

FIG. 1

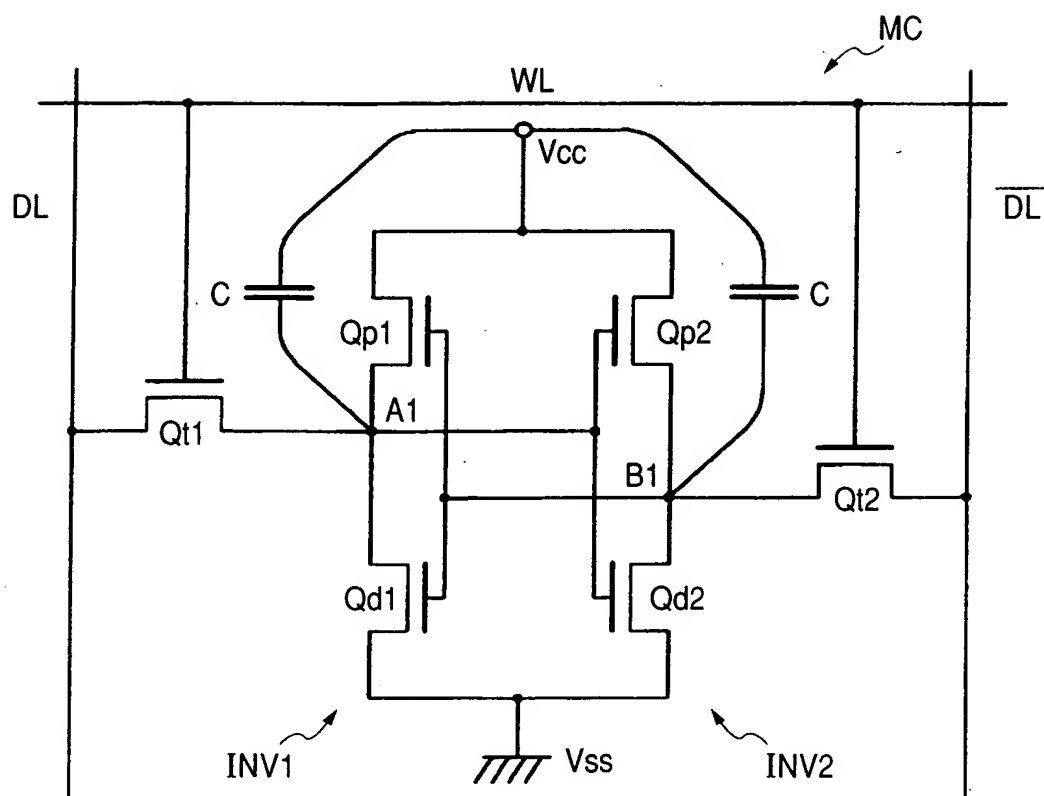


FIG. 2

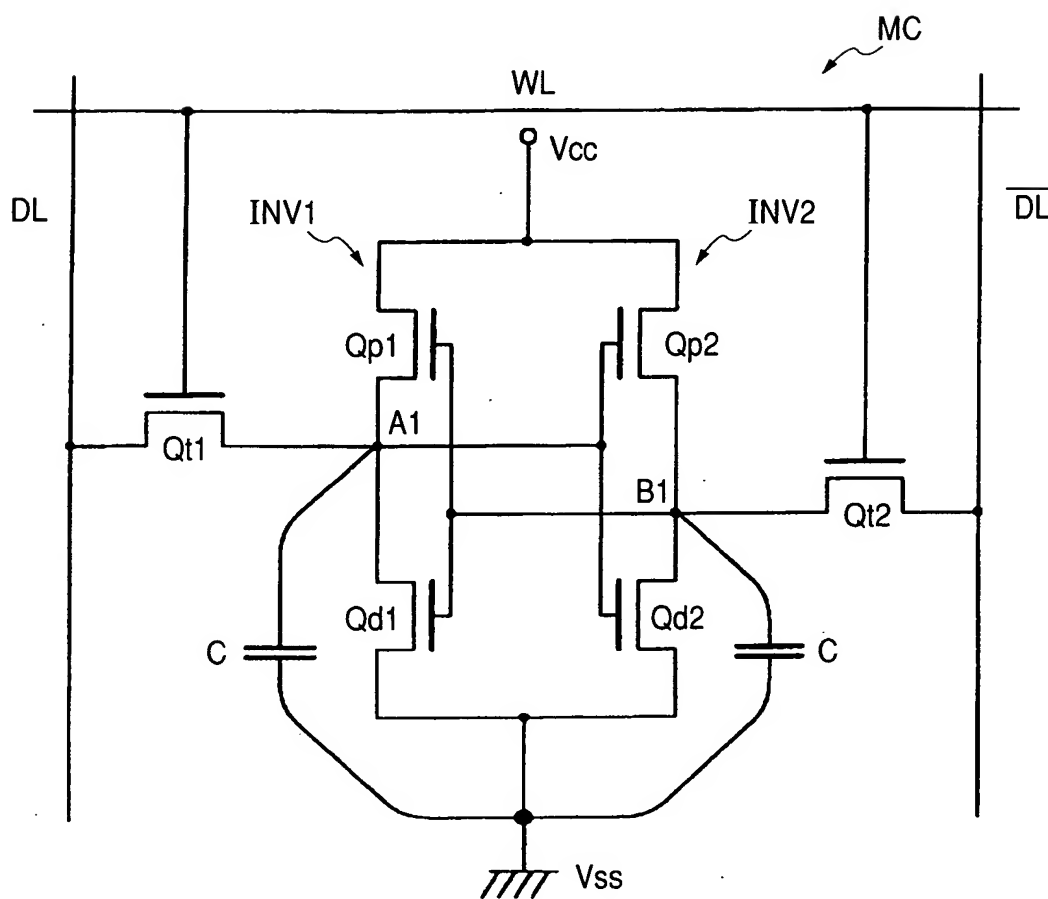


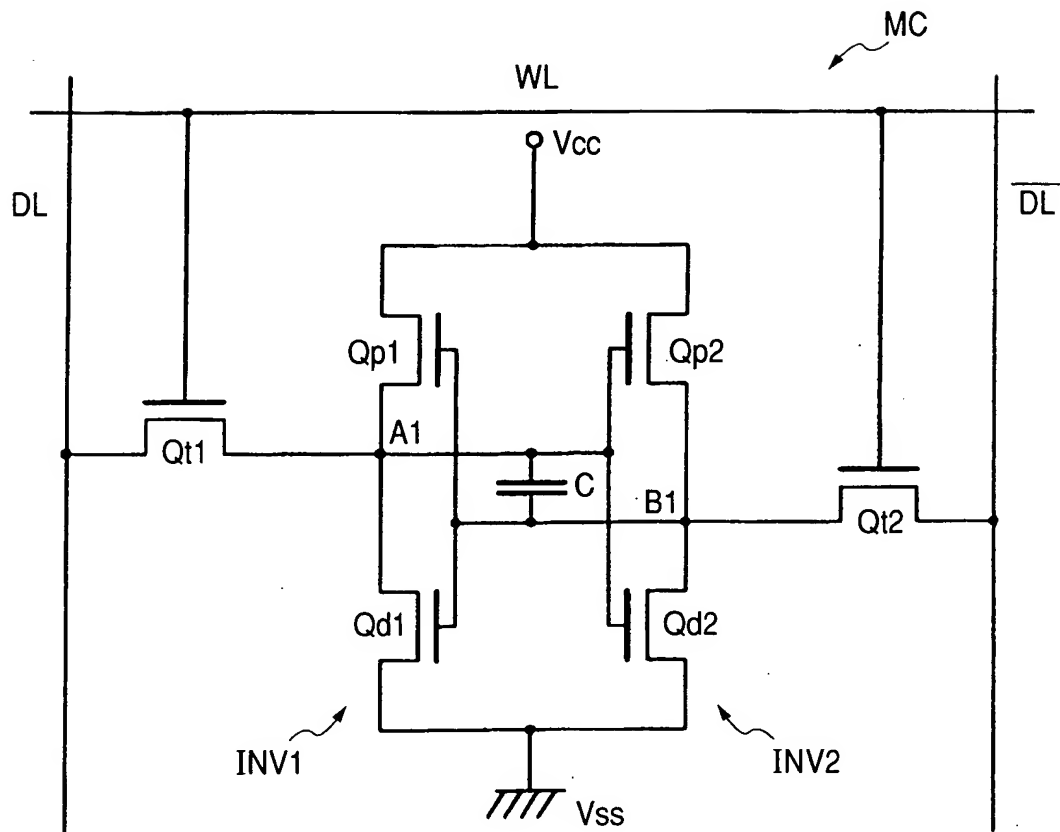
FIG. 3

FIG. 4

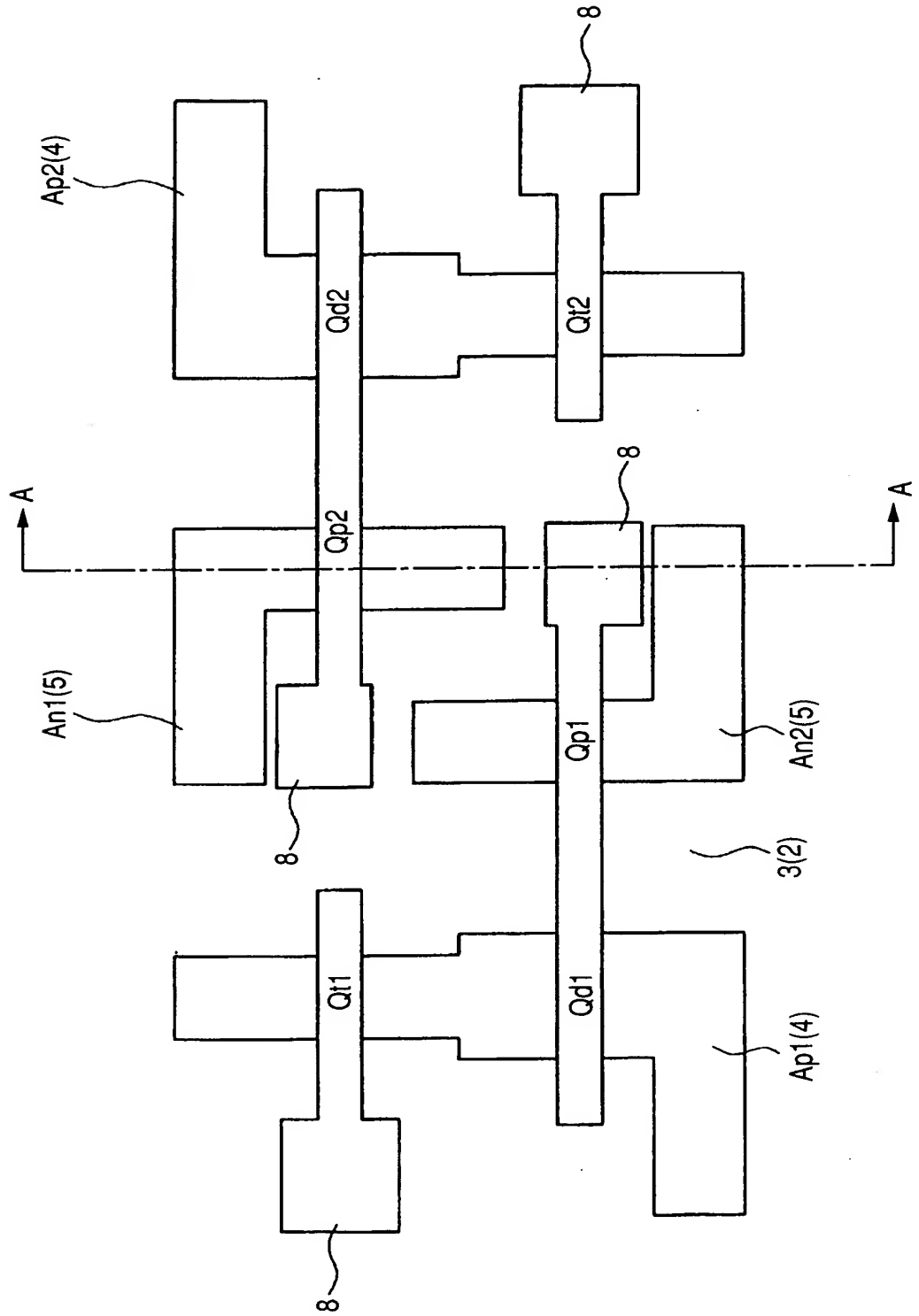


FIG. 5

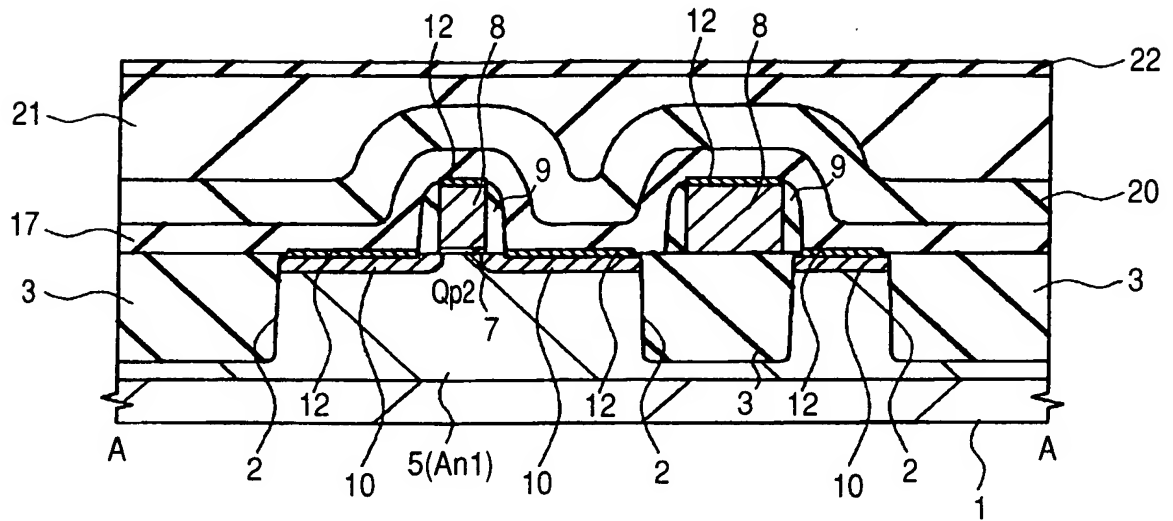
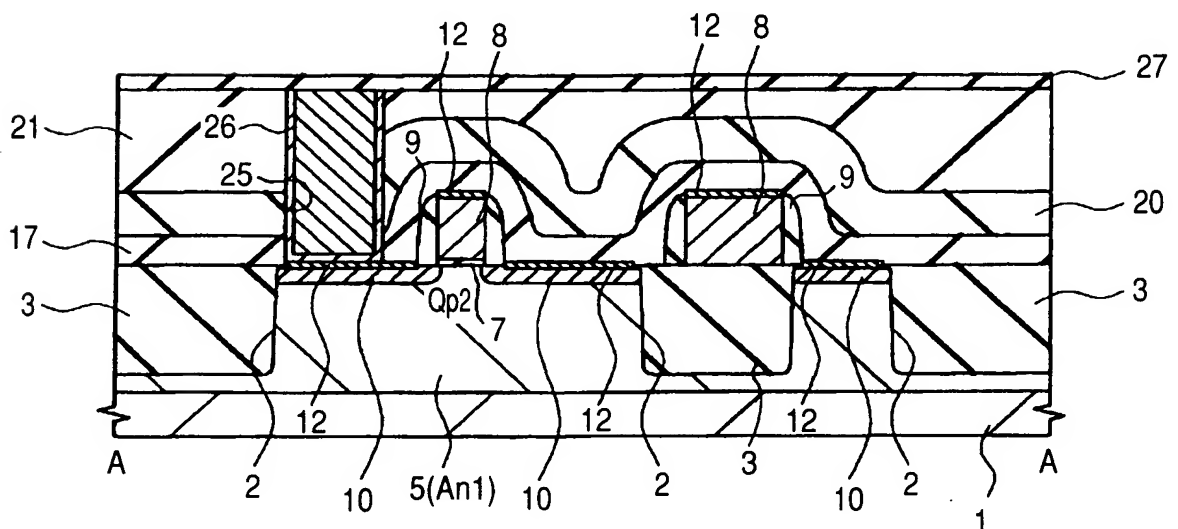


FIG. 6



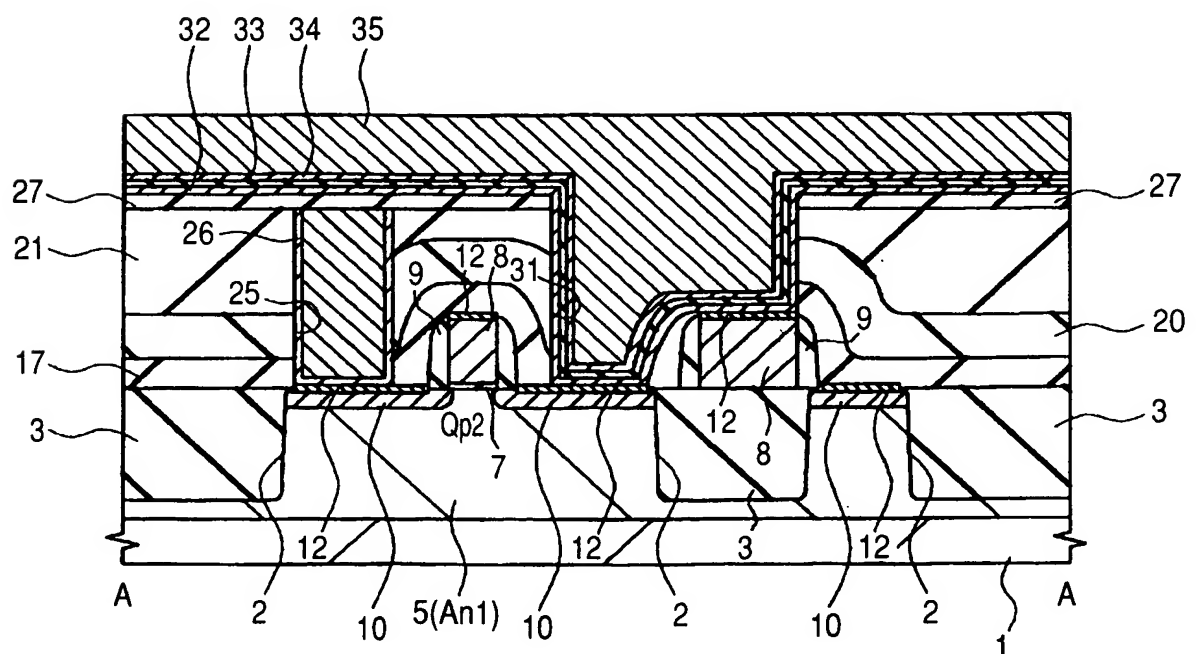


FIG. 9

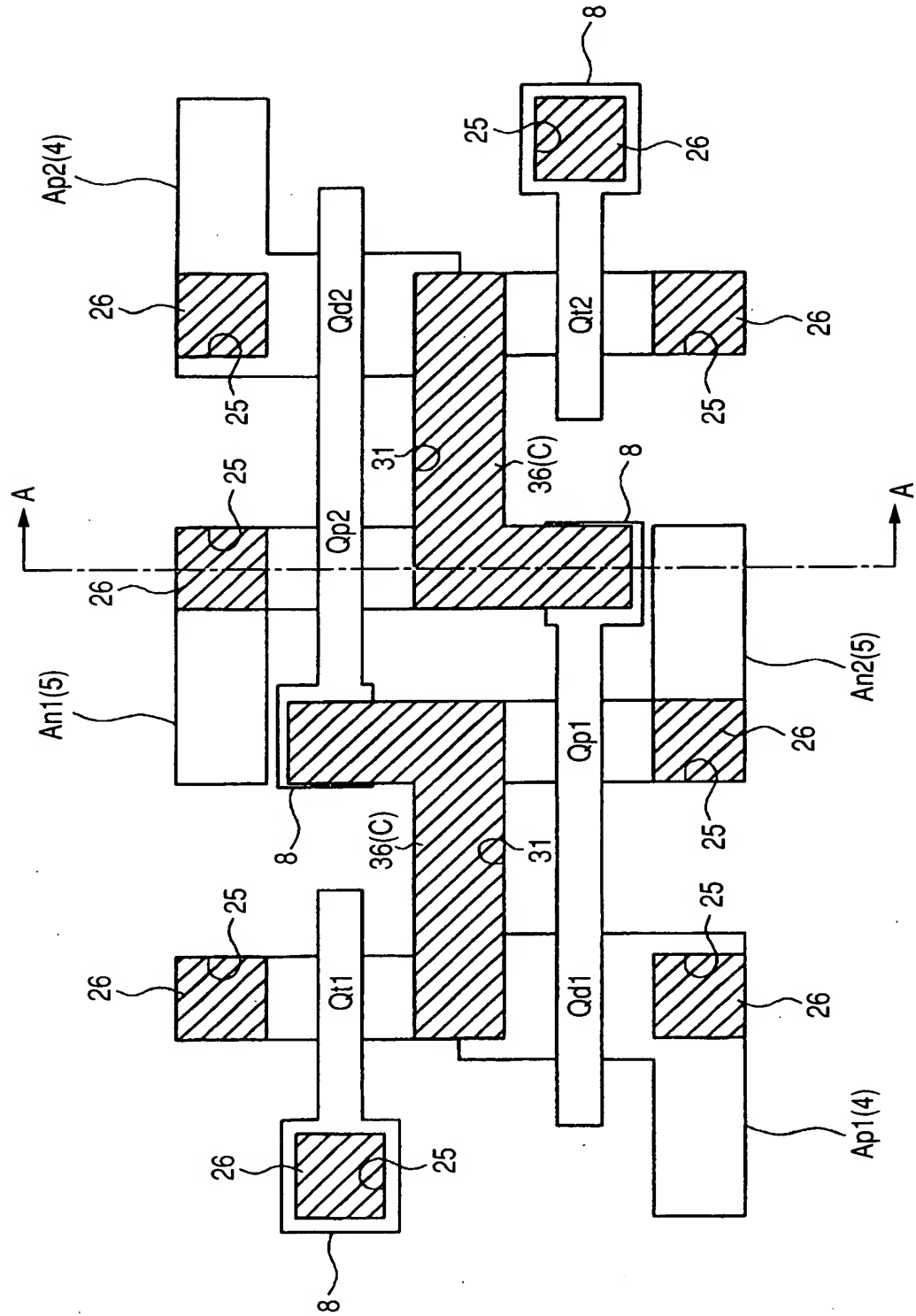


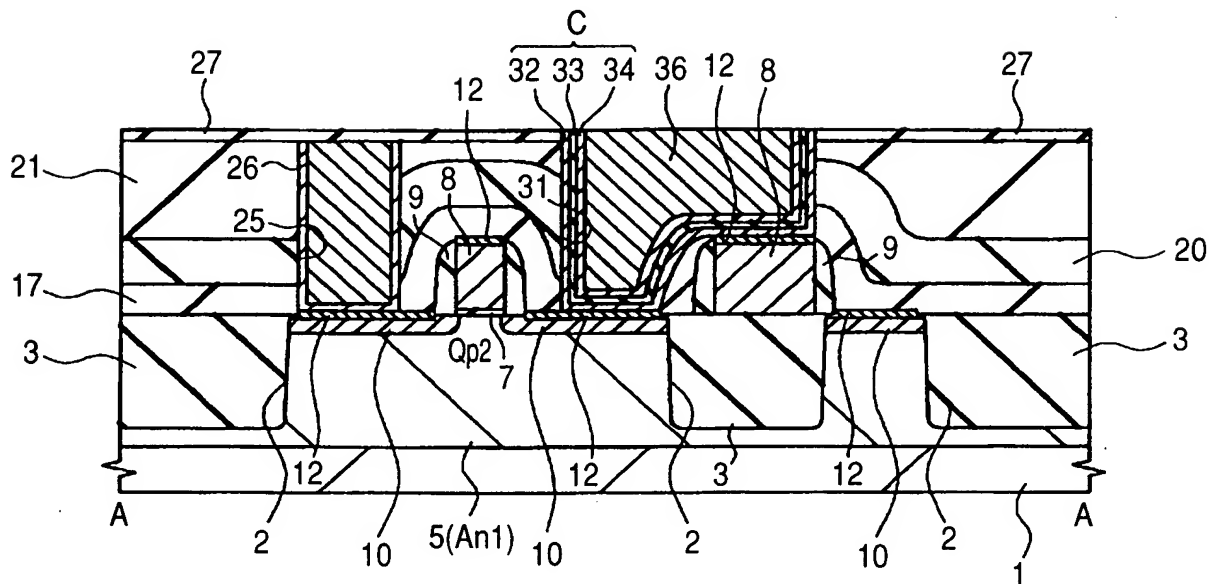
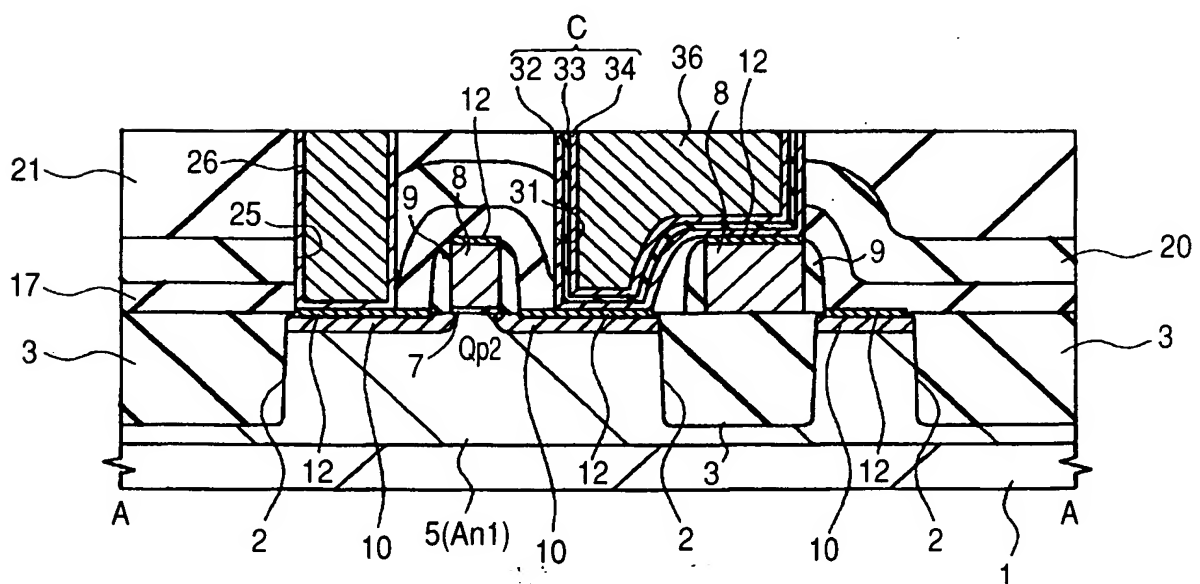
FIG. 10**FIG. 11**

FIG. 12

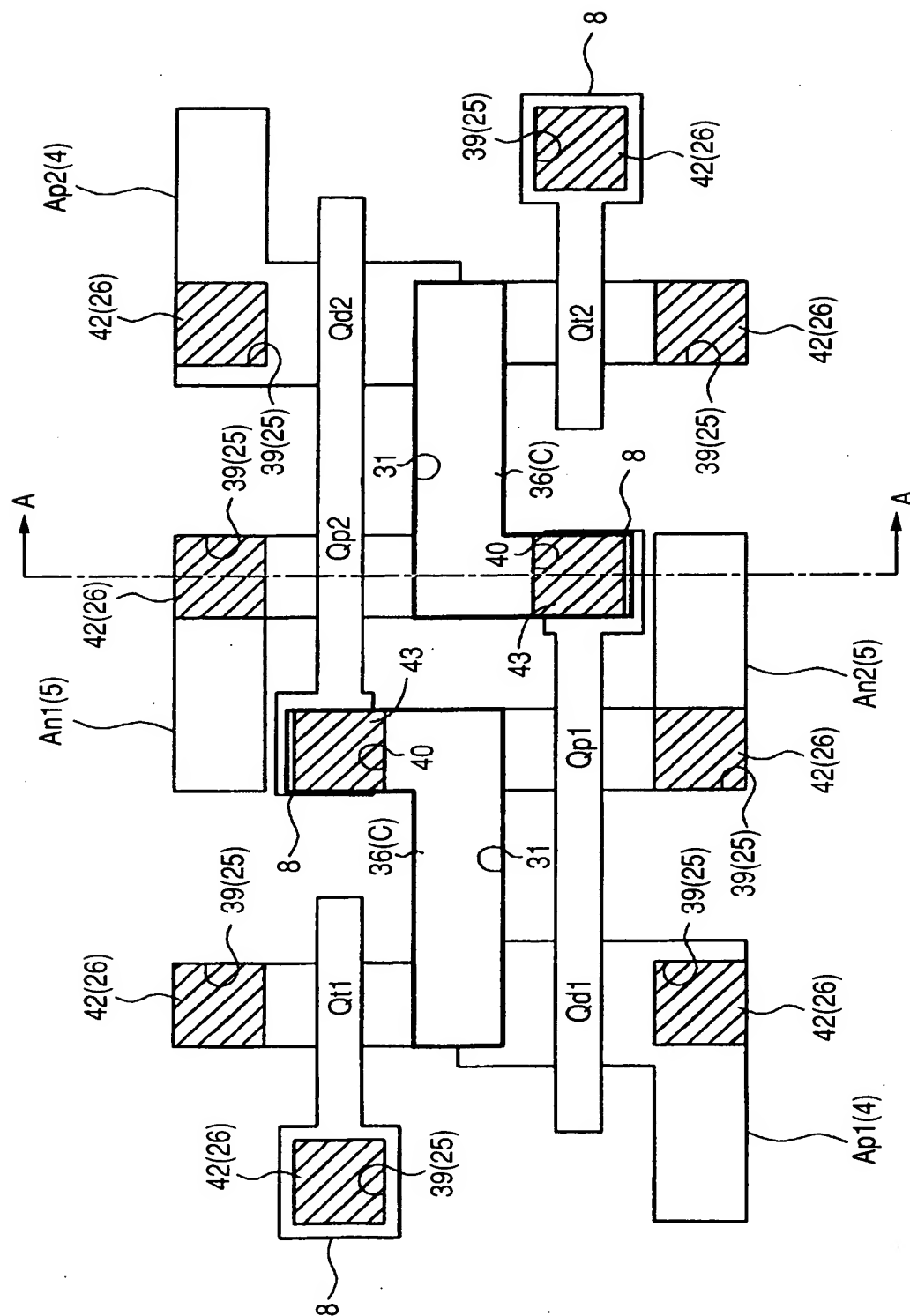


FIG. 13

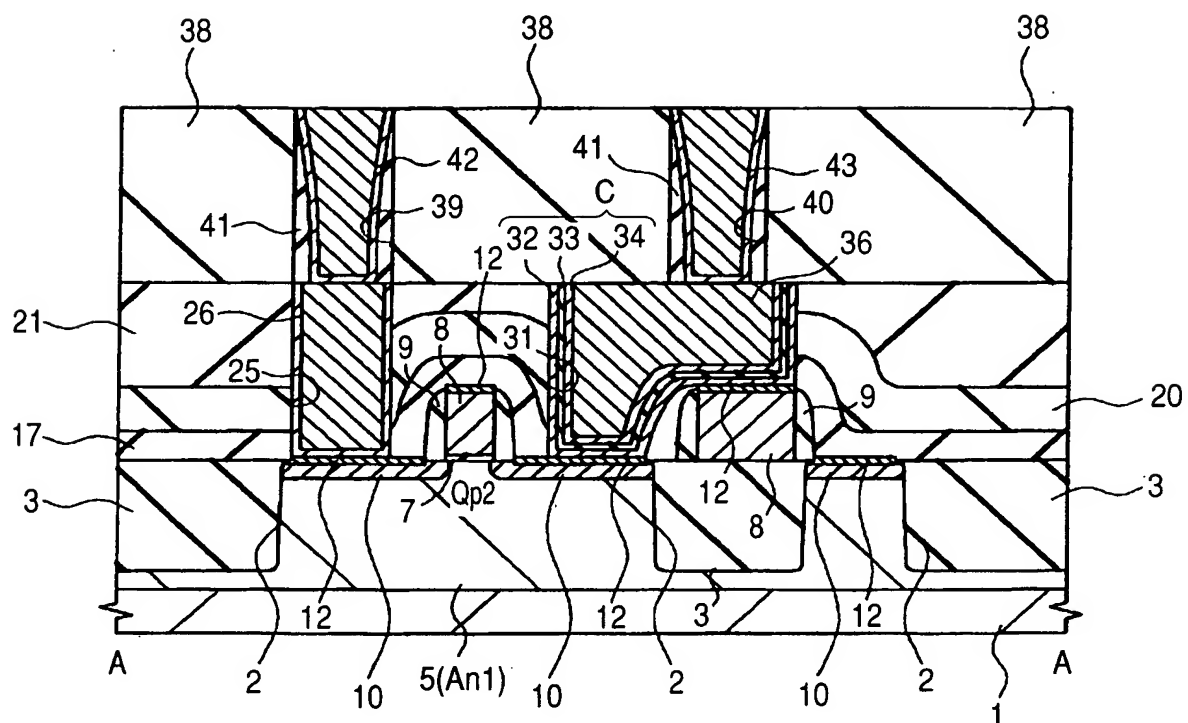


FIG. 14

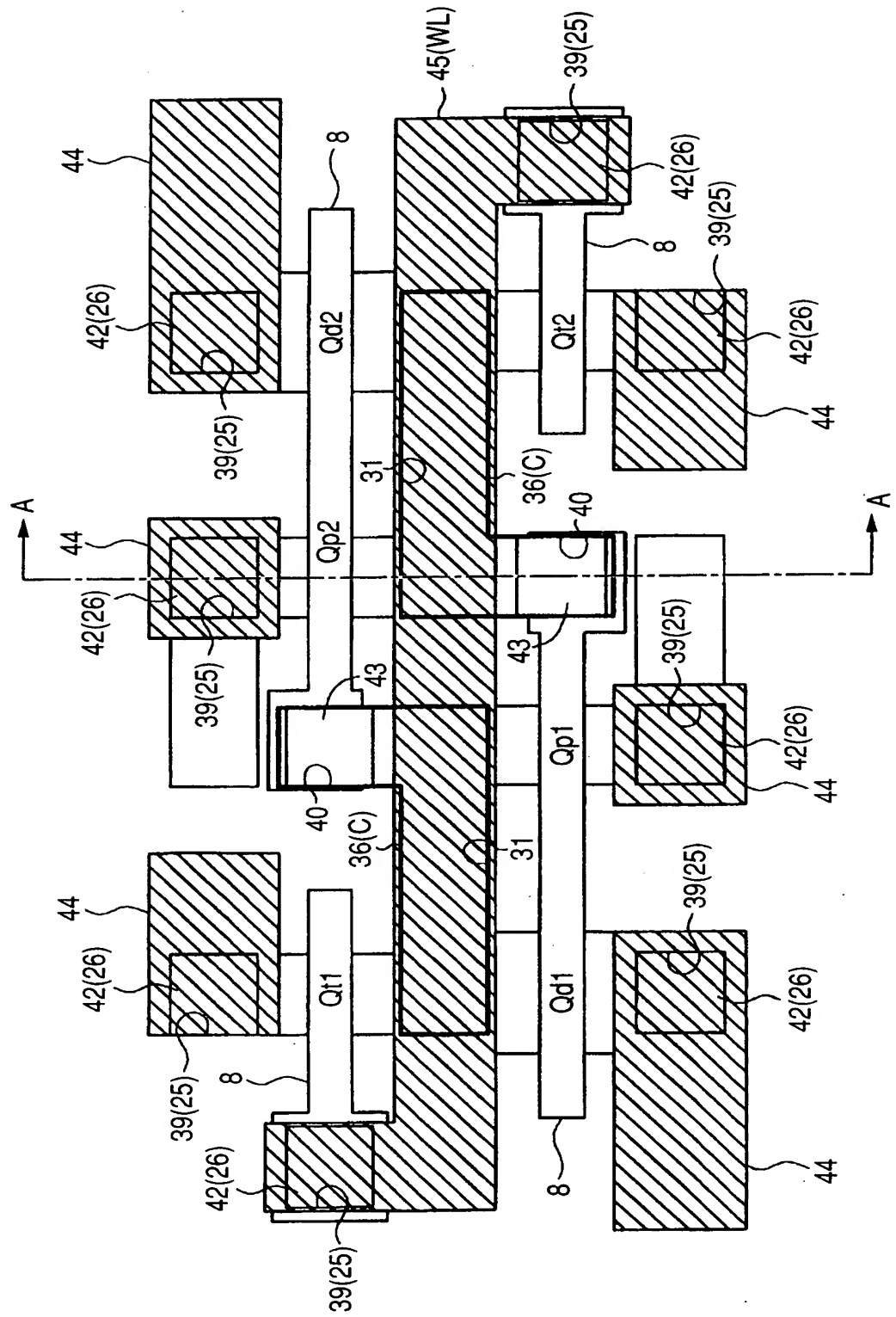


FIG. 15

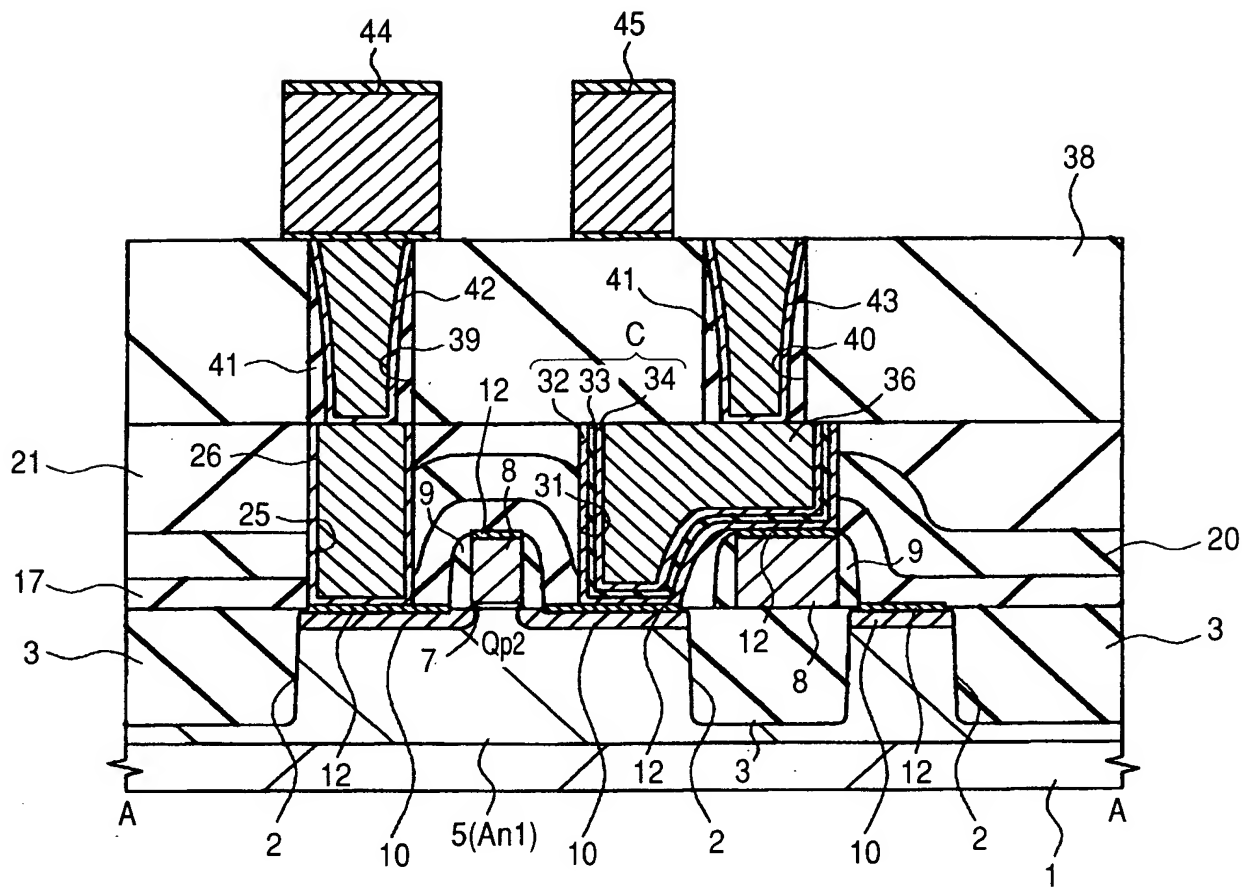


FIG. 16

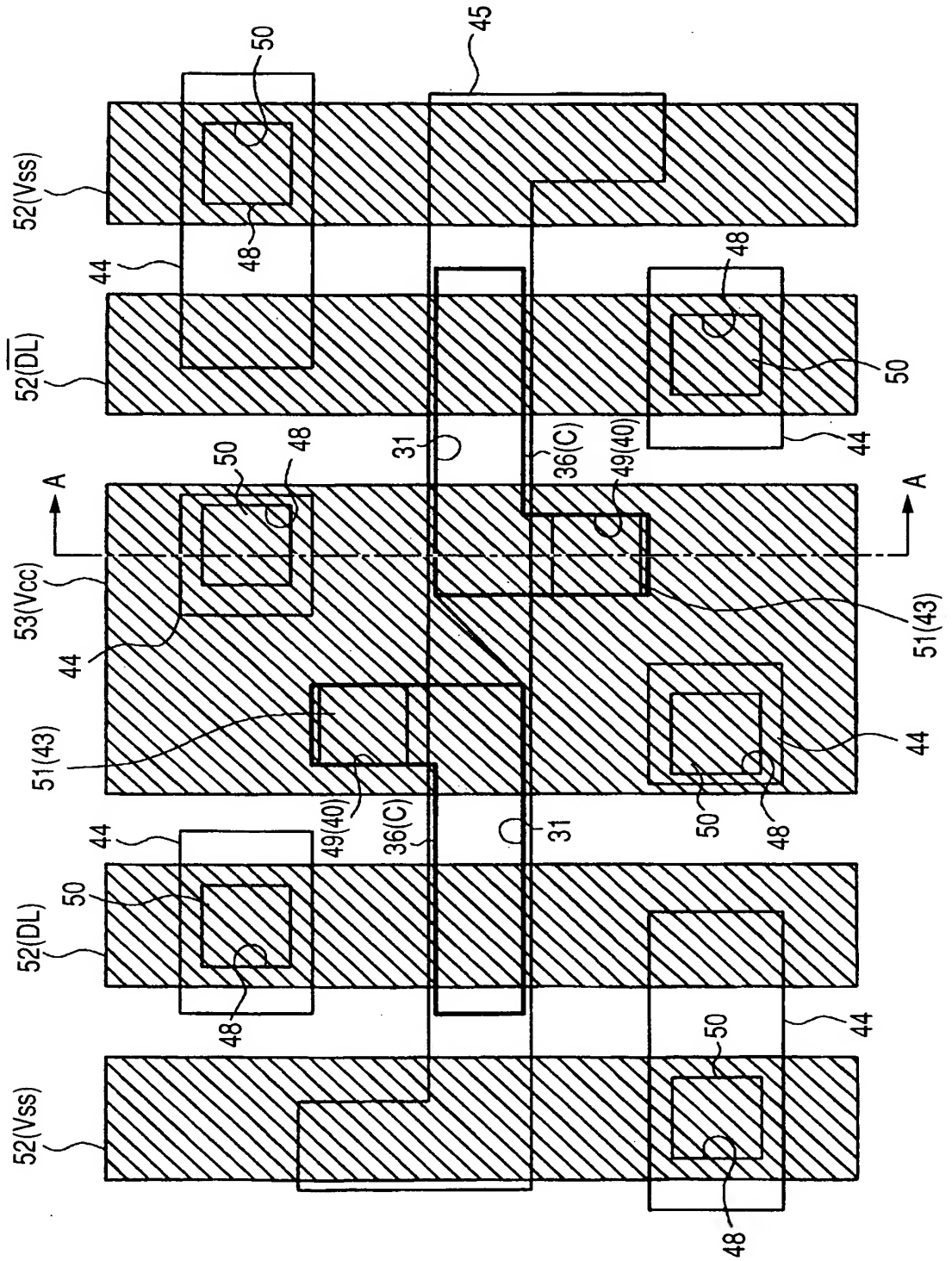


FIG. 17

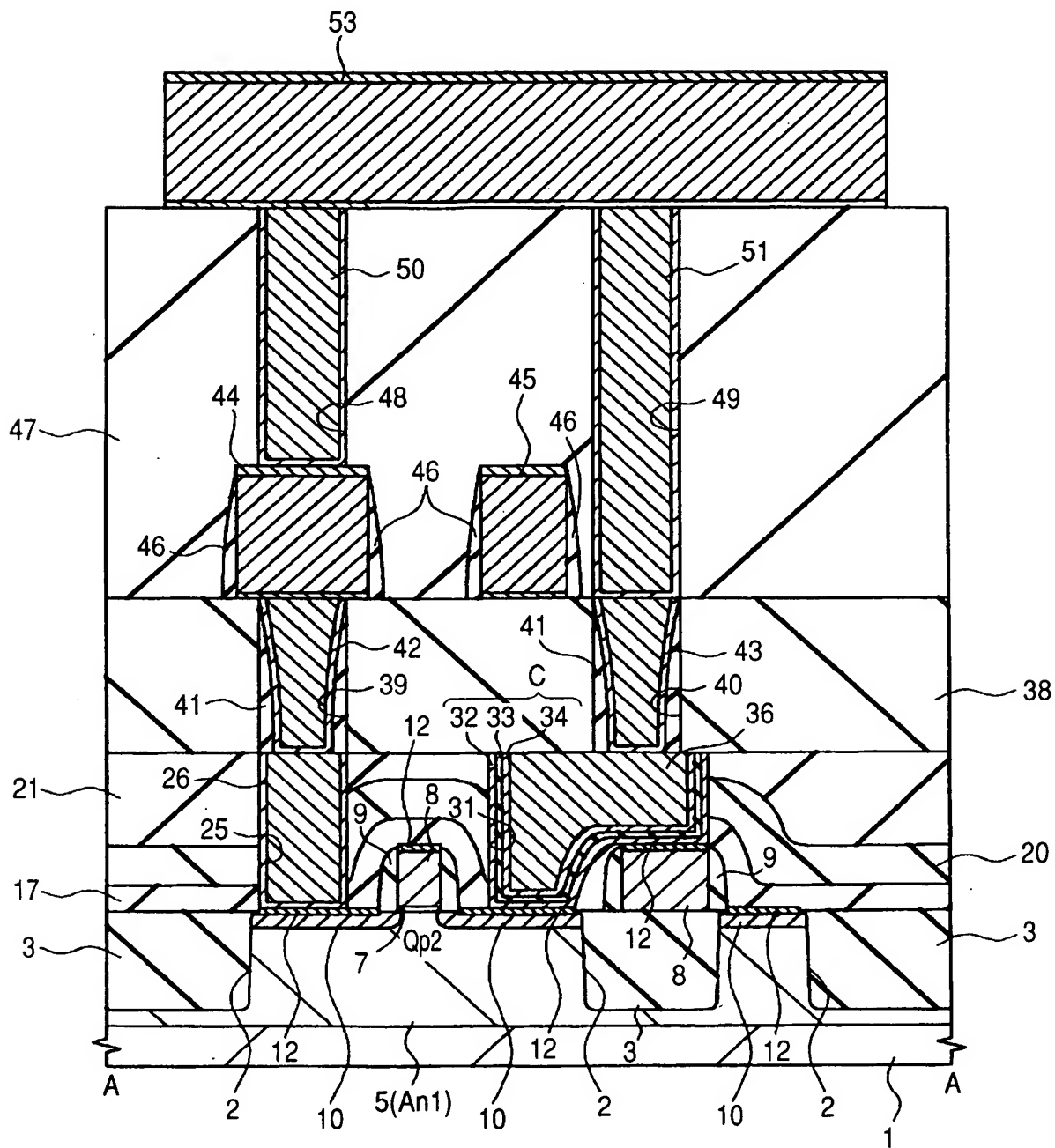


FIG. 18

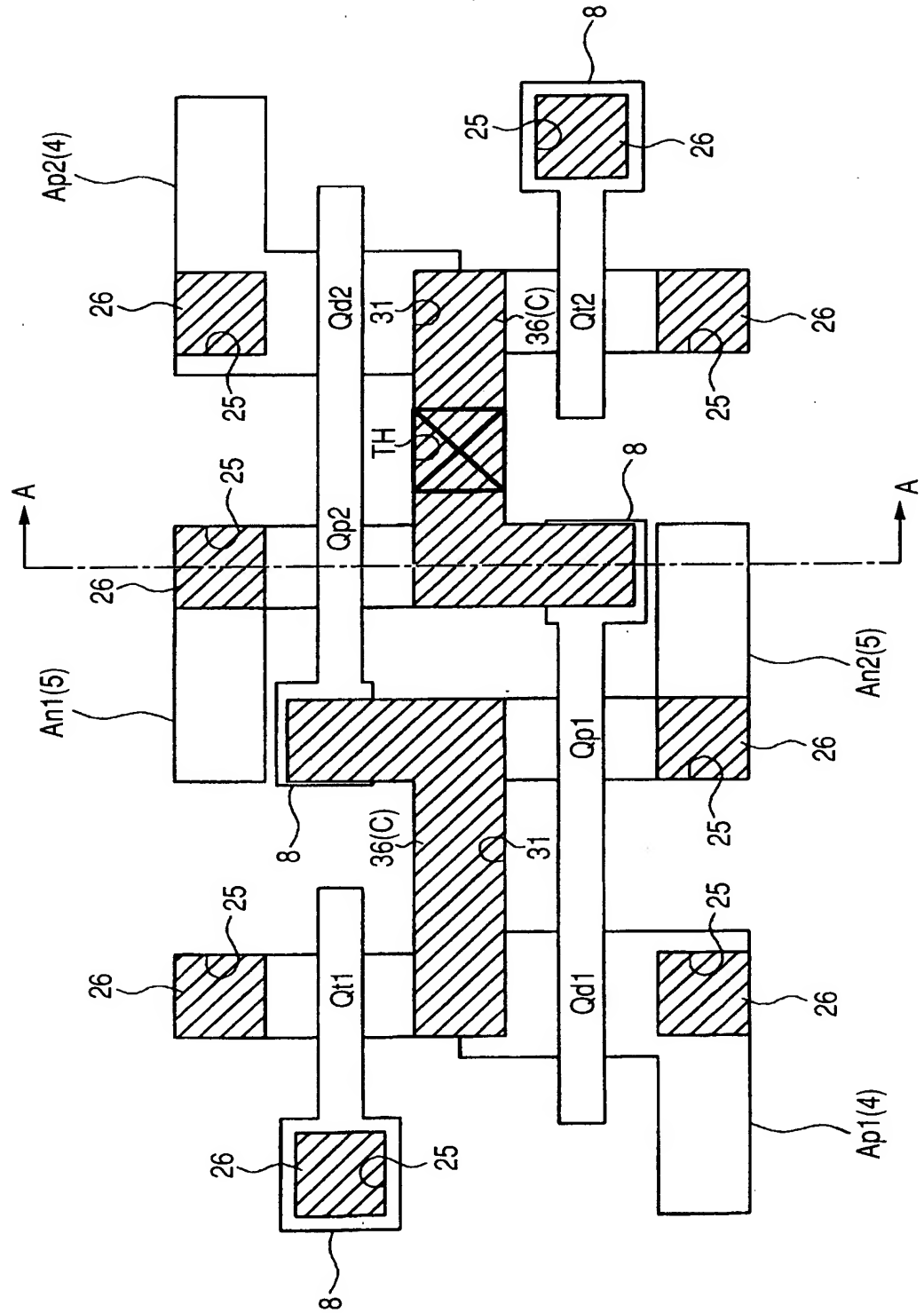
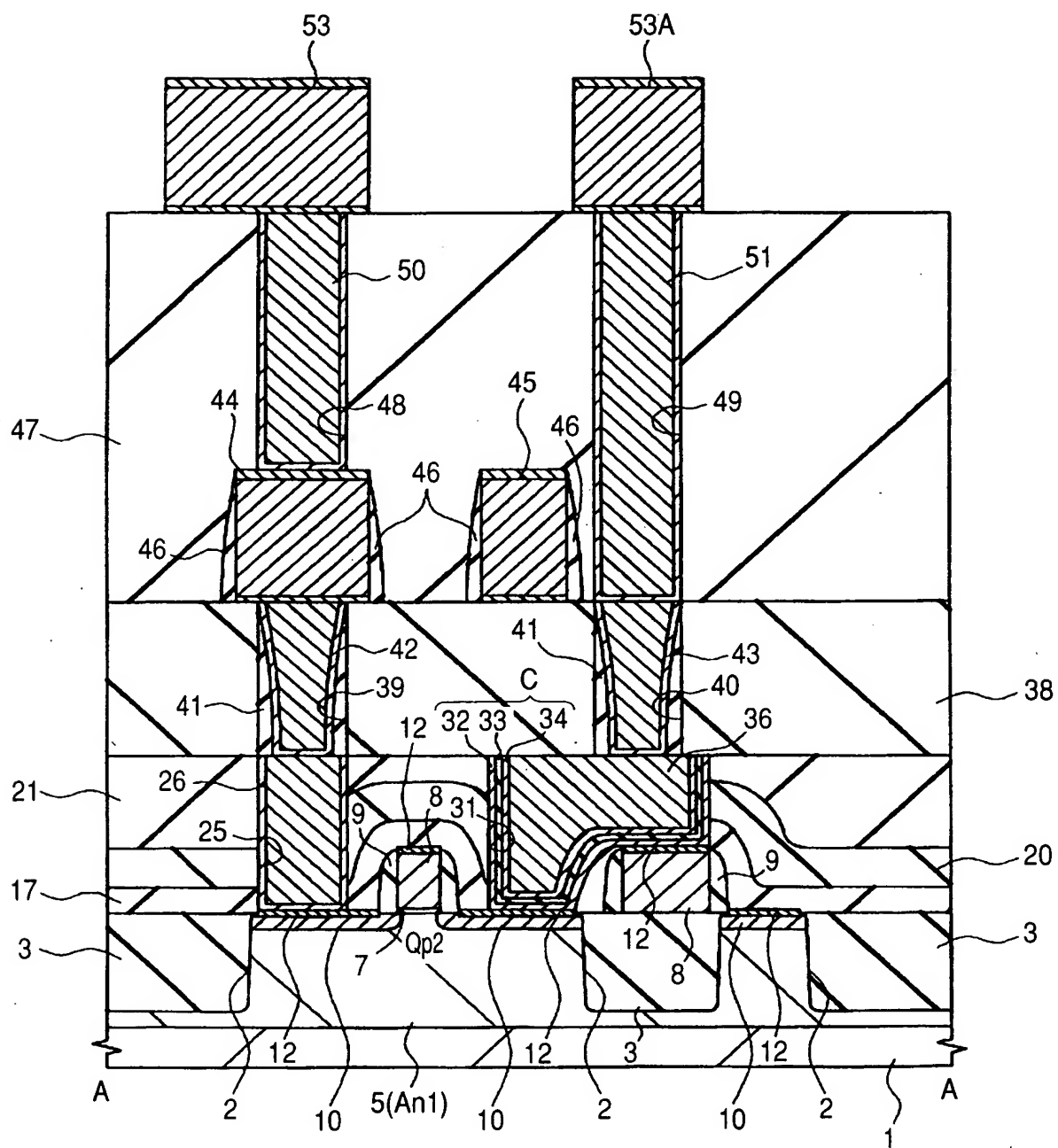


FIG. 20



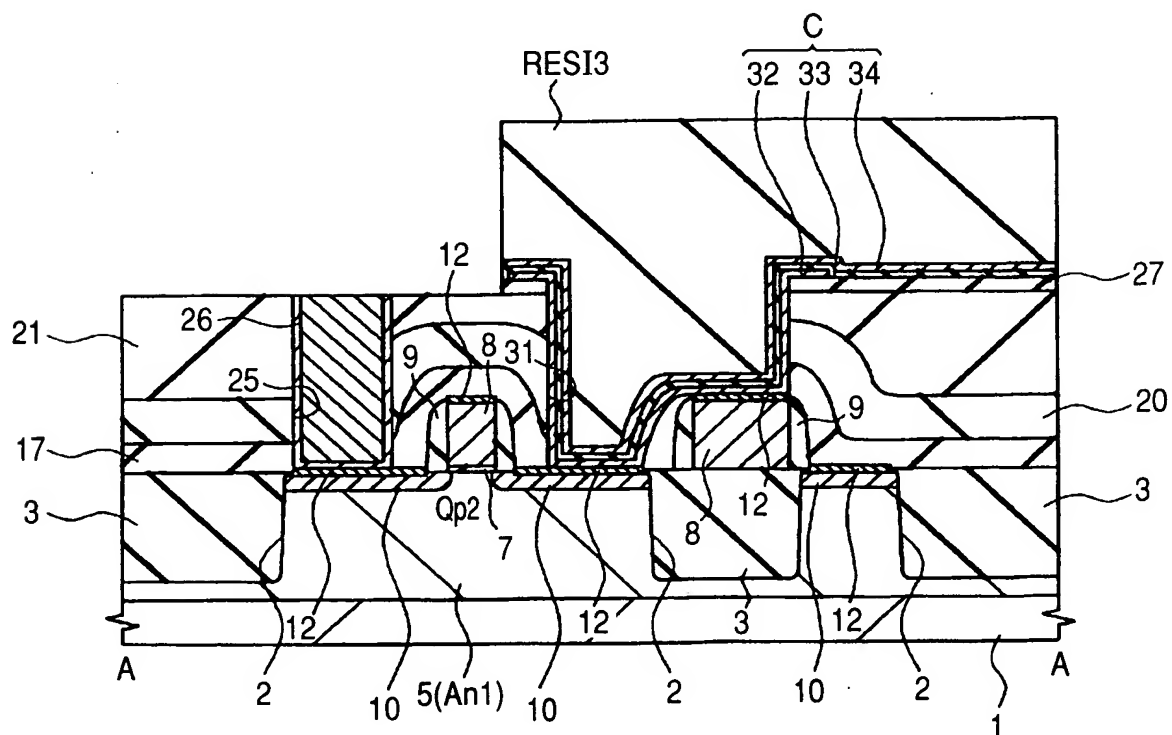


FIG. 23

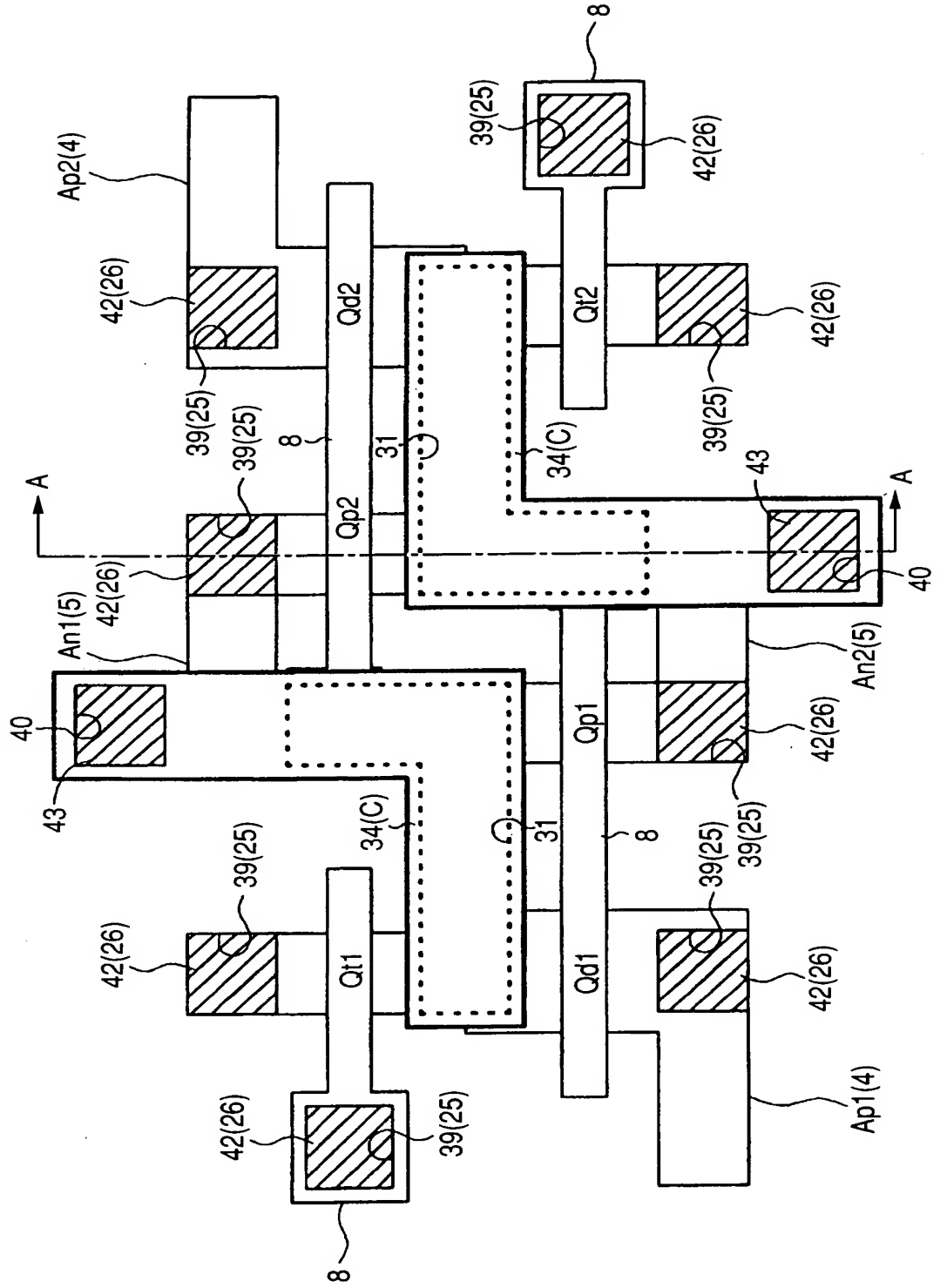


FIG. 26

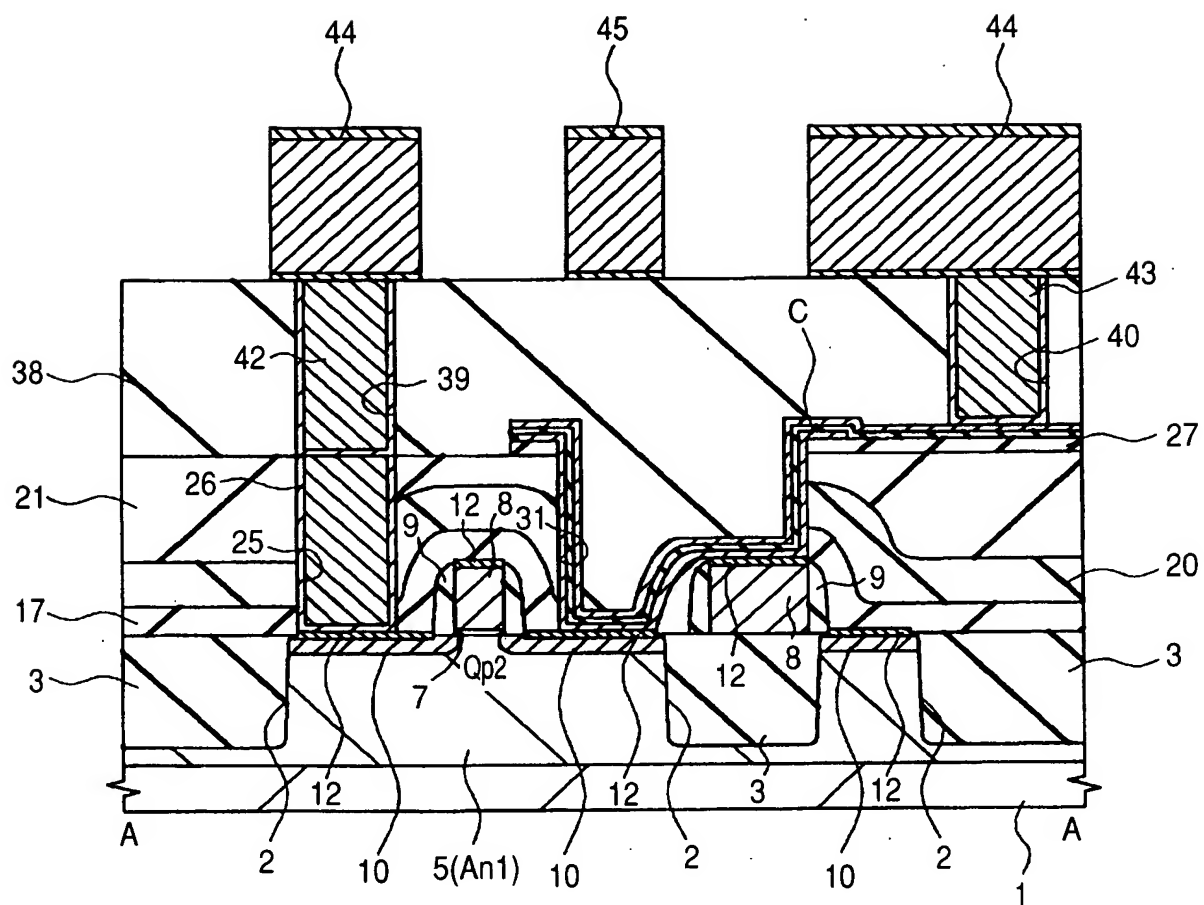
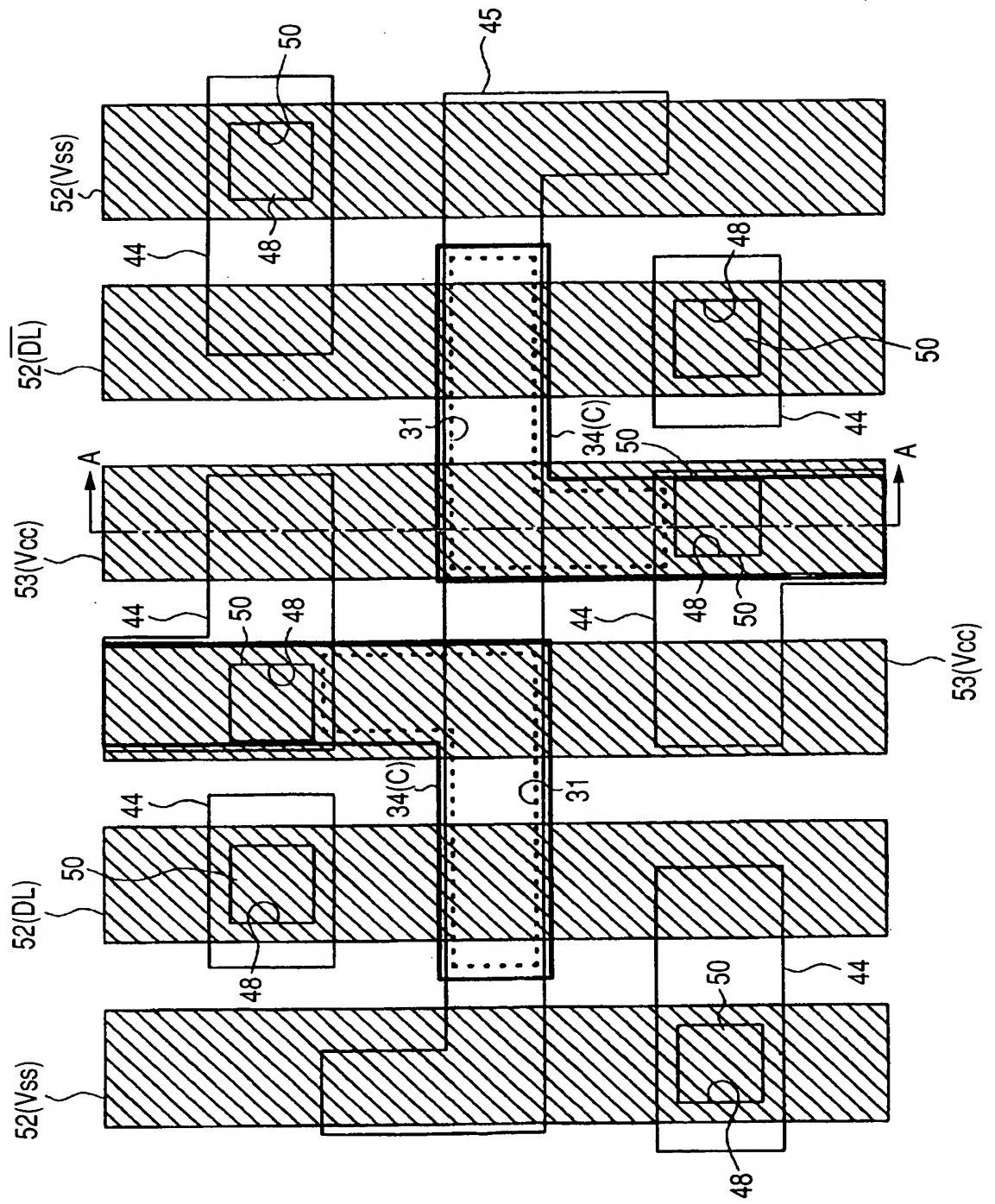


FIG. 27



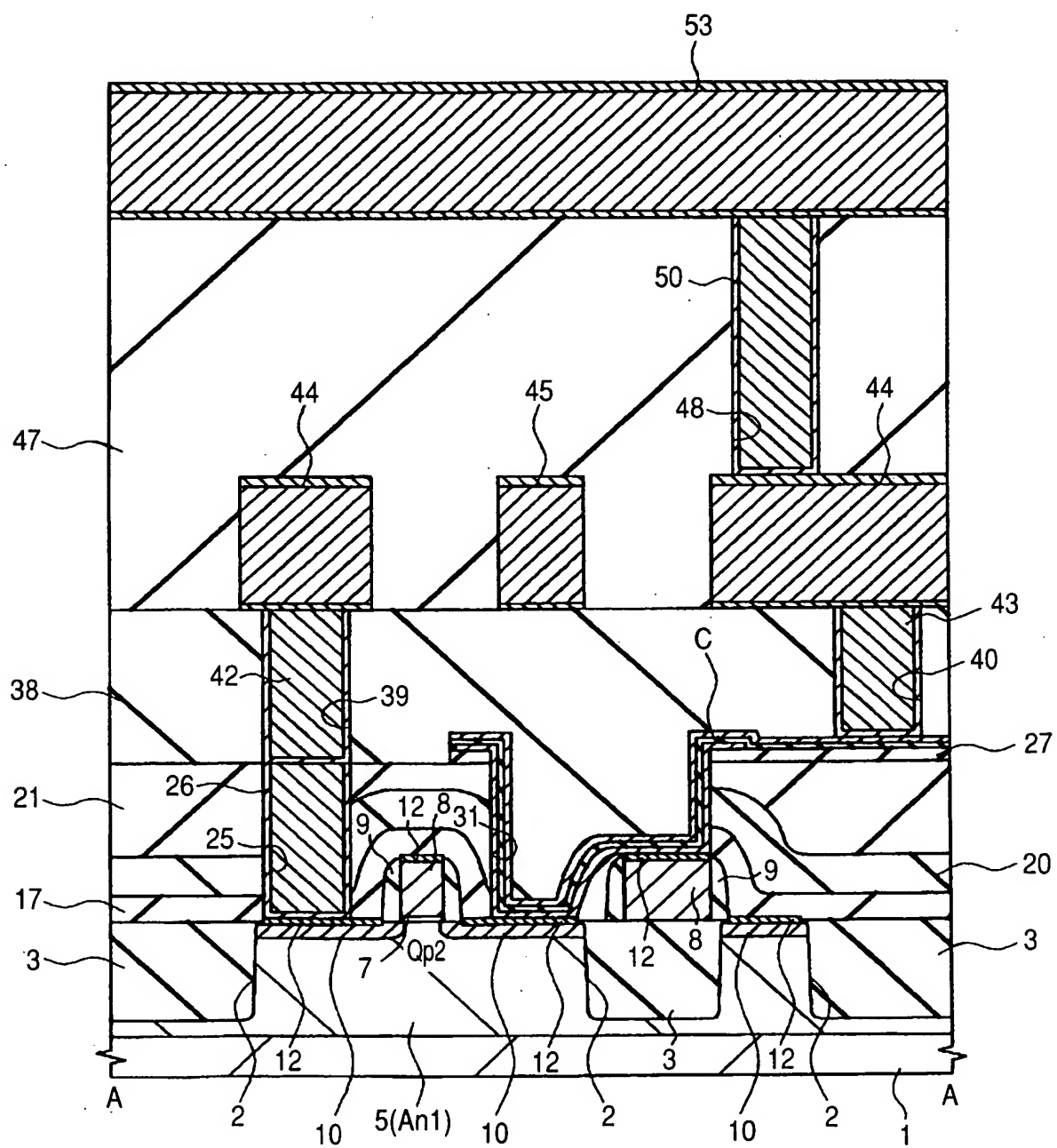


FIG. 29

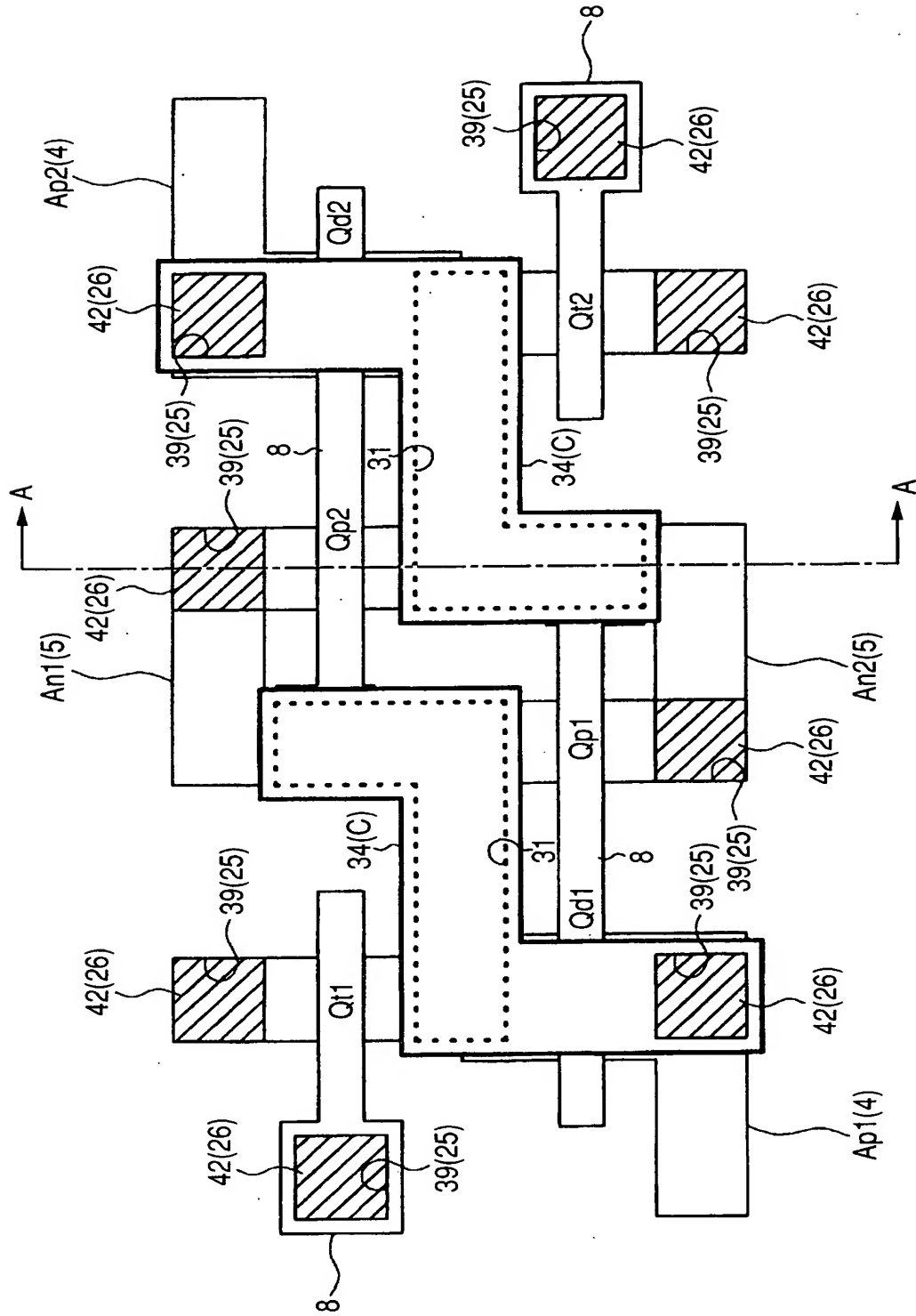


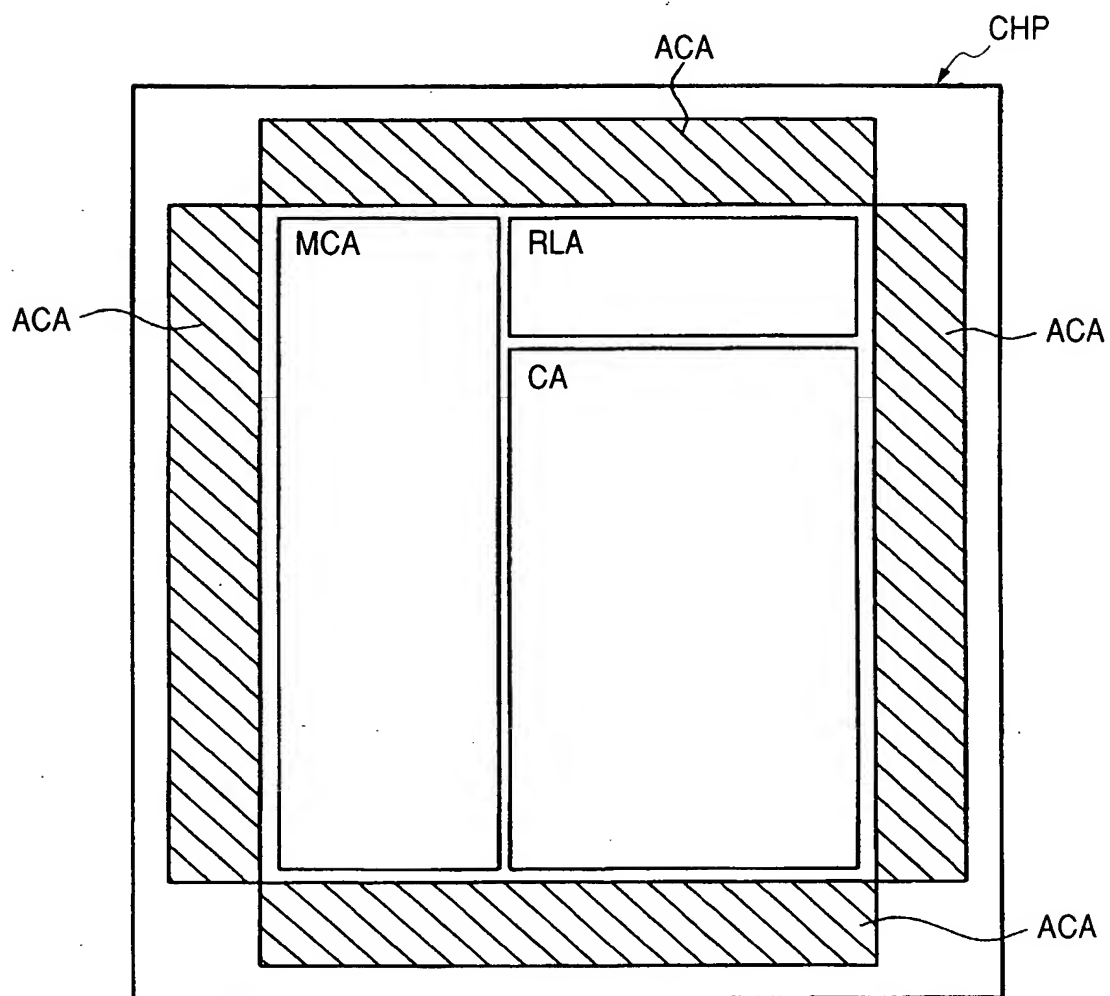
FIG. 30

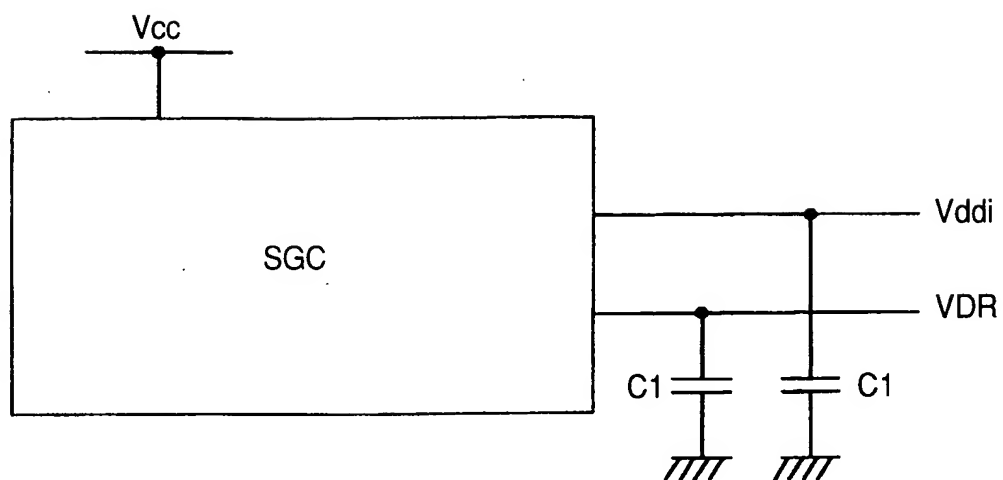
FIG. 31

FIG. 32

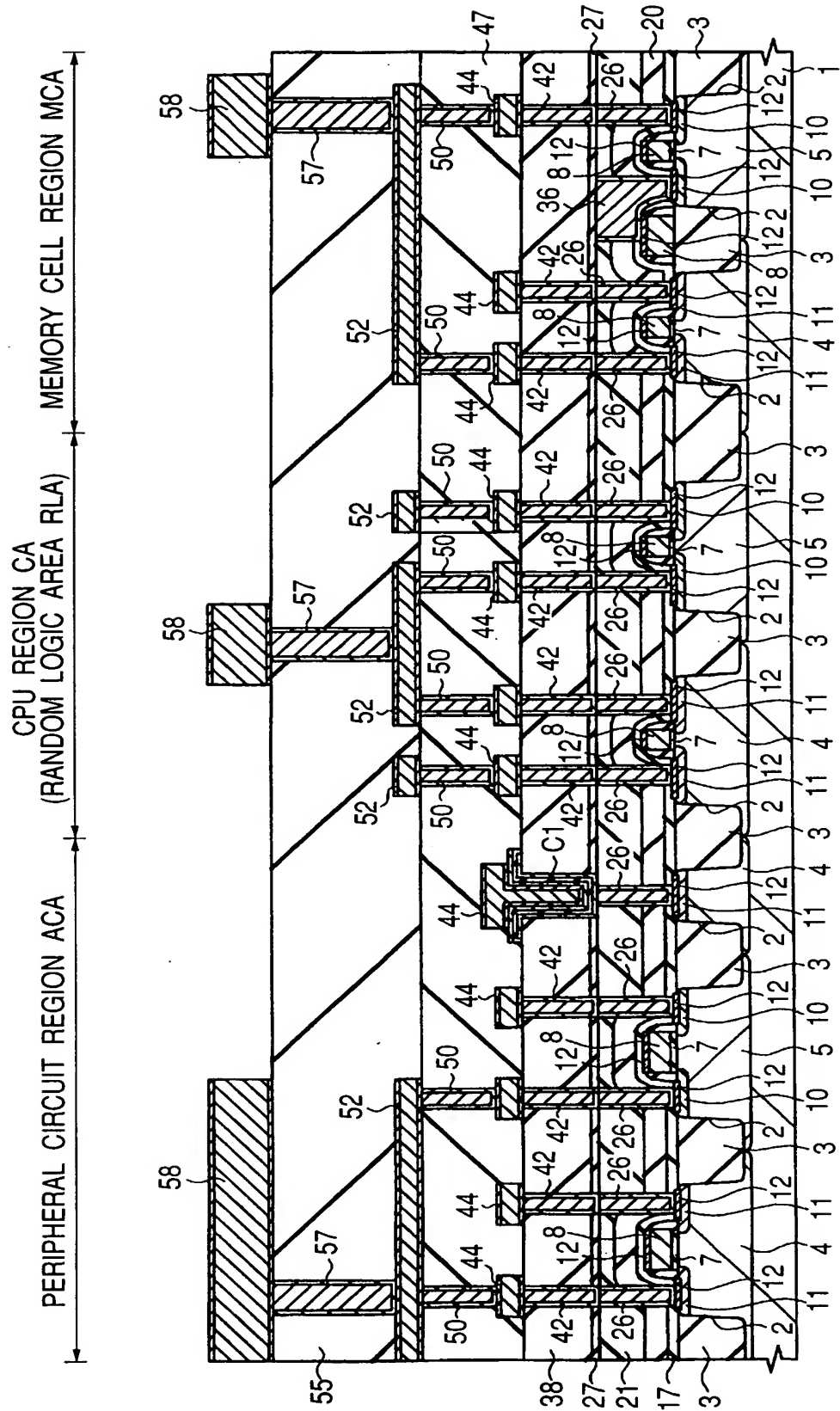


FIG. 33

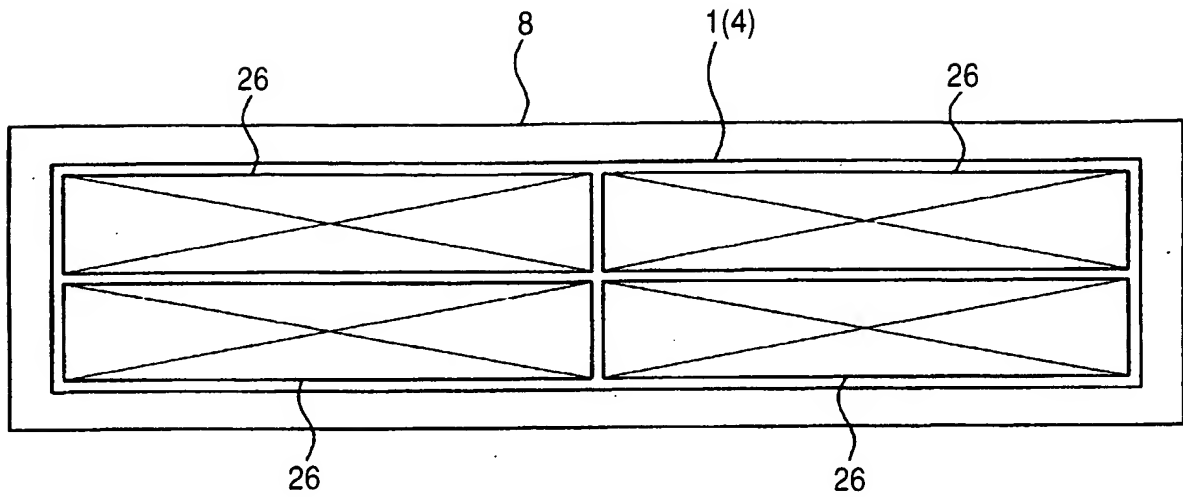


FIG. 34

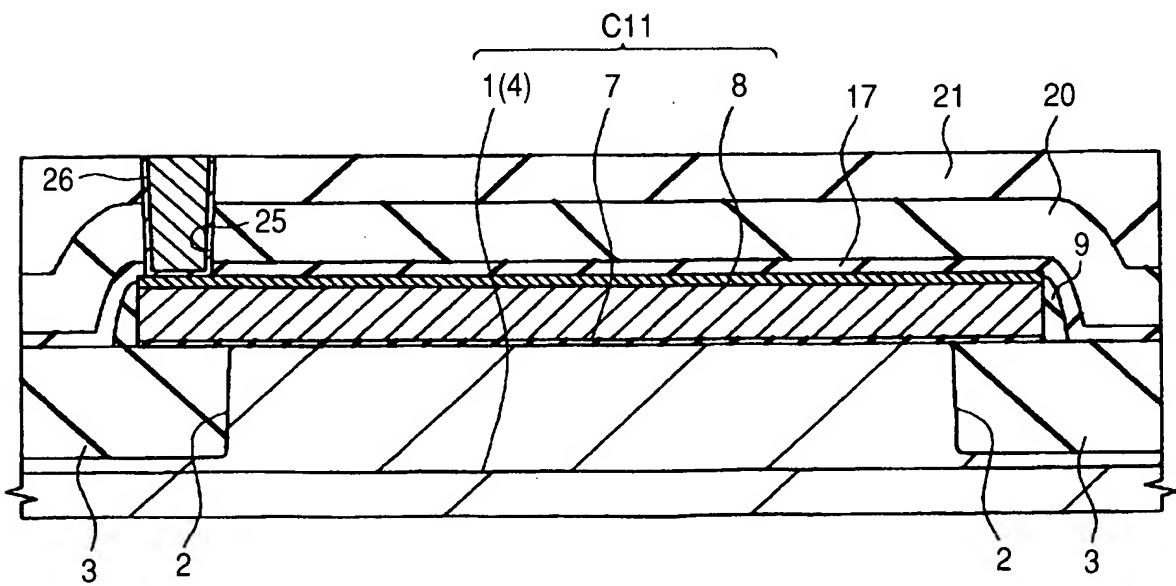


FIG. 35

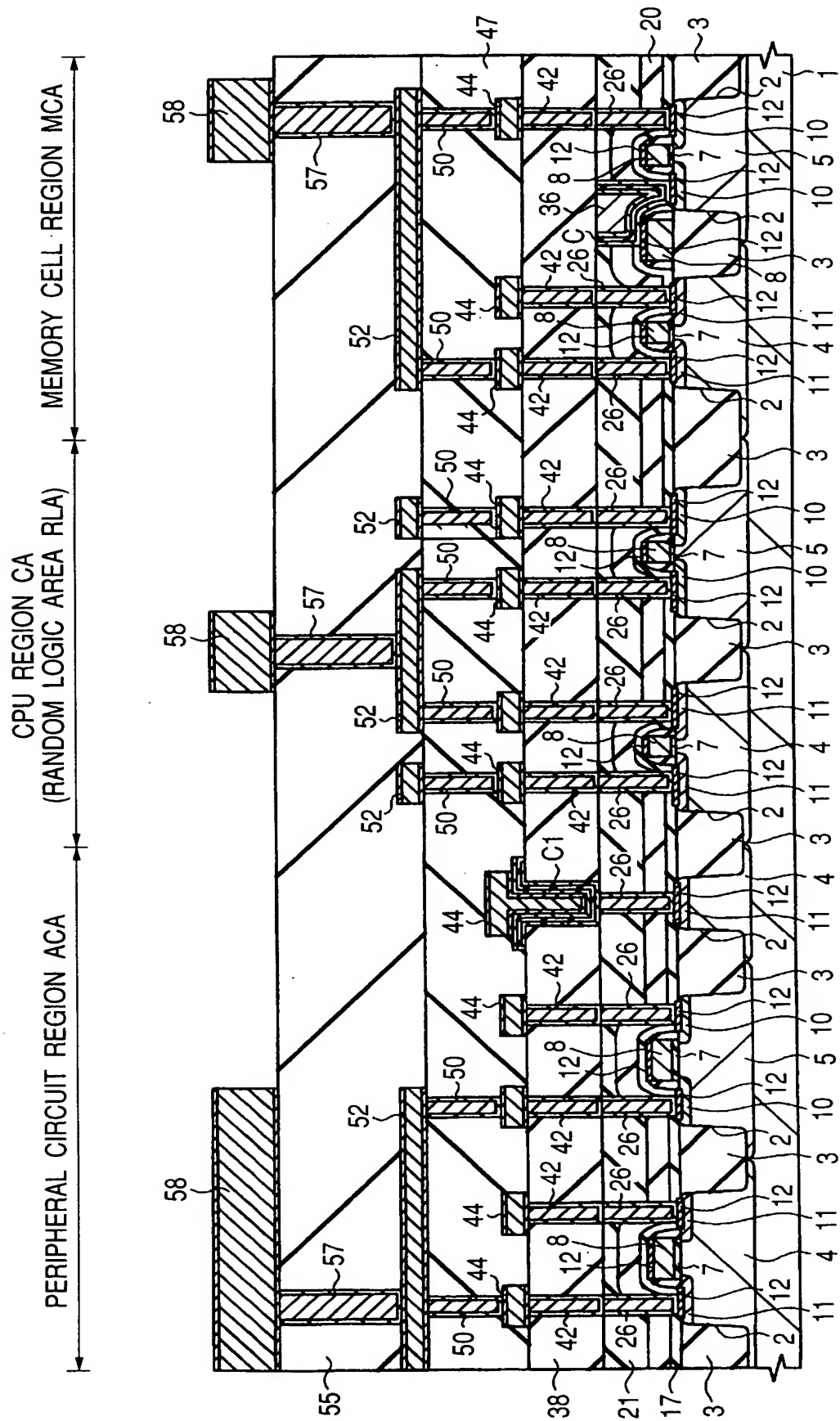


FIG. 36

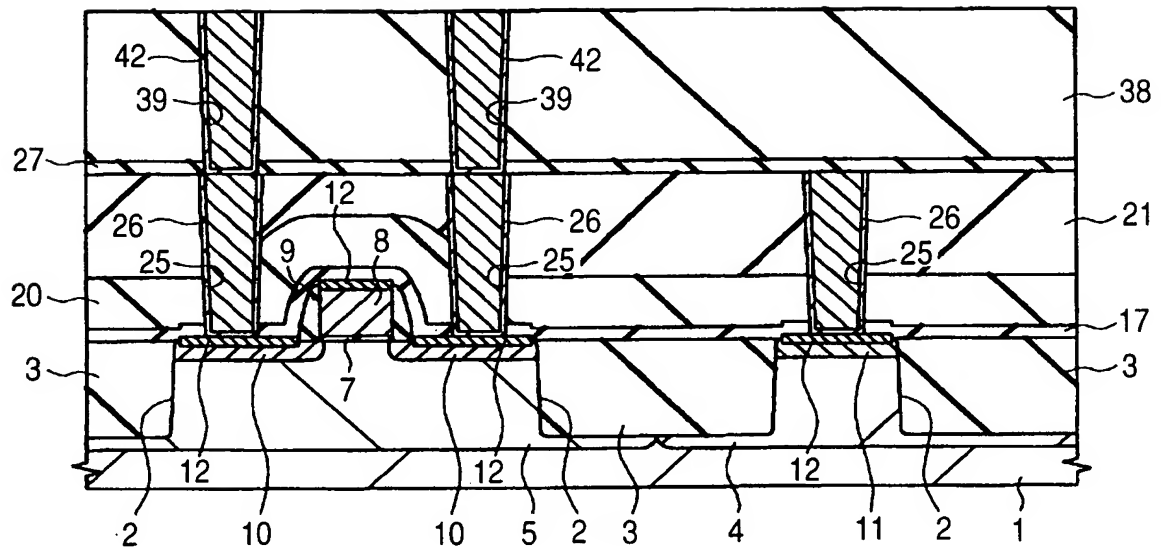


FIG. 37

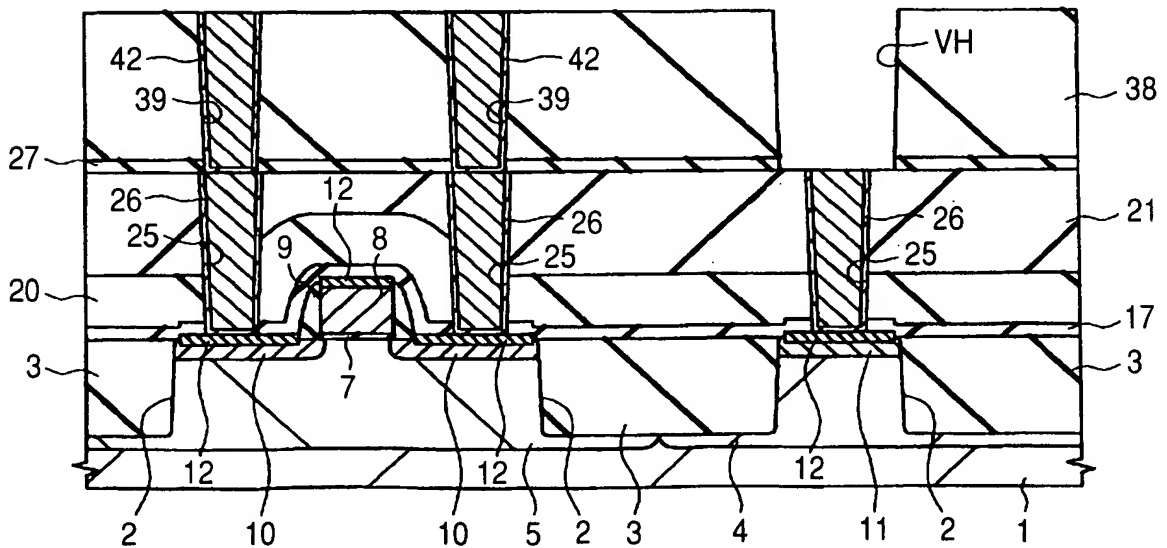


FIG. 38

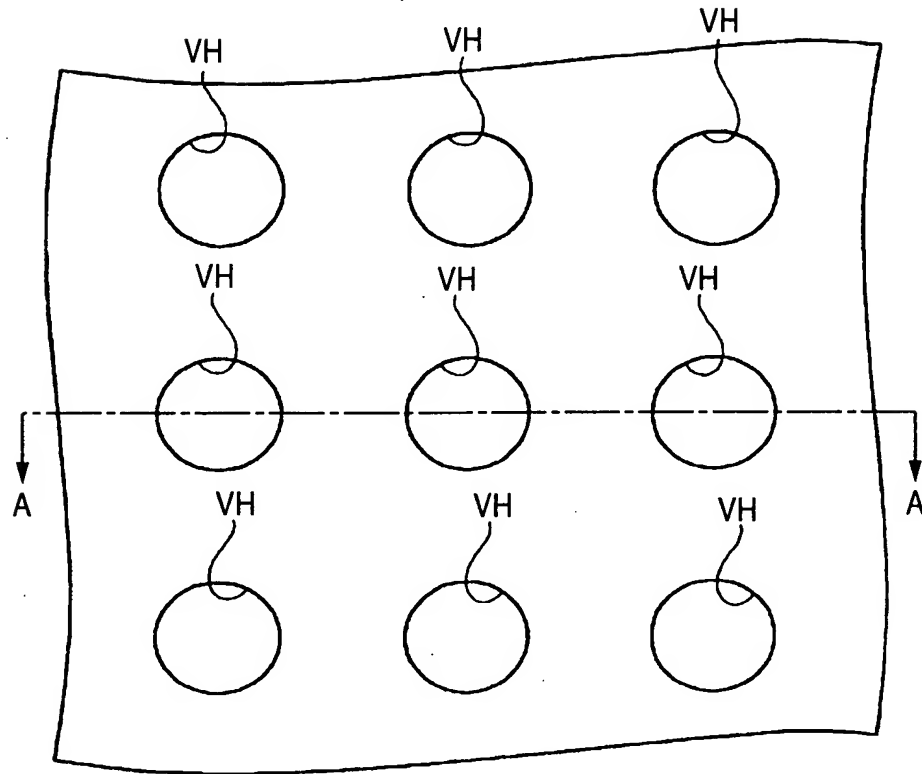


FIG. 39

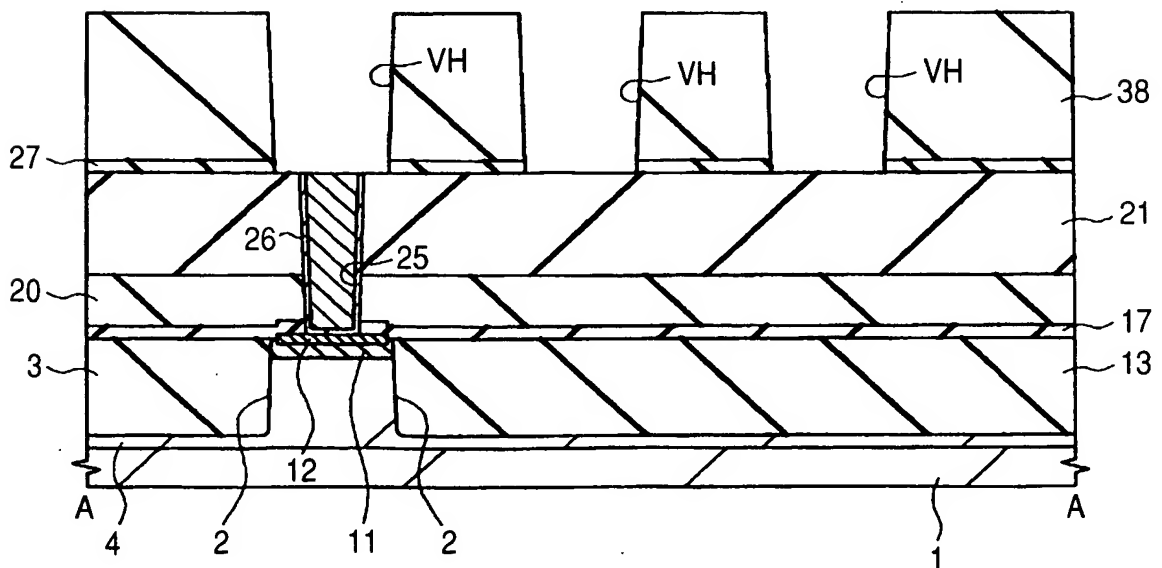


FIG. 40

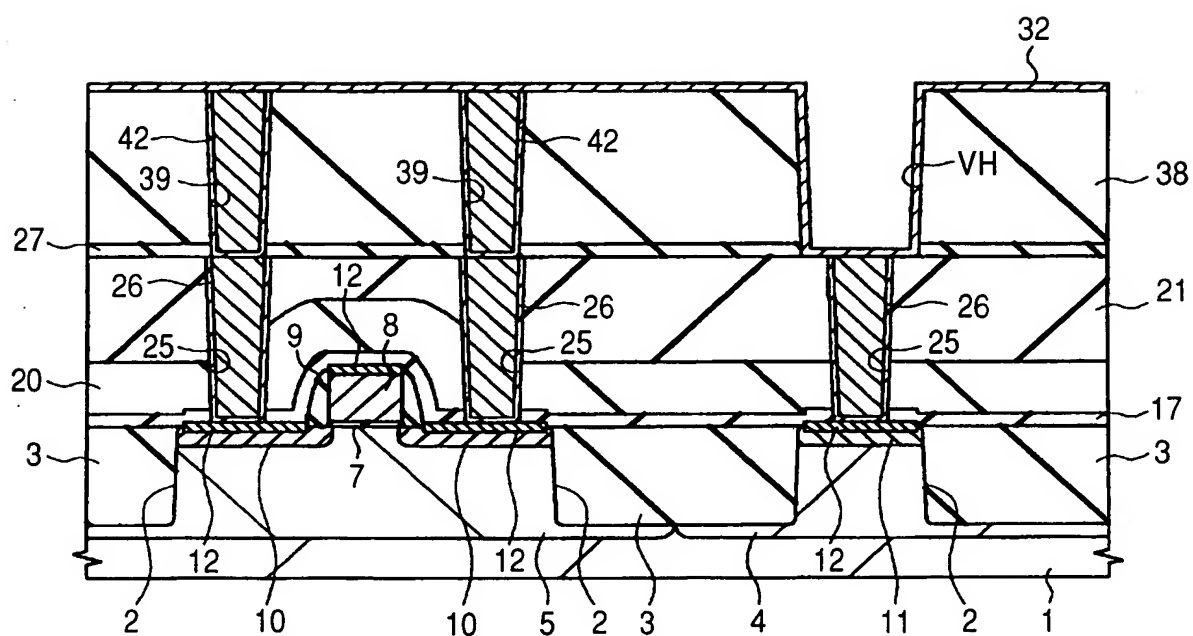


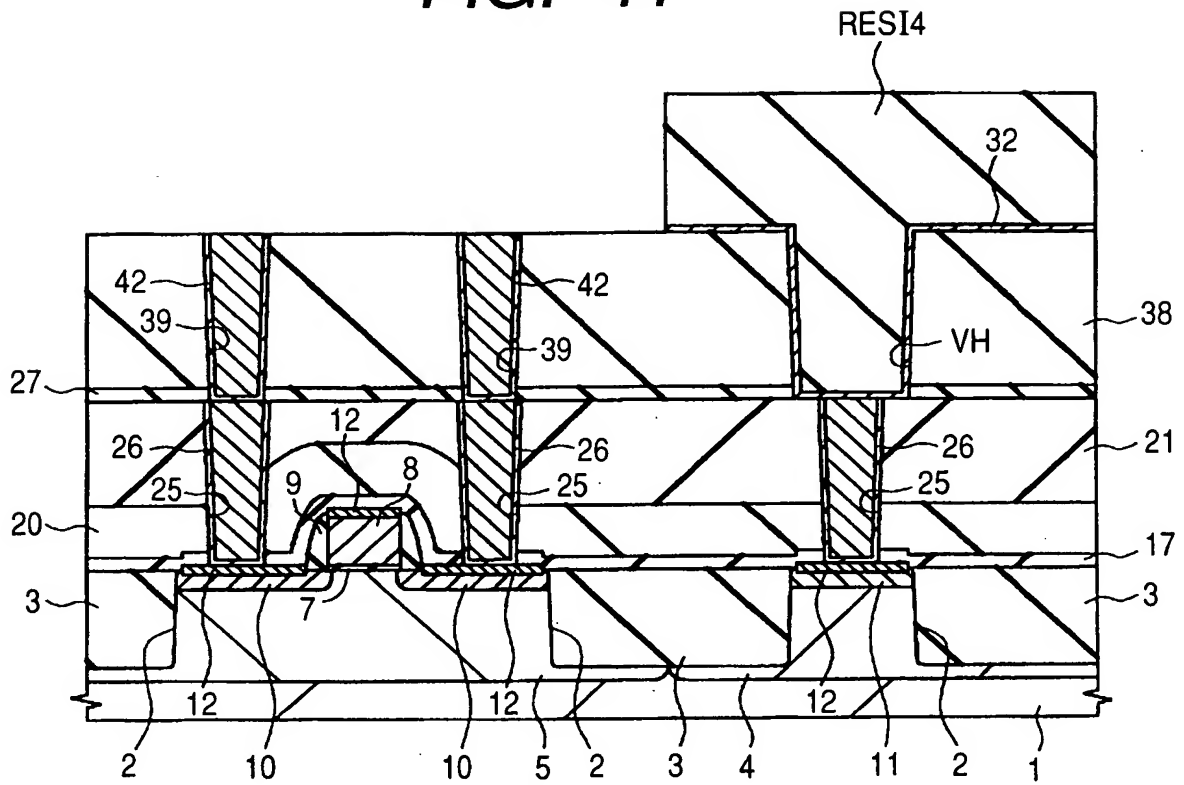
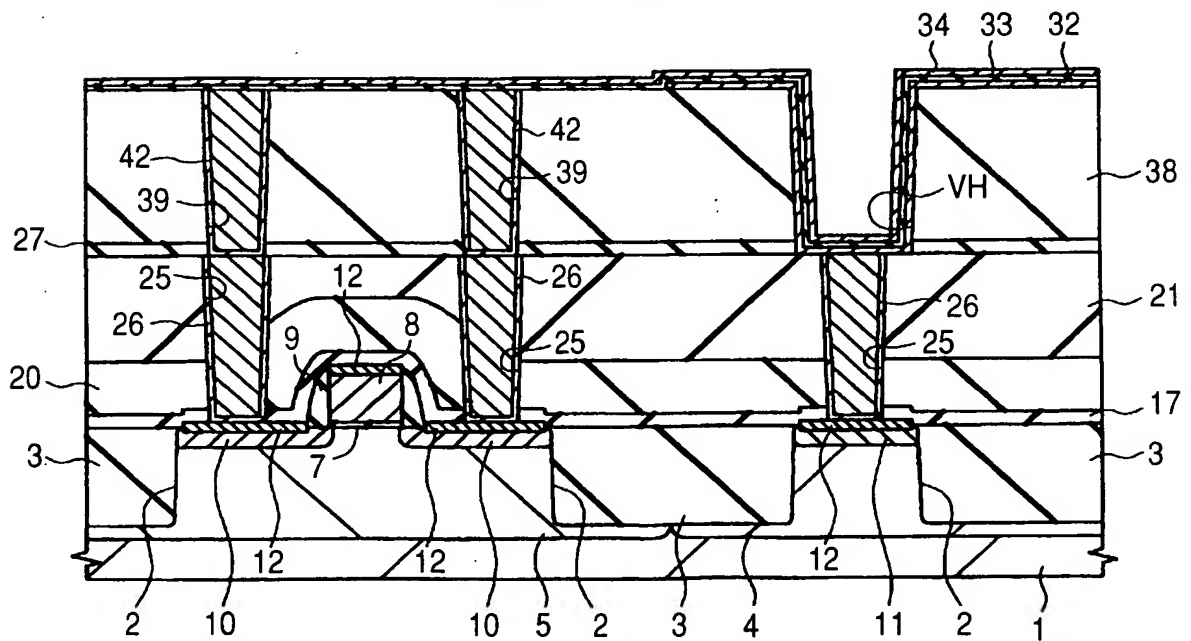
FIG. 41**FIG. 42**

FIG. 43

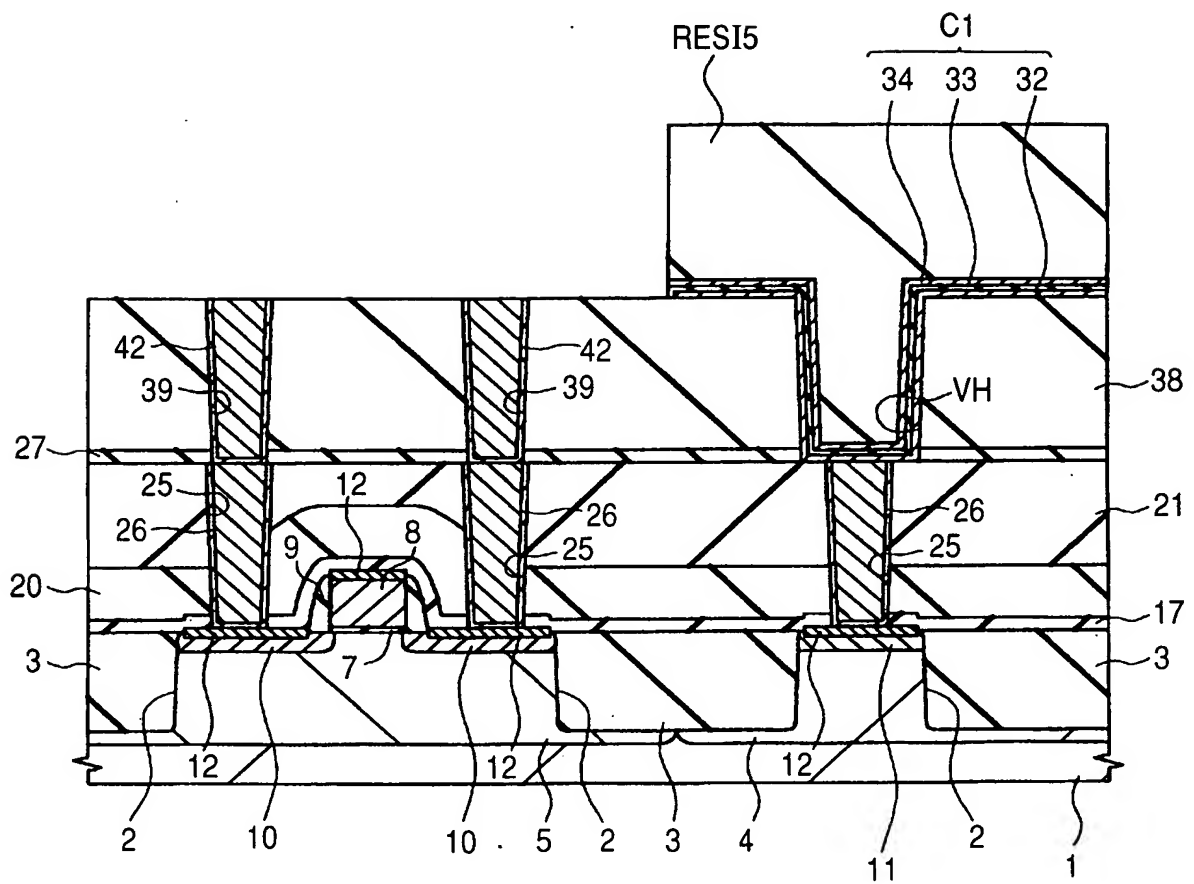


FIG. 44

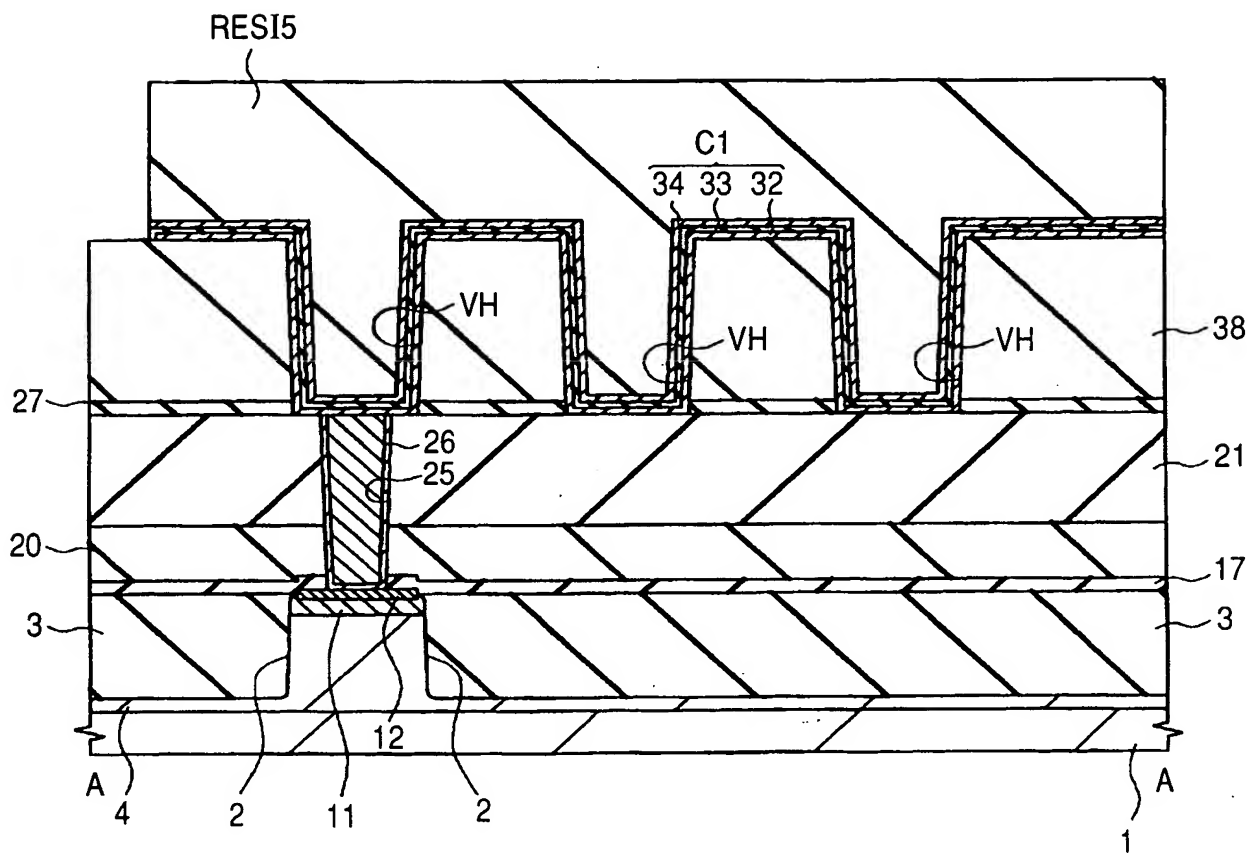


FIG. 45

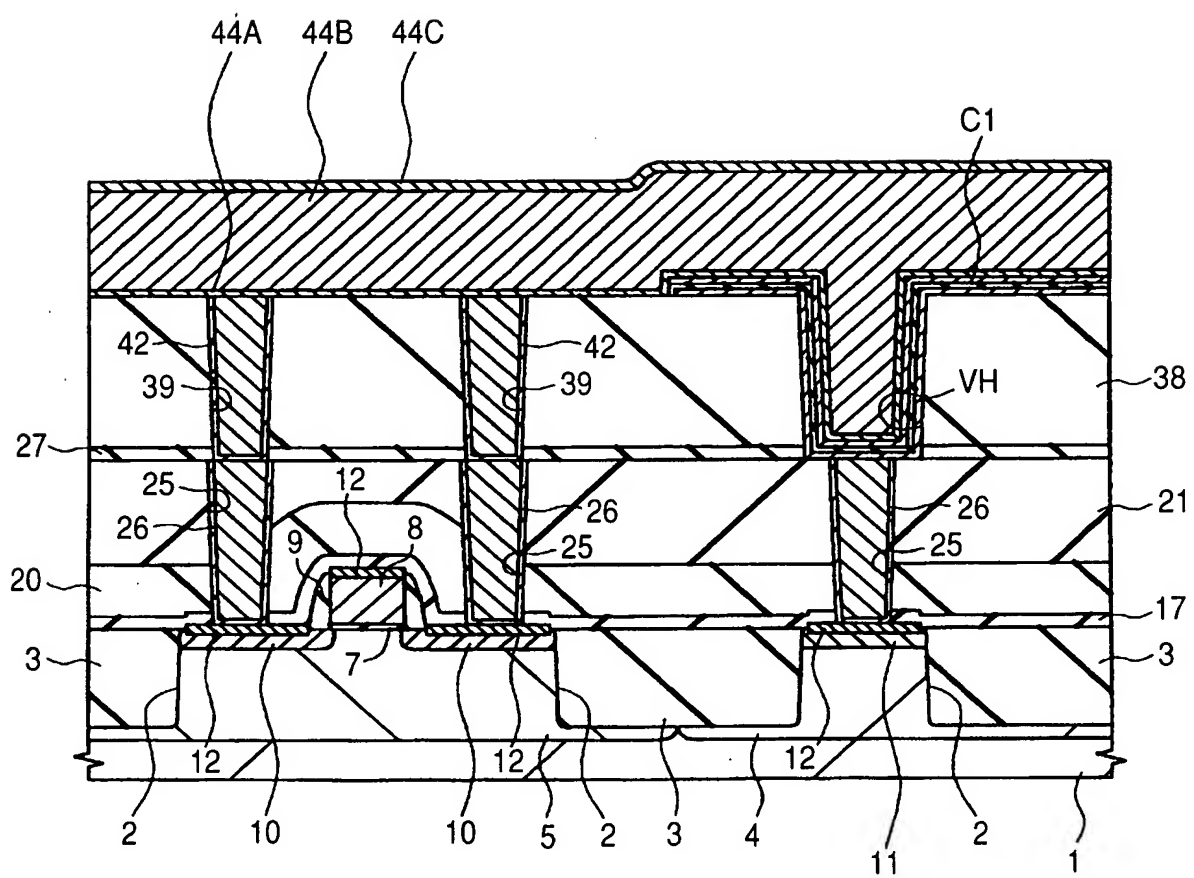


FIG. 47

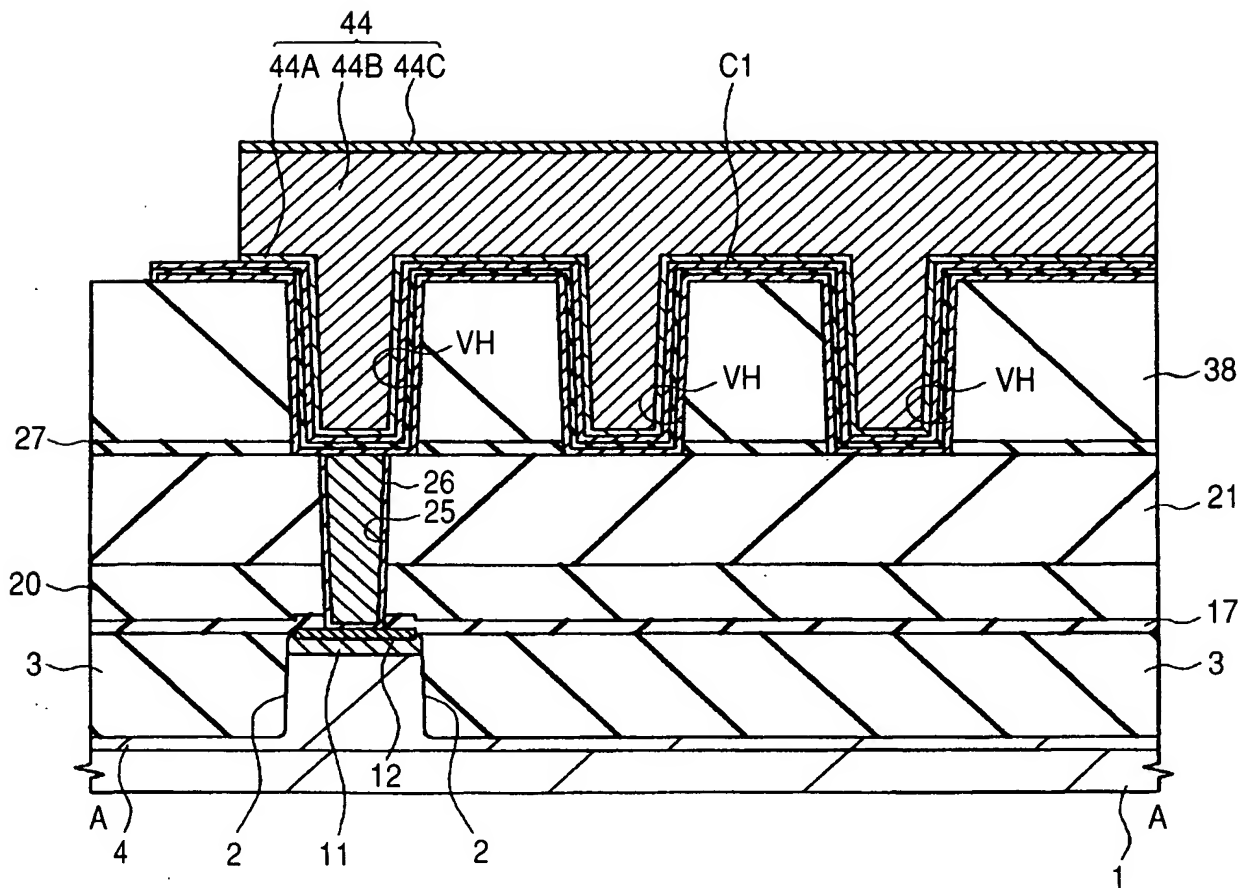


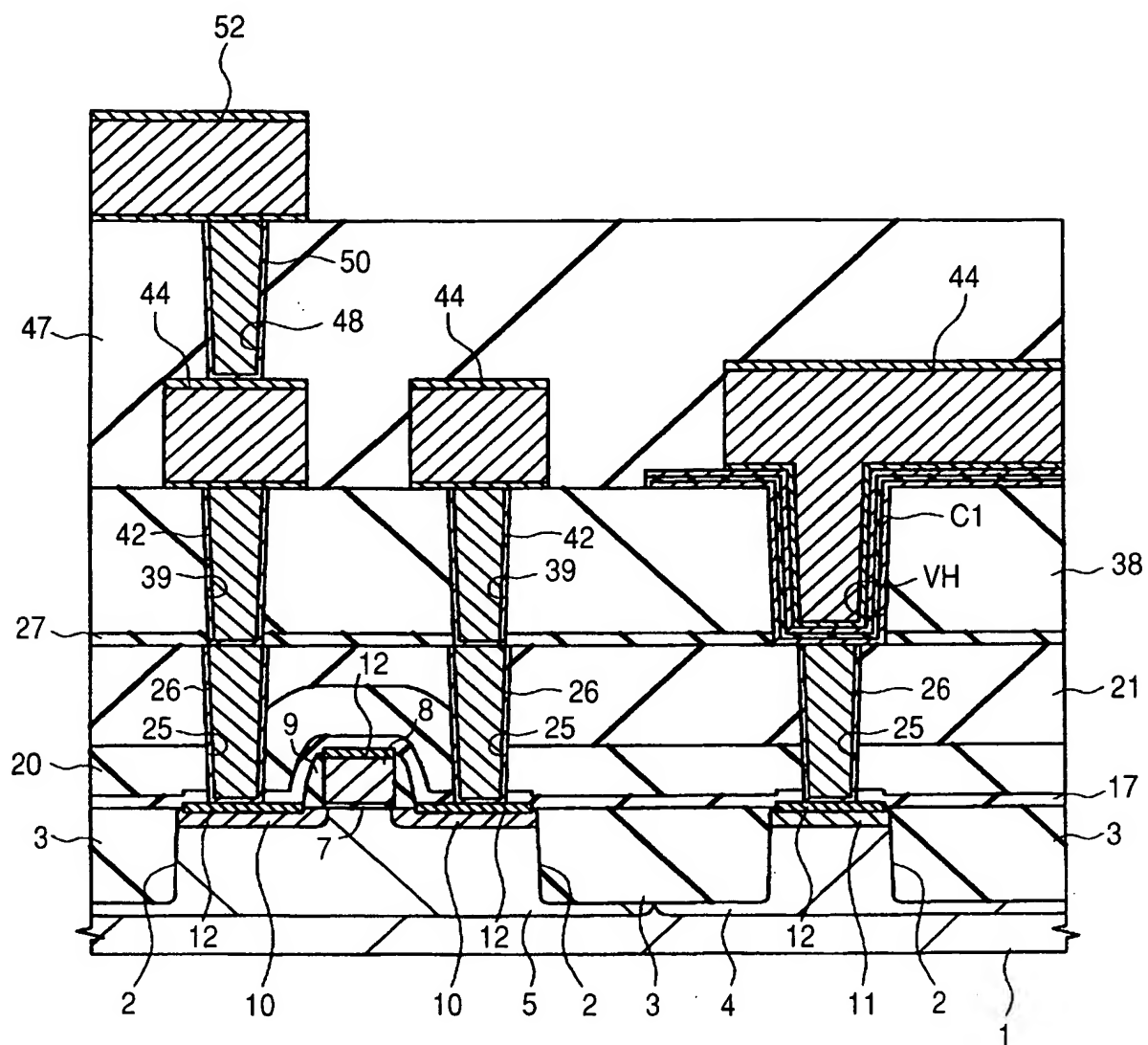
FIG. 48

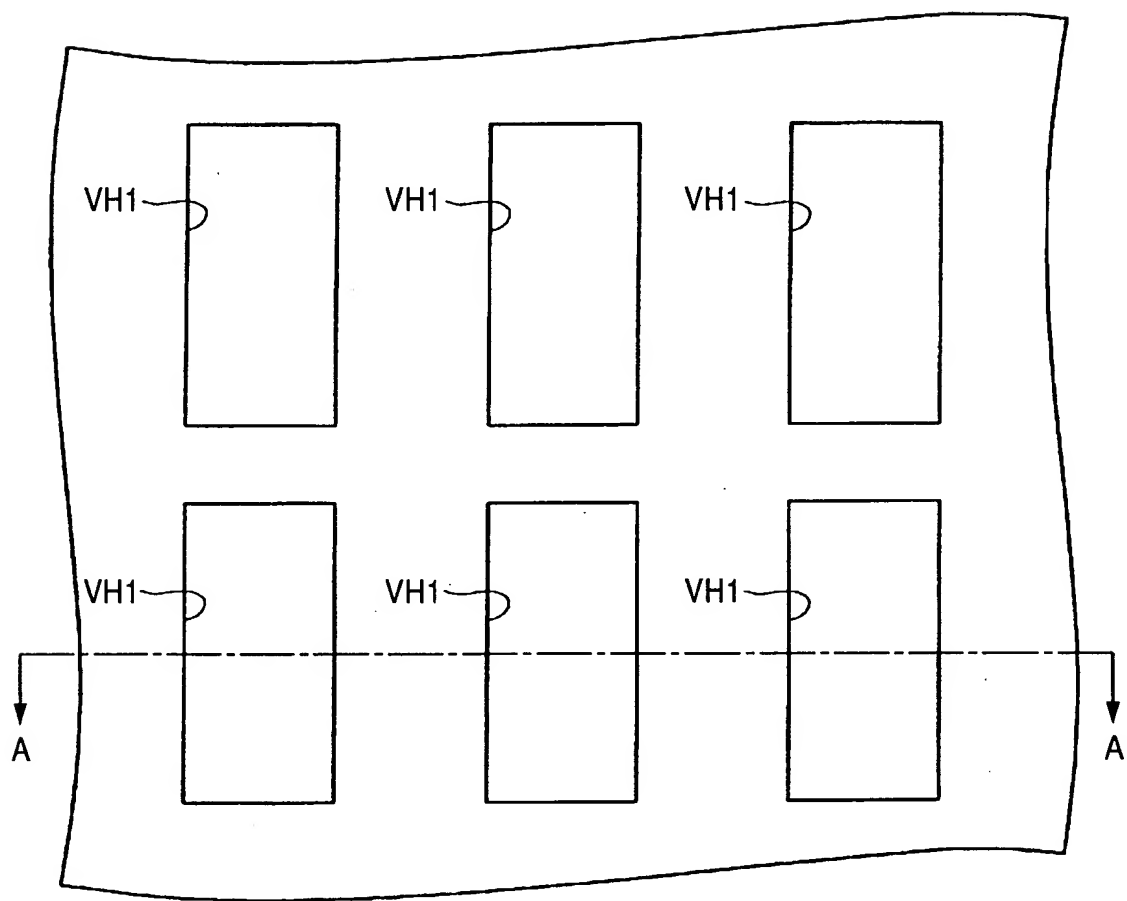
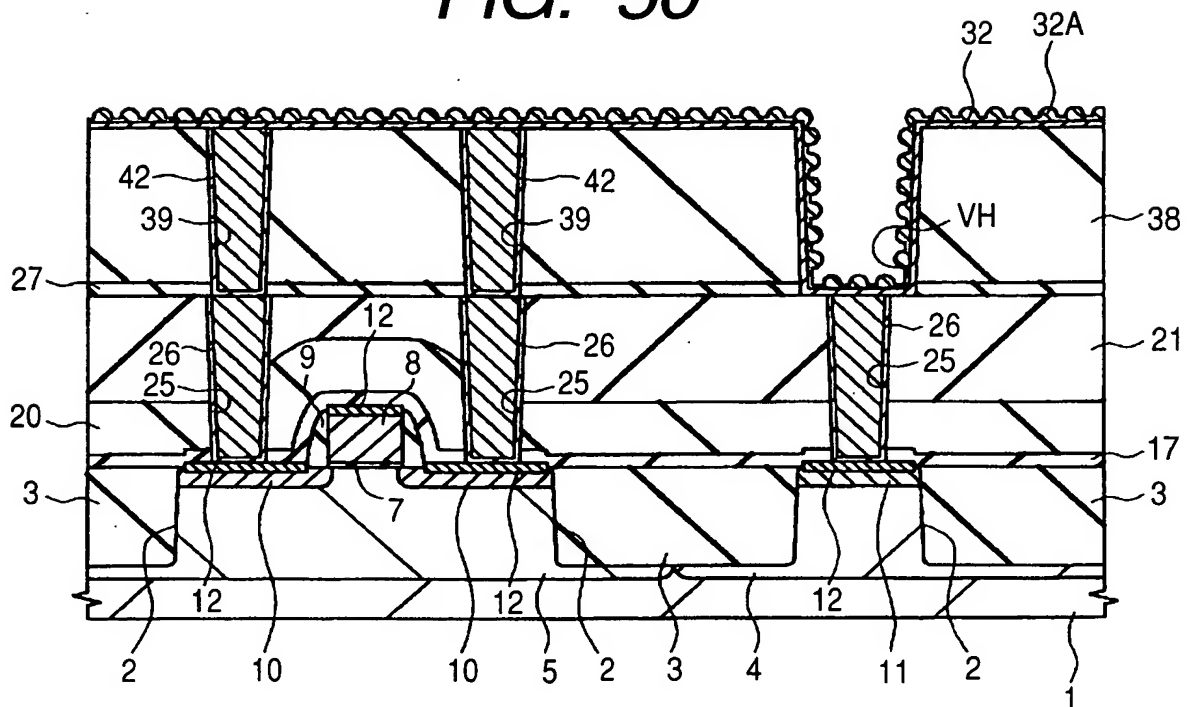
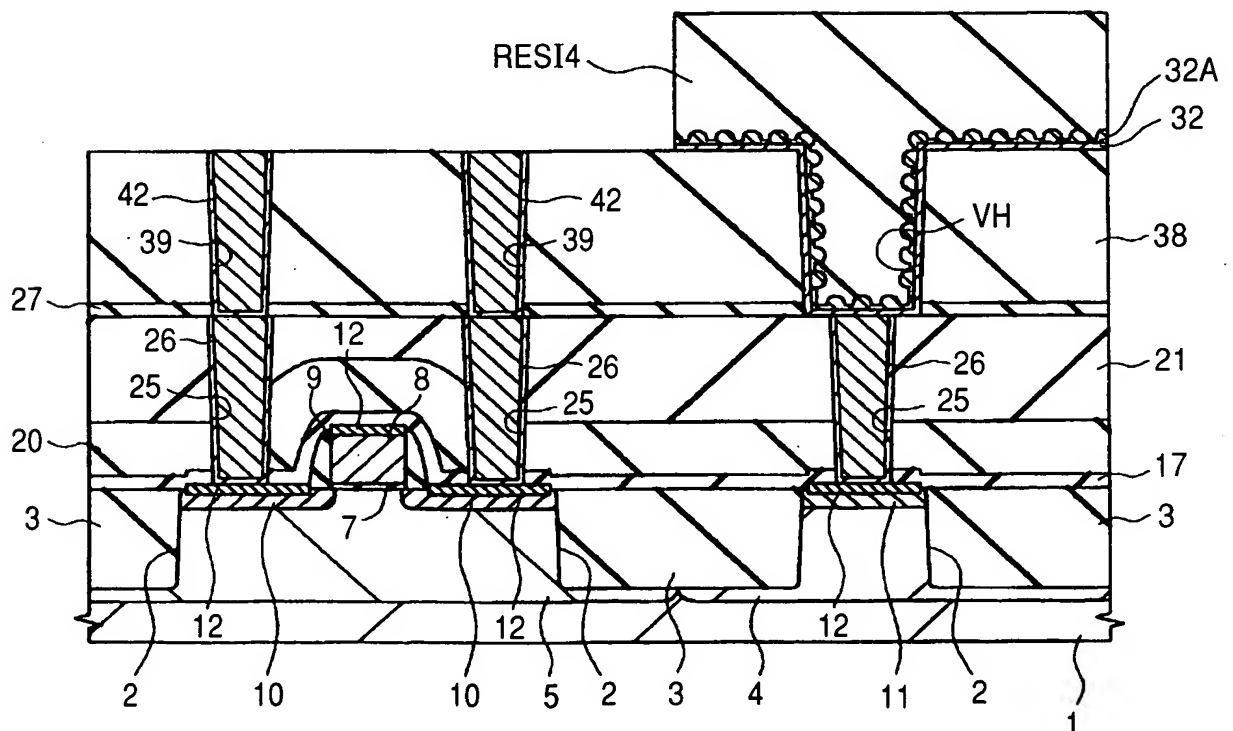
FIG. 49

FIG. 50**FIG. 51**

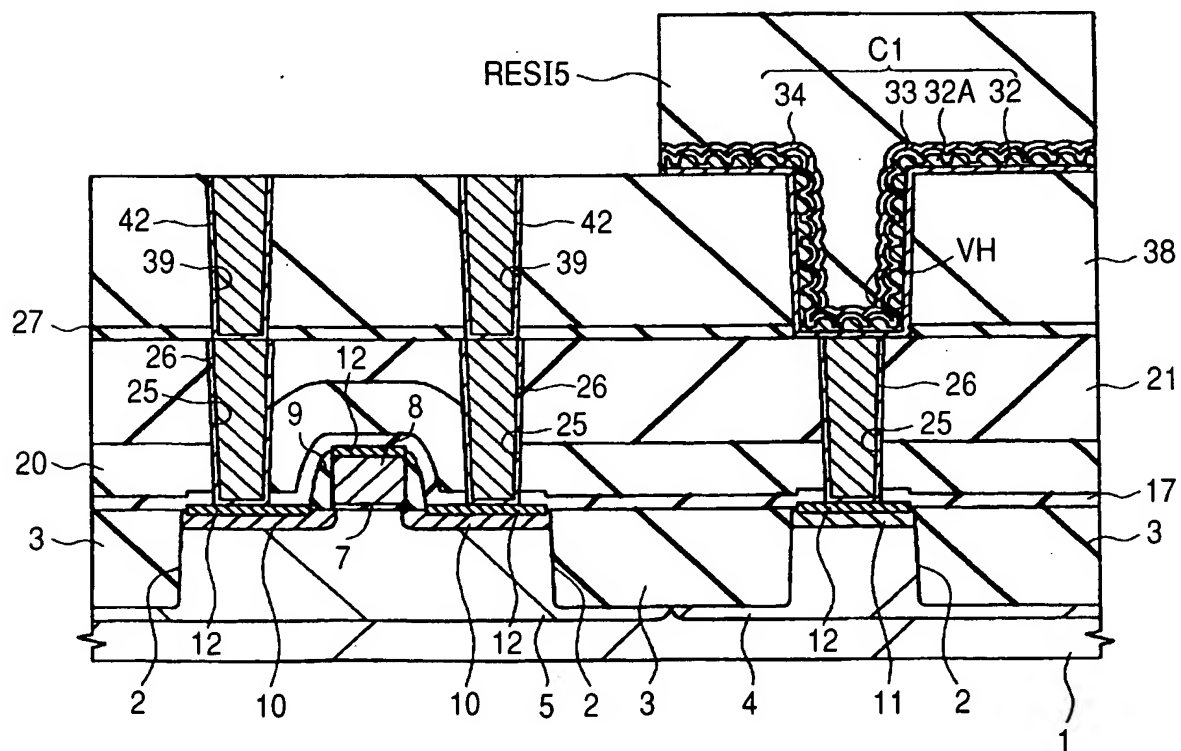


FIG. 54

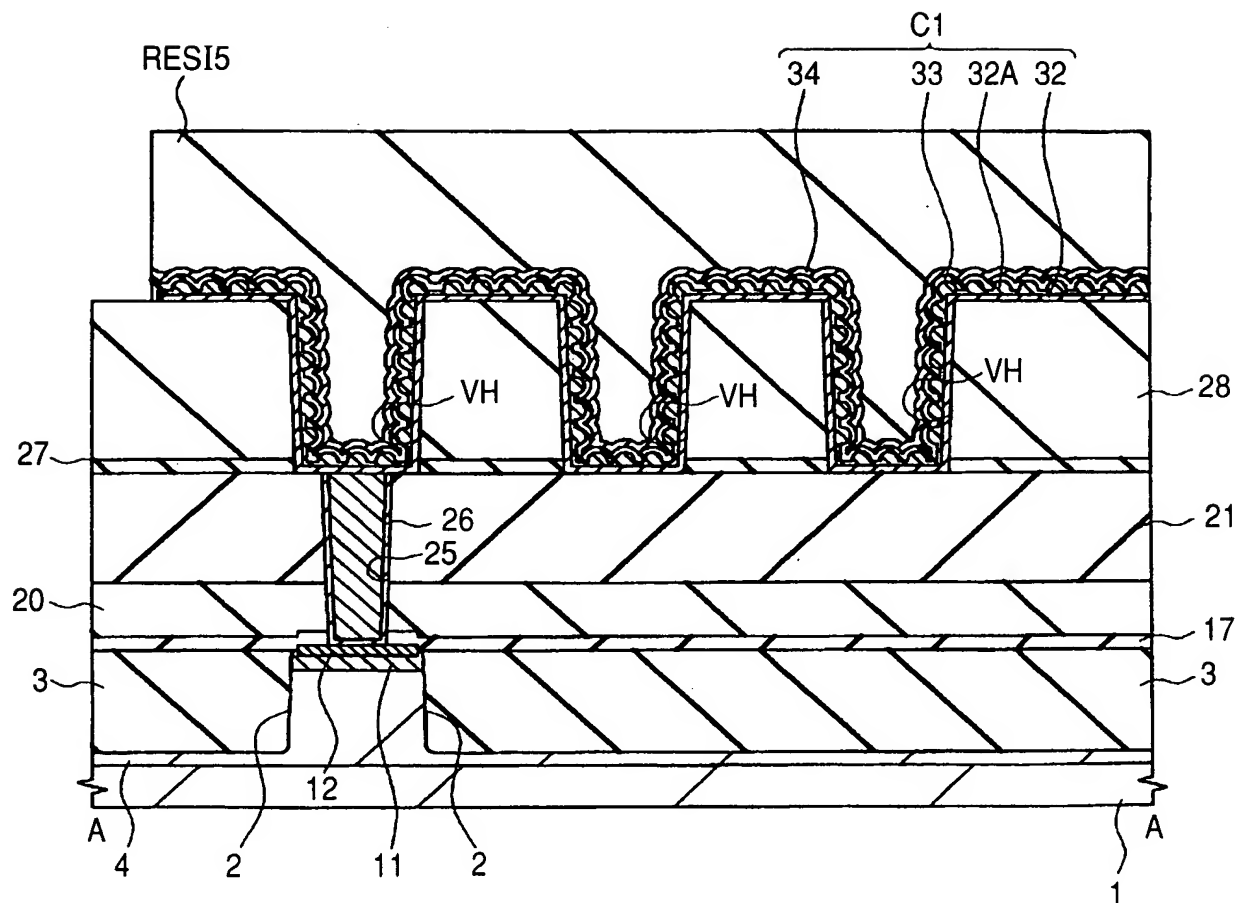


FIG. 55

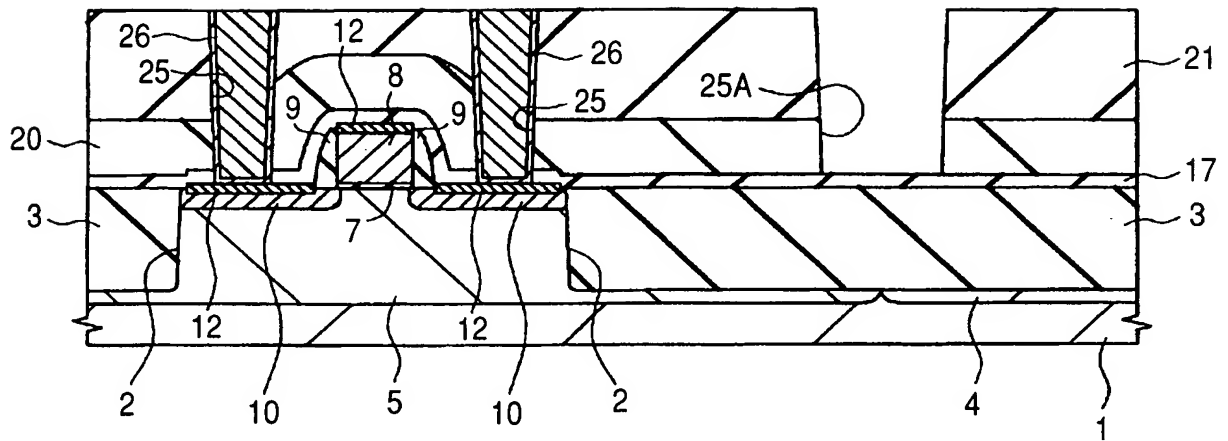


FIG. 56

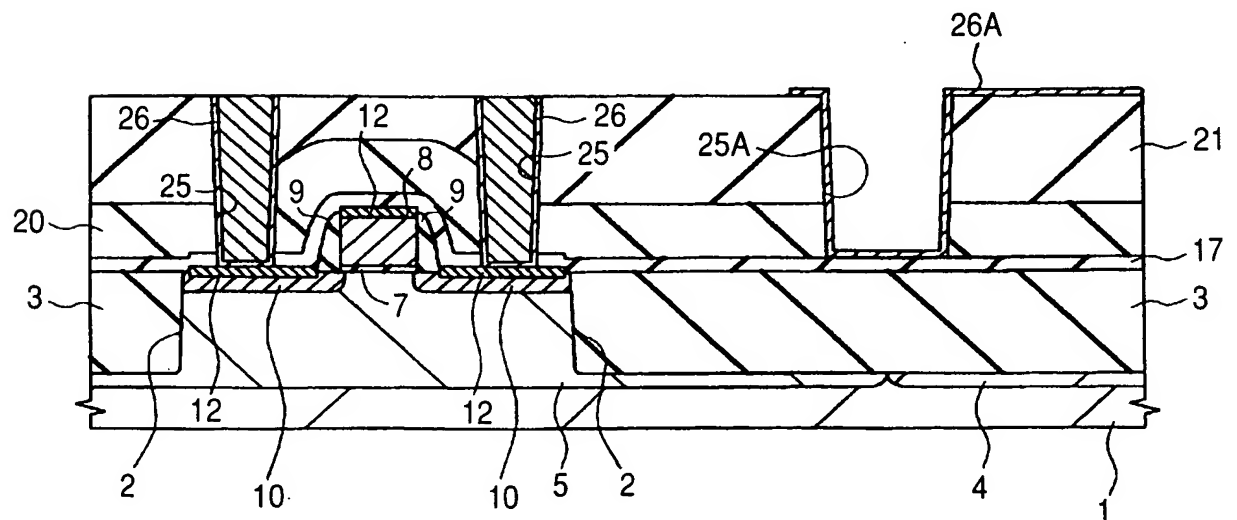


FIG. 57

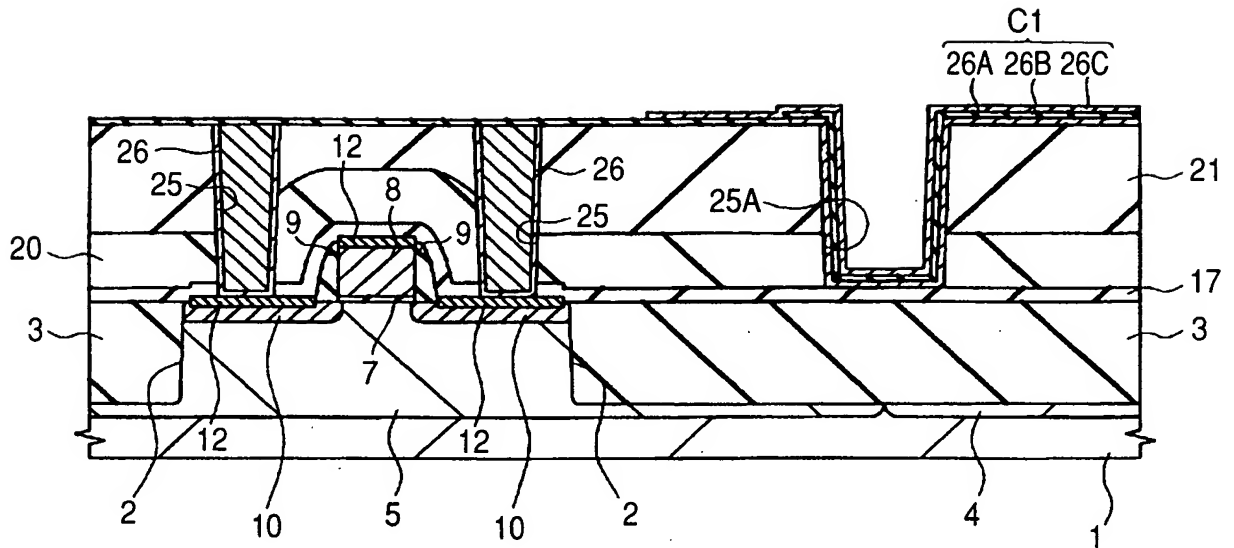


FIG. 58

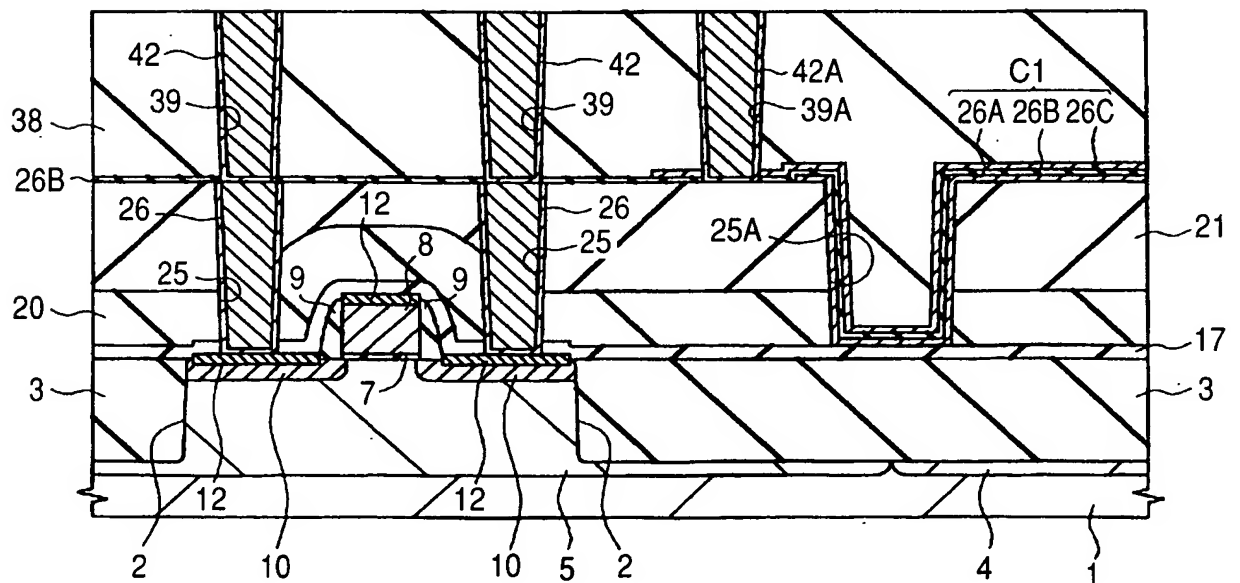


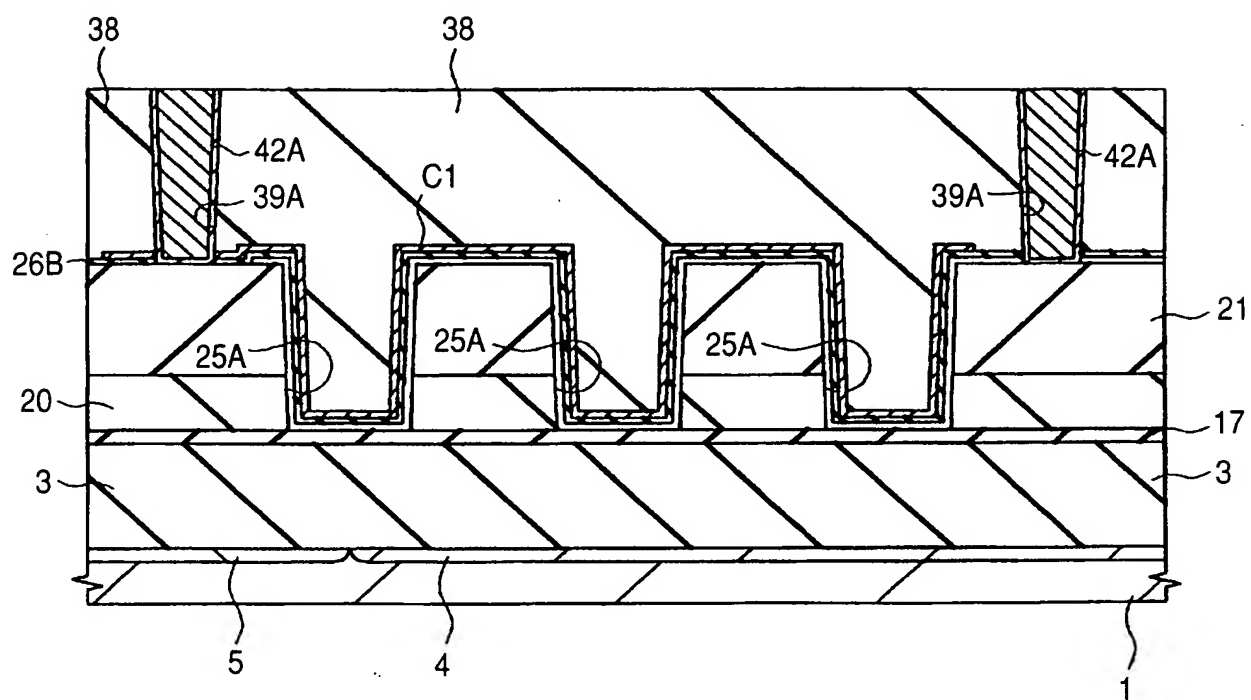
FIG. 59

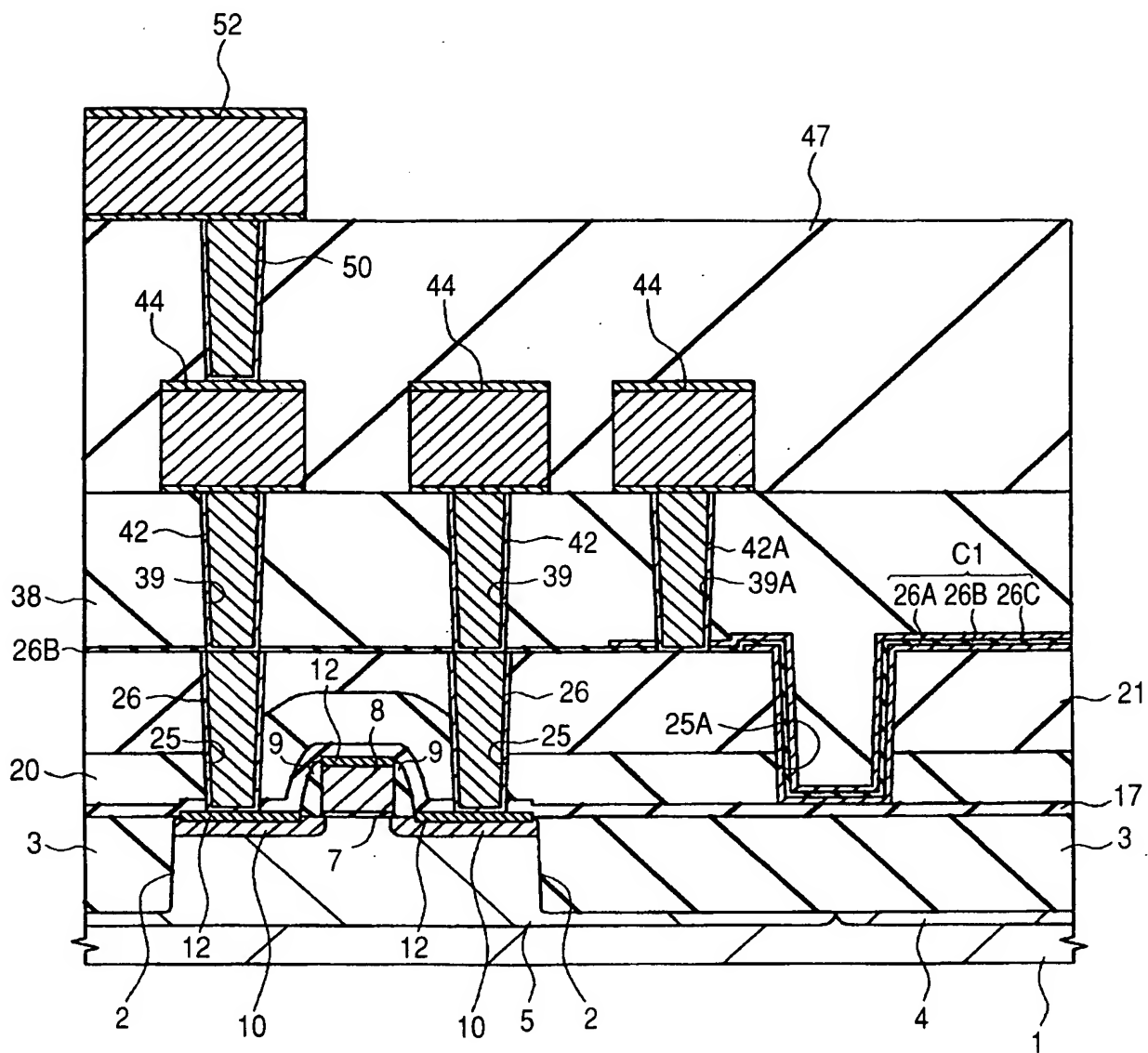
FIG. 60

FIG. 61

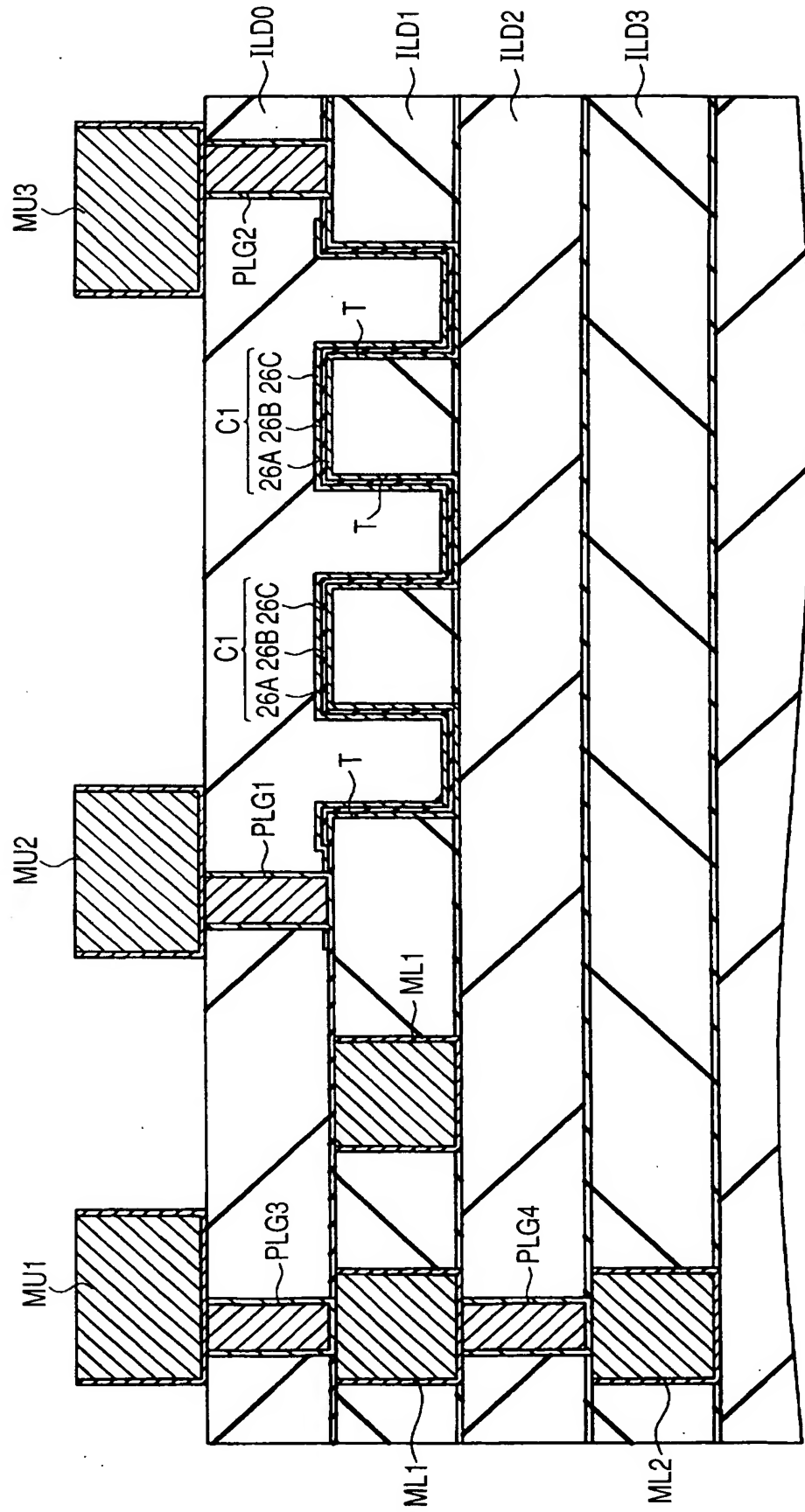


FIG. 62

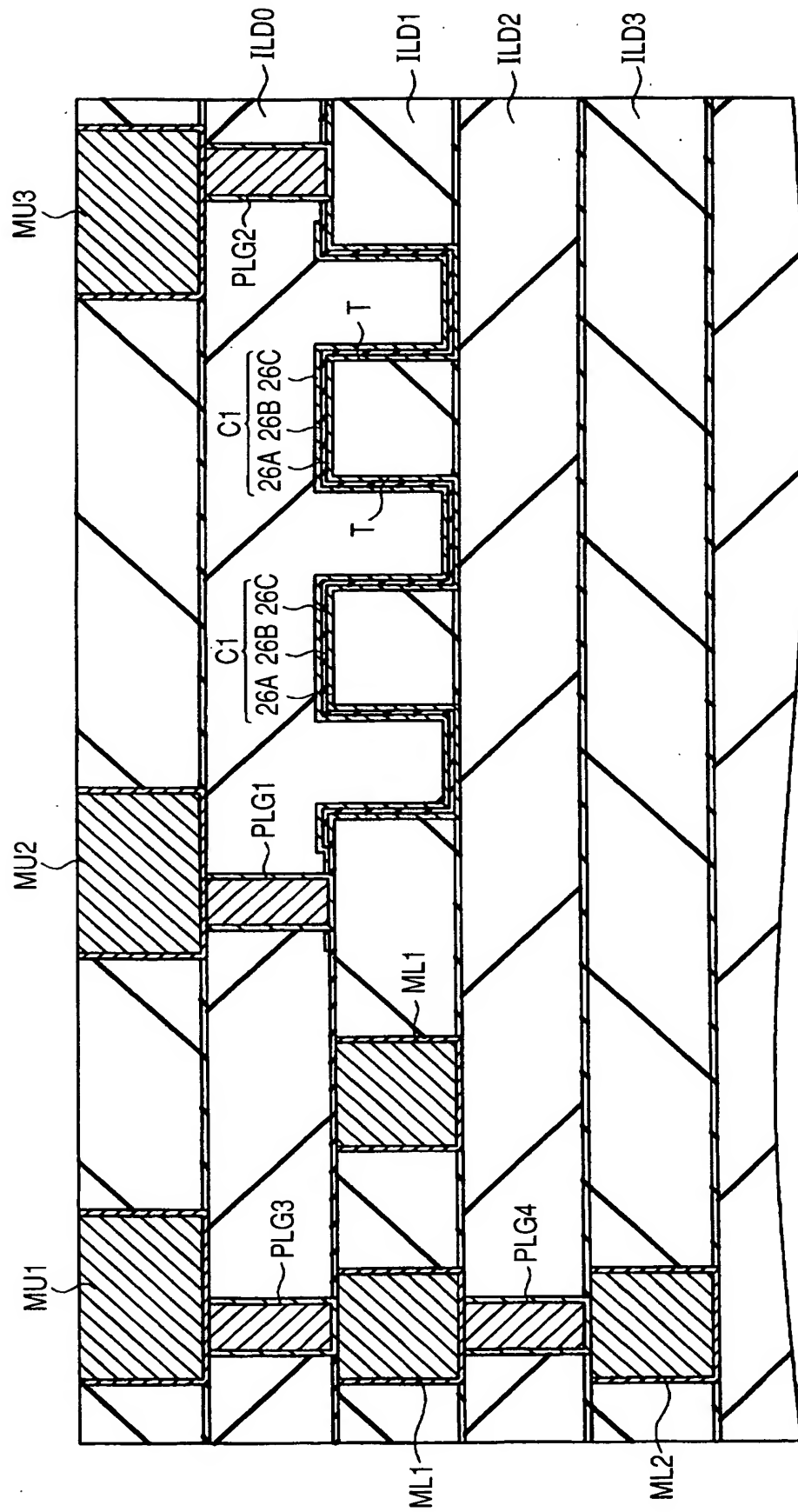
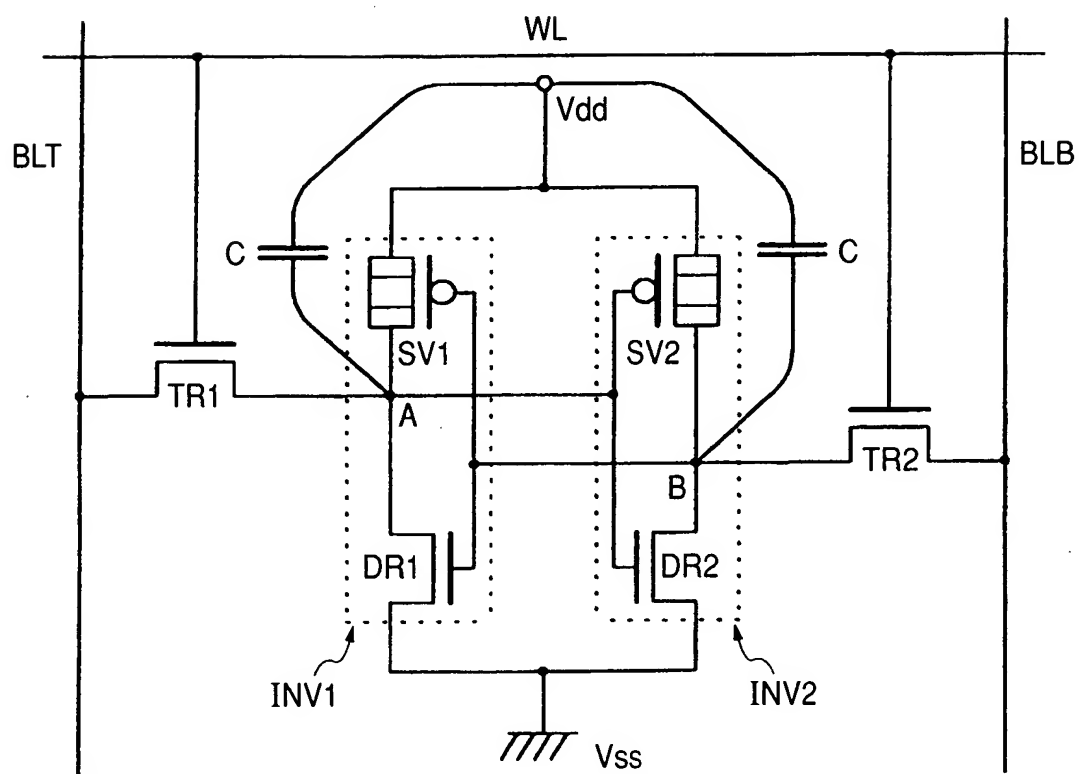


FIG. 63

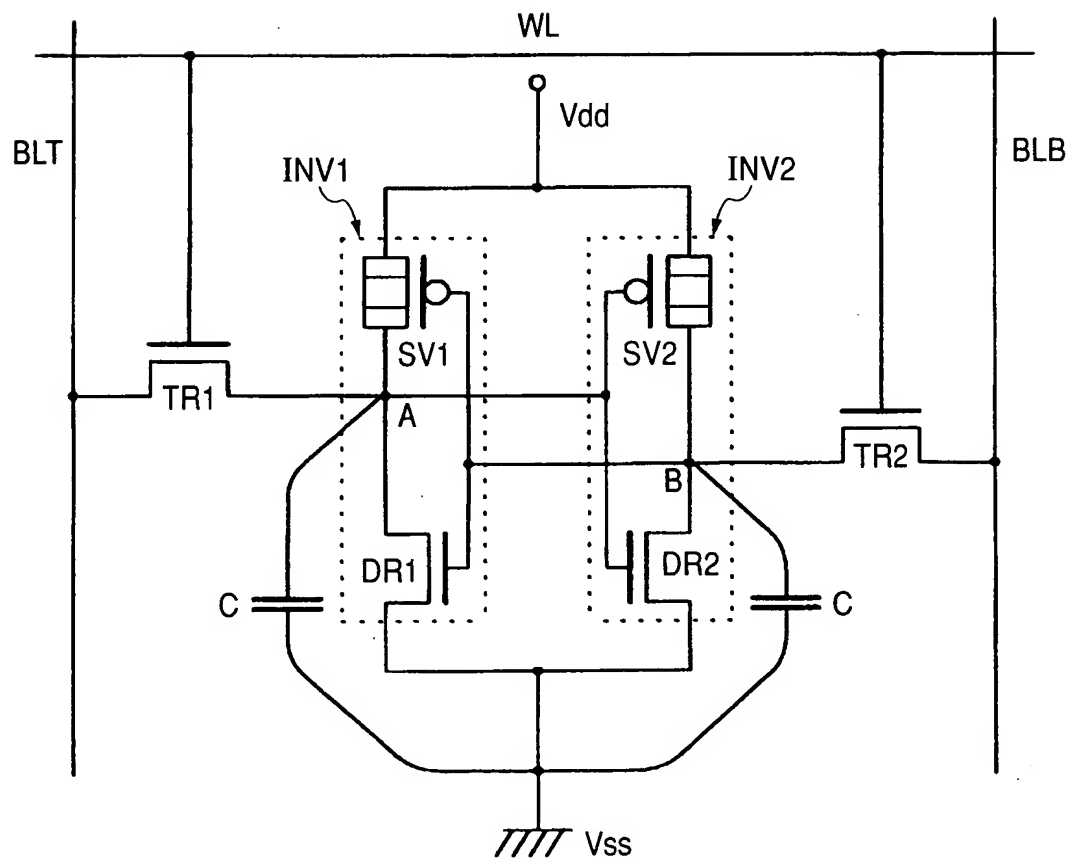
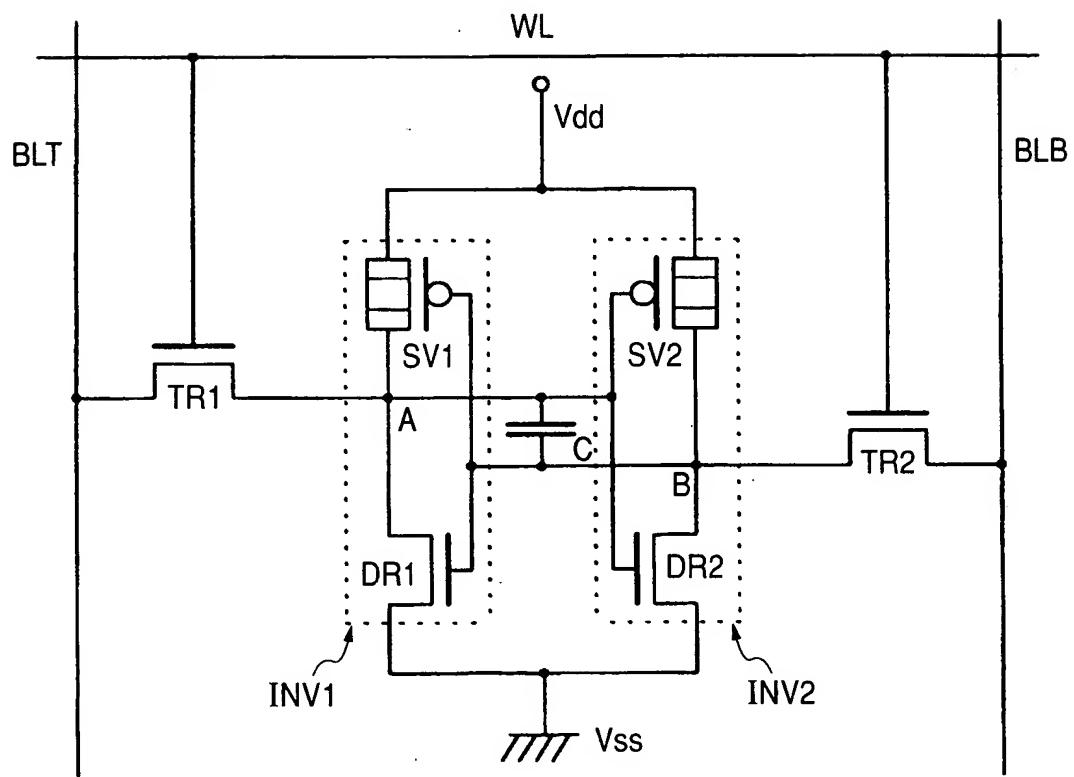


FIG. 65

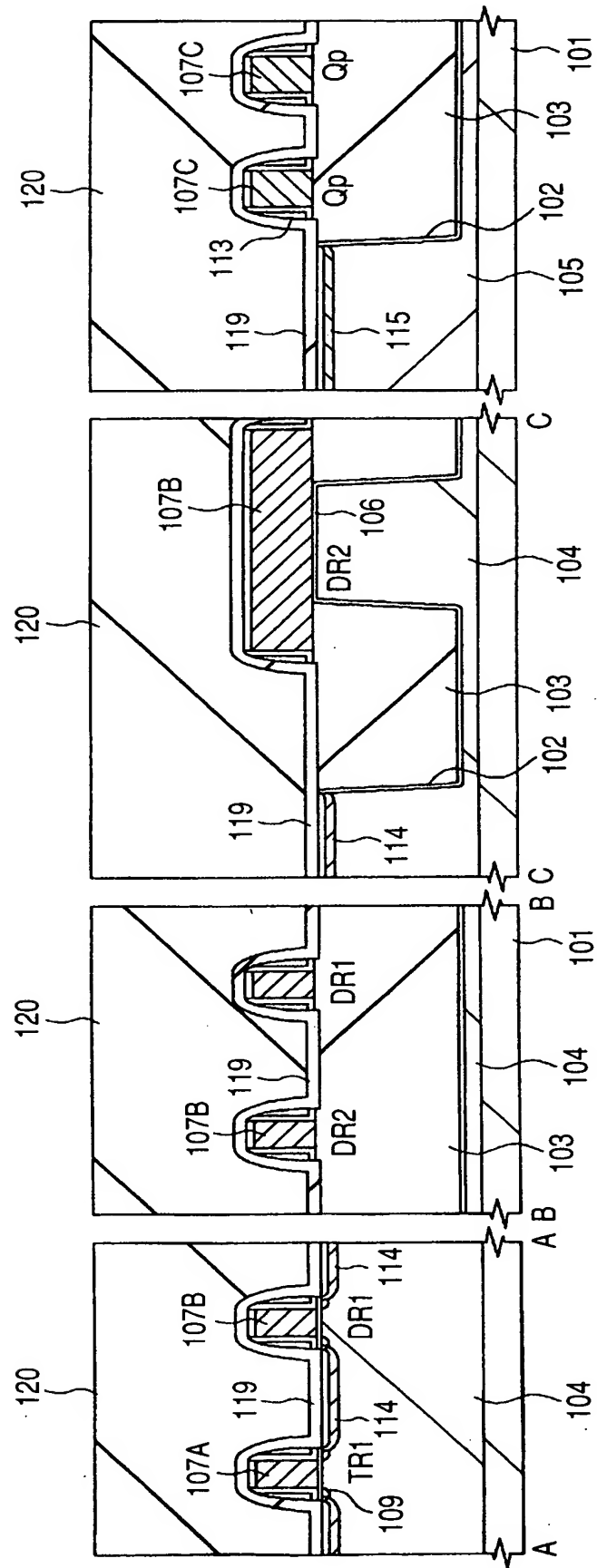


FIG. 67

FIG. 71

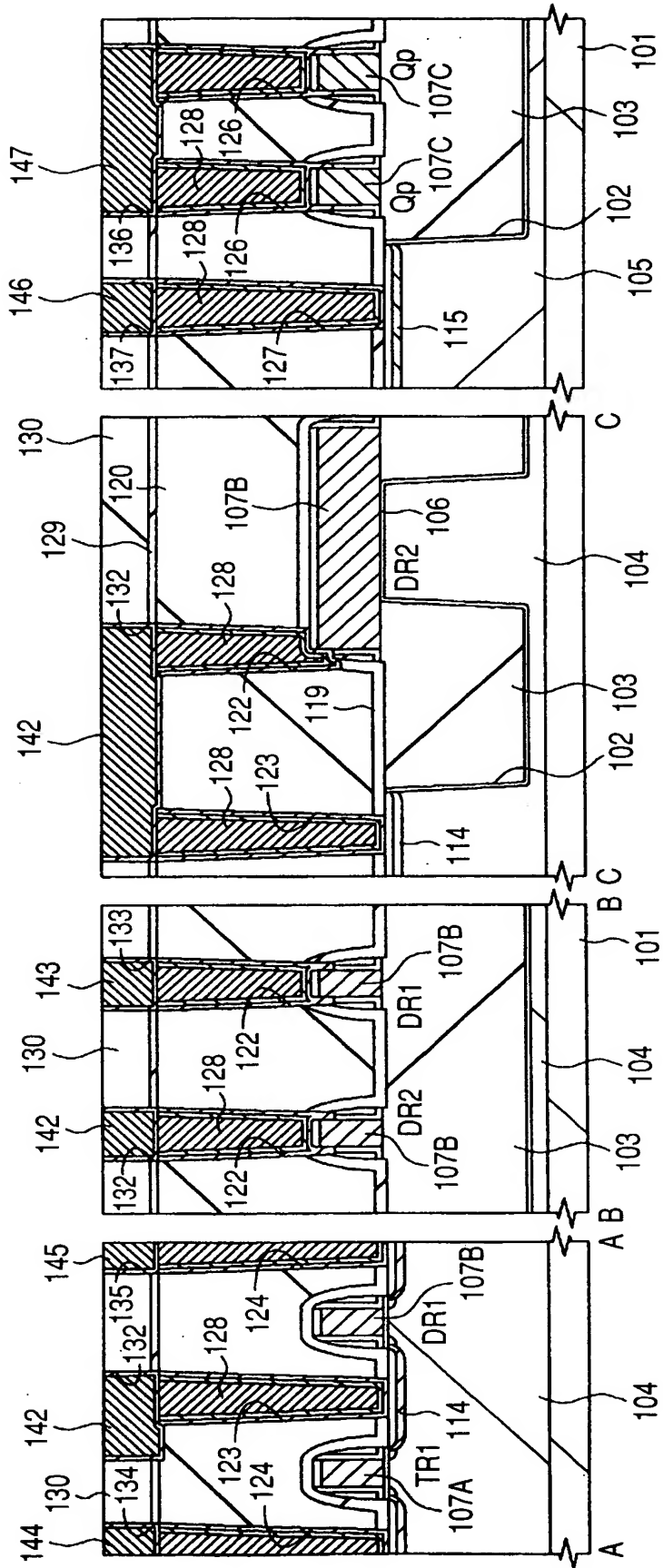


FIG. 72

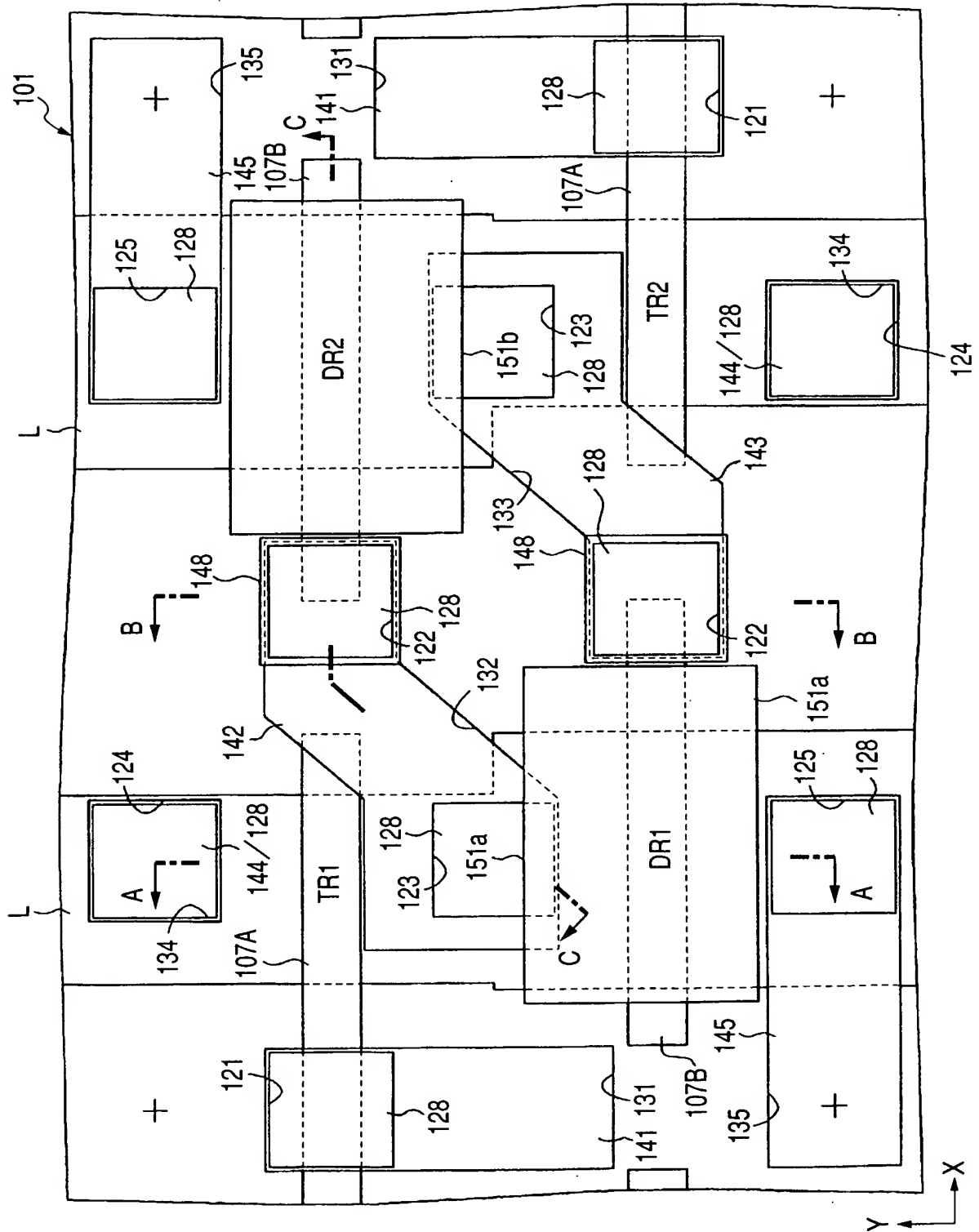


FIG. 73

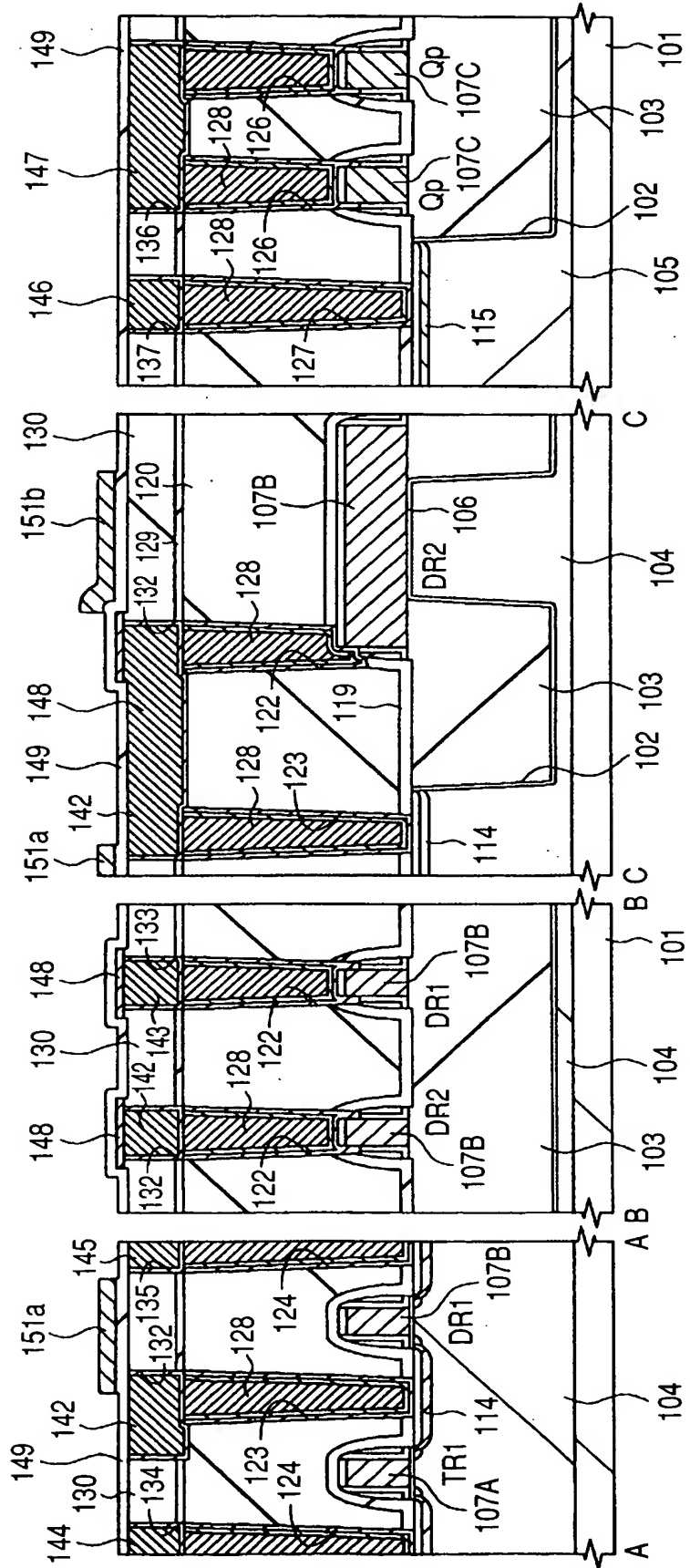


FIG. 76

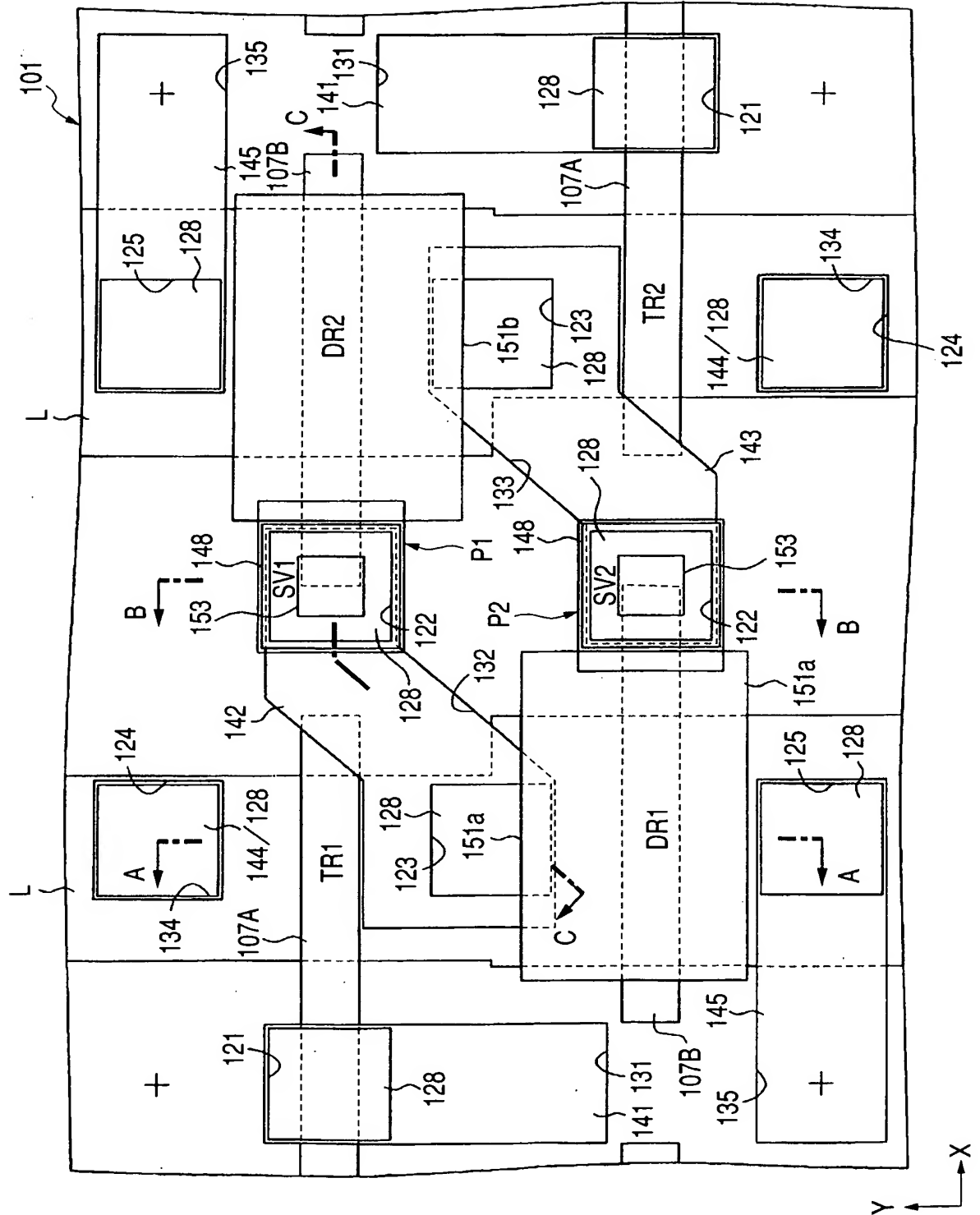


FIG. 78

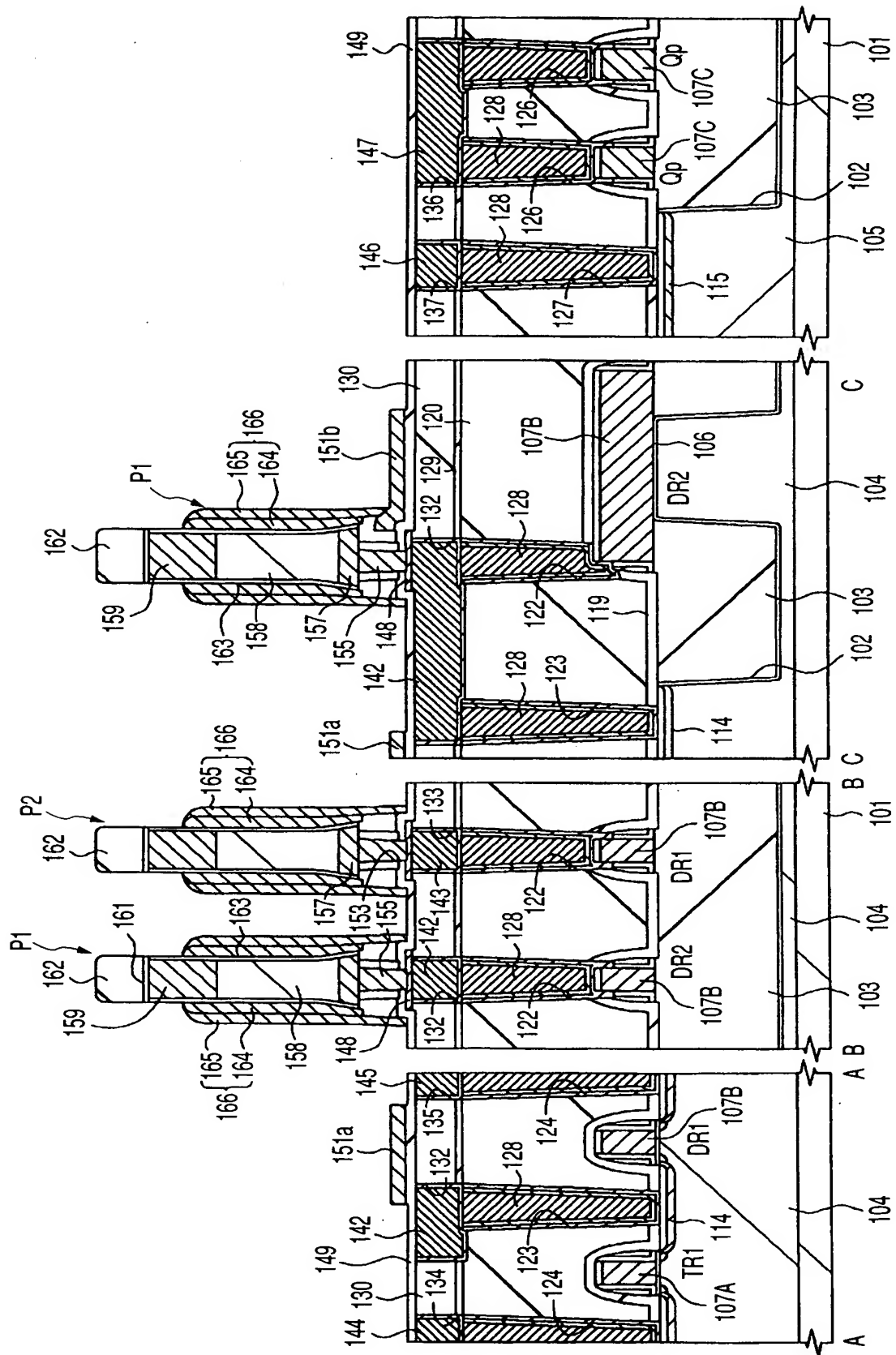


FIG. 79

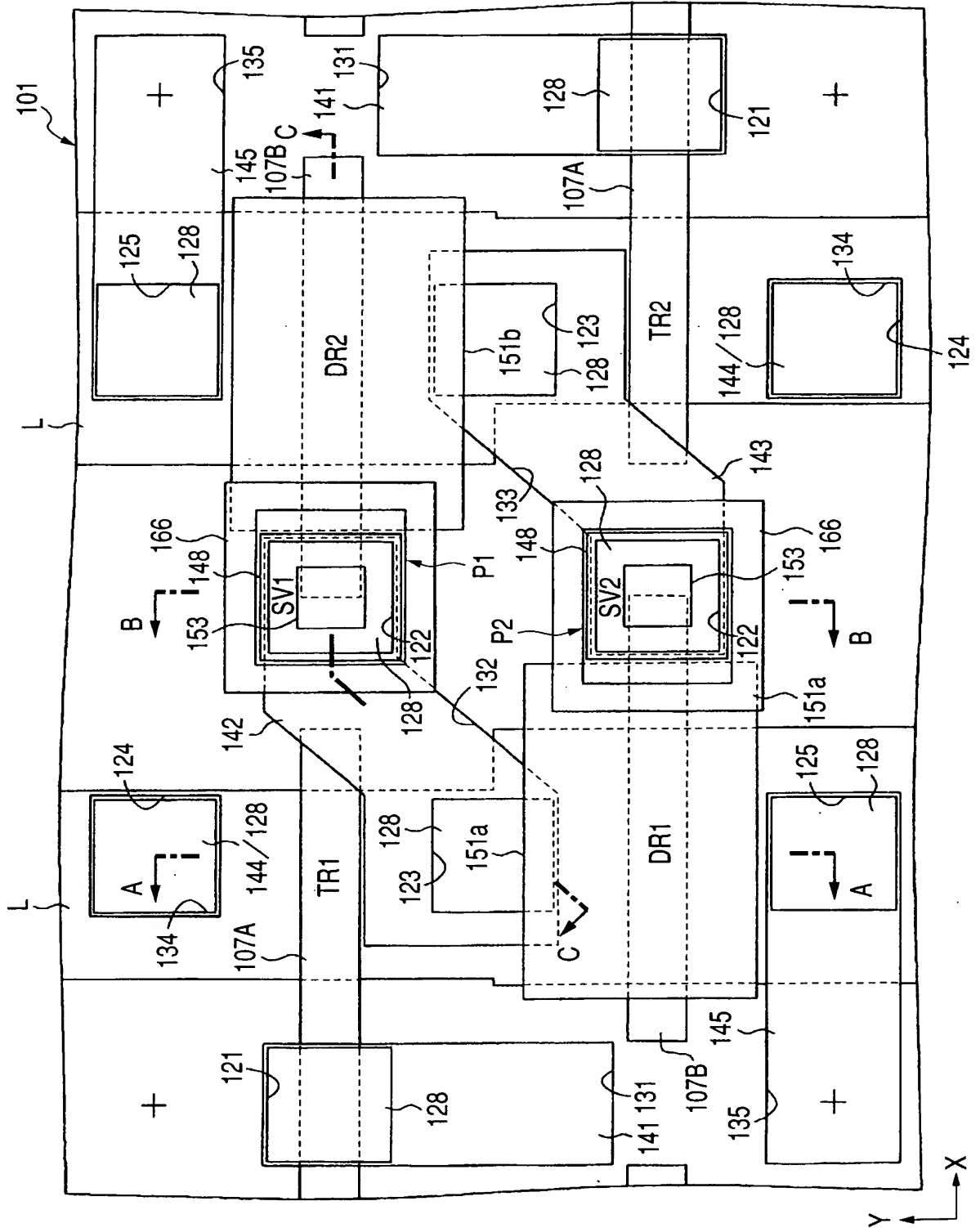


FIG. 82

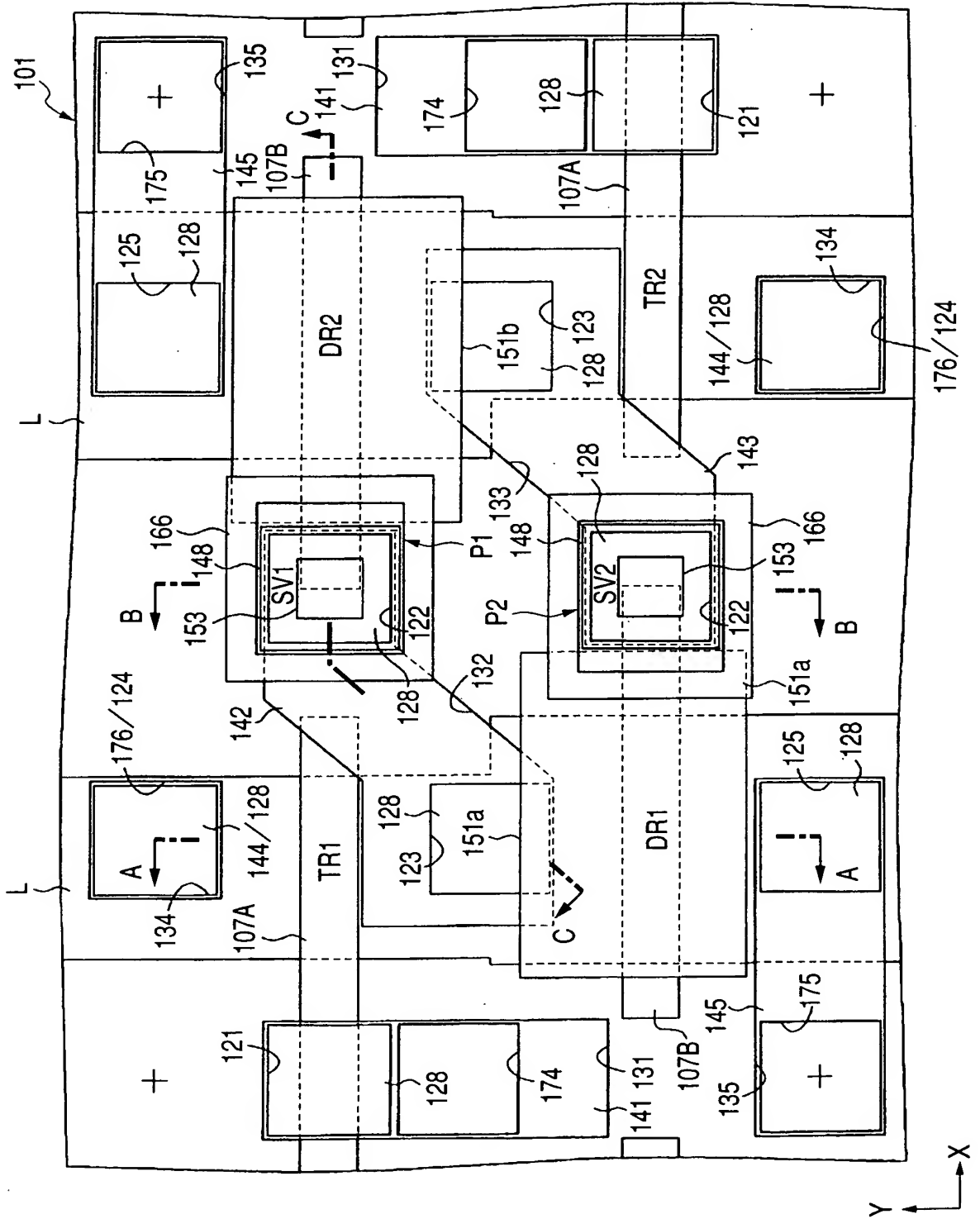


FIG. 84

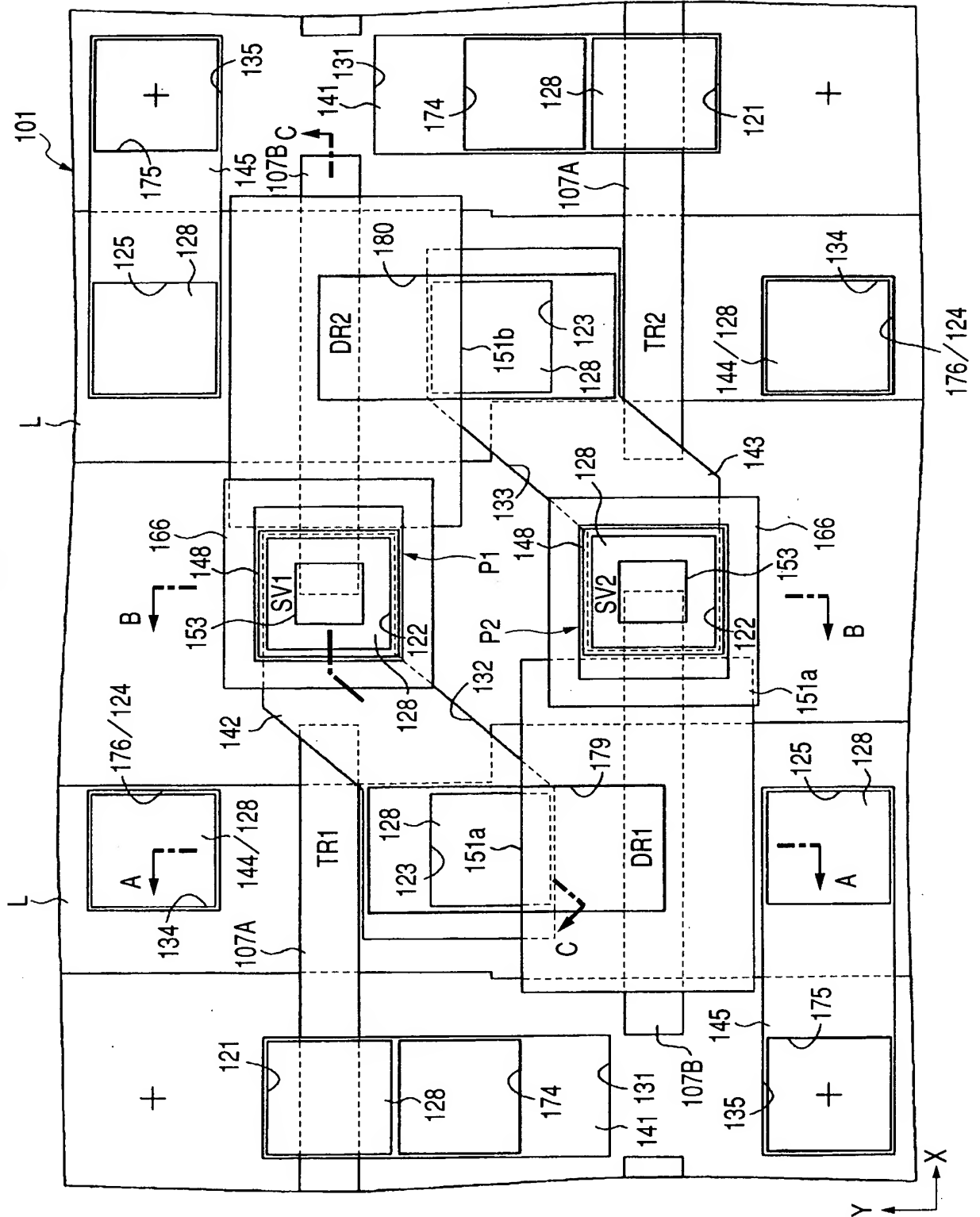


FIG. 87

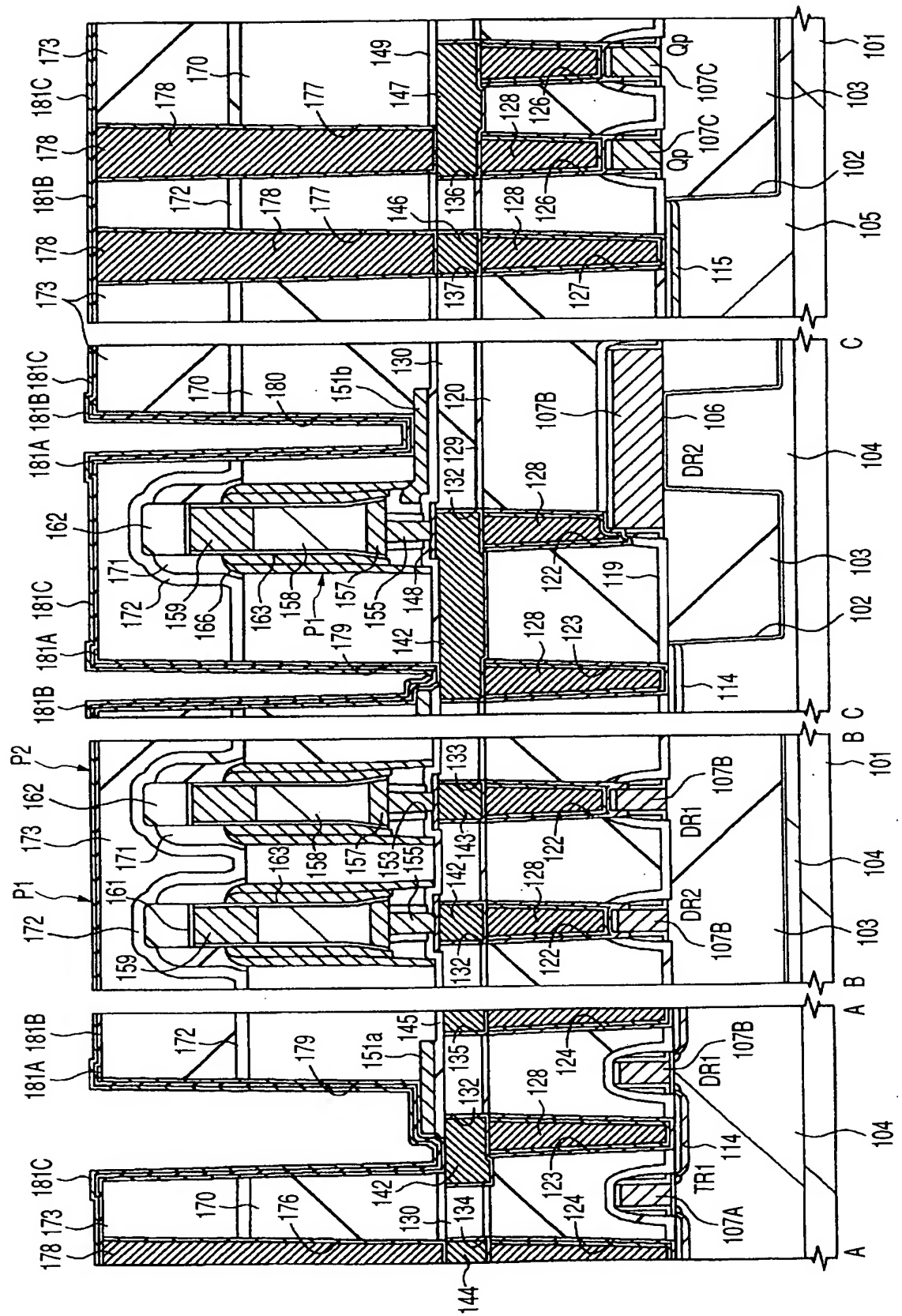


FIG. 88

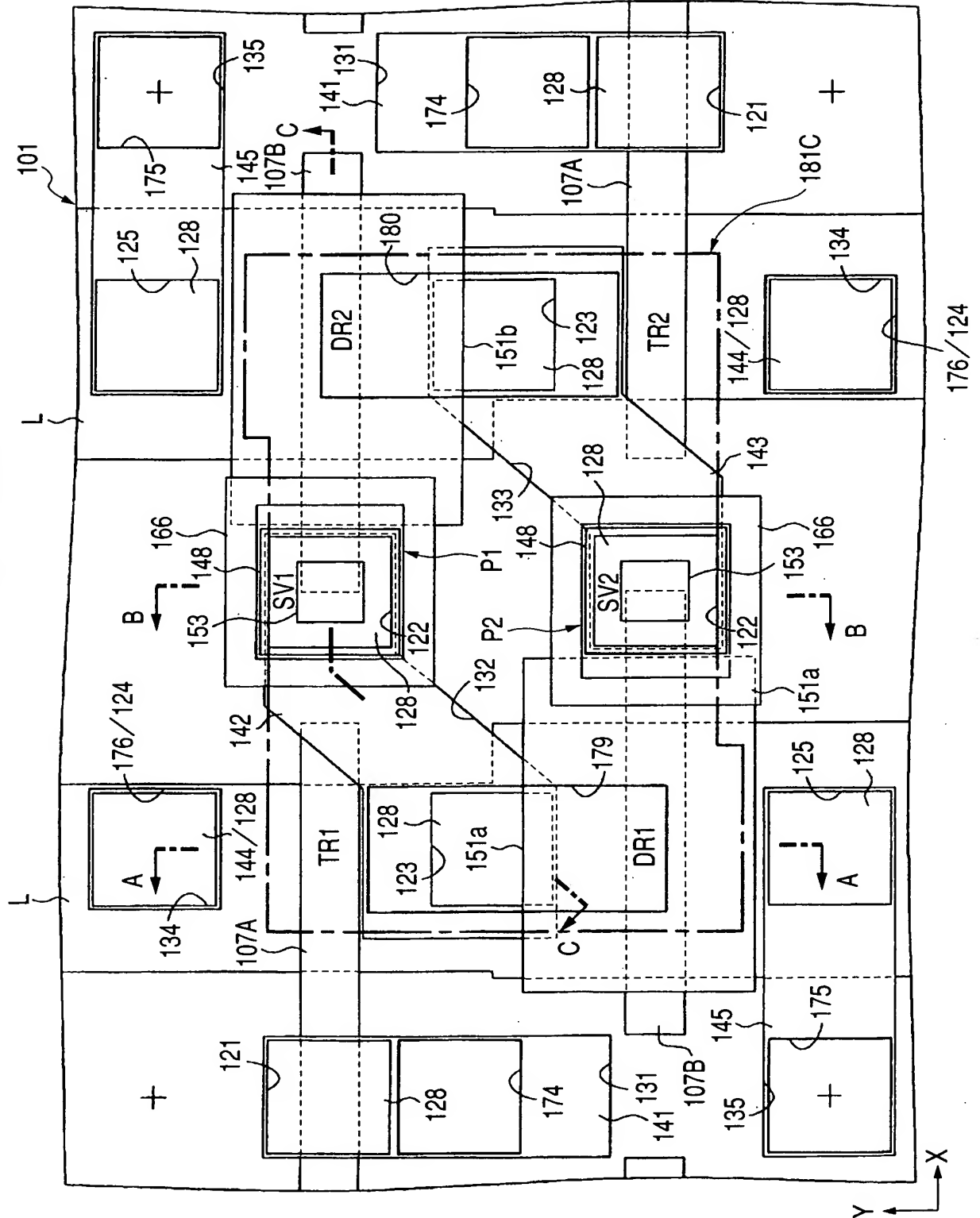
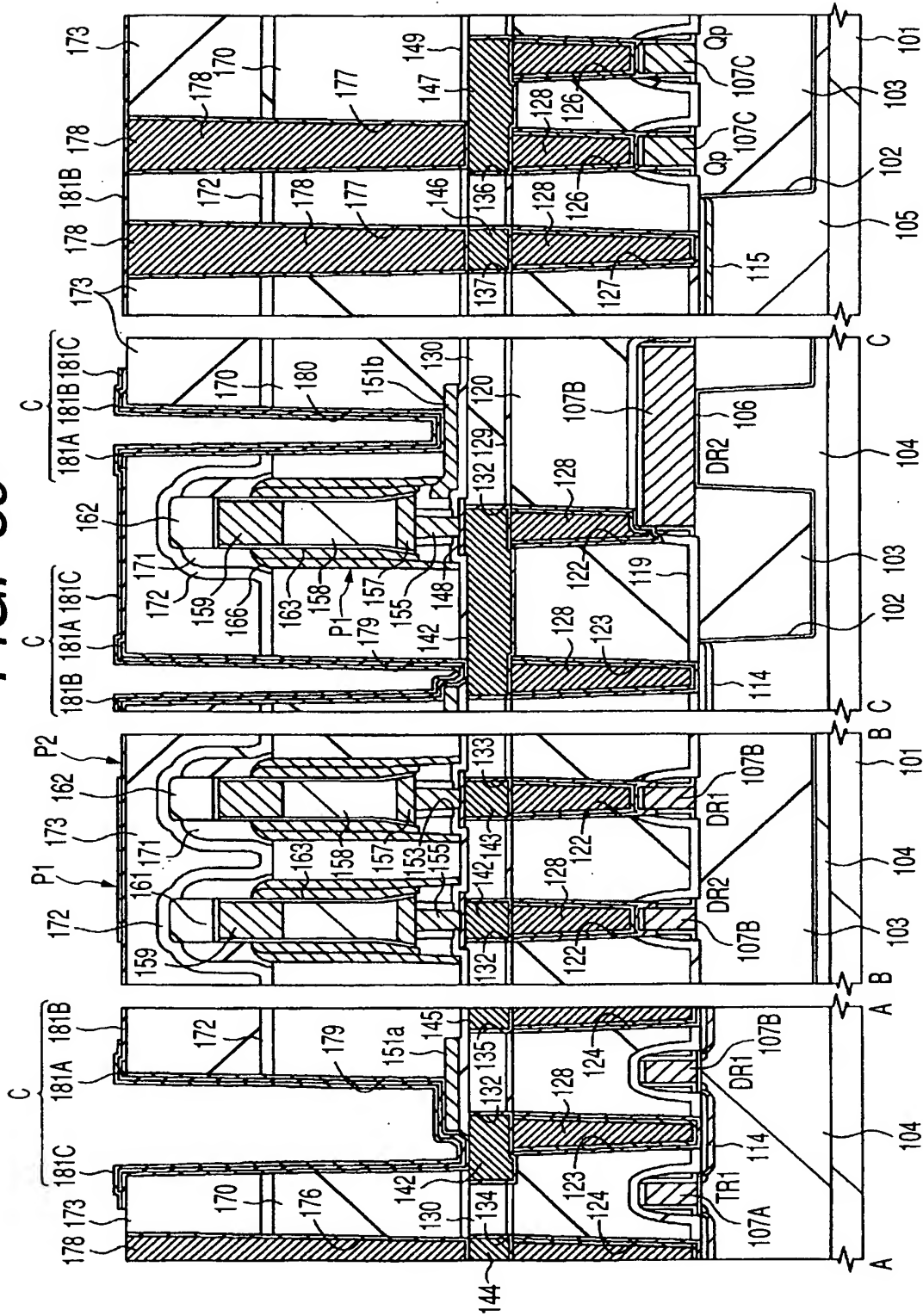


FIG. 89



170: SILICON OXIDE FILM (FIRST INSULATING FILM) 179, 180: THROUGH-HOLE (FIRST OPENING)
 172: SILICON NITRIDE FILM (FIRST INSULATING FILM) 181A: TIN FILM (FIRST CONDUCTIVE FILM)
 173: SILICON OXIDE FILM (FIRST INSULATING FILM) 181B: SILICON NITRIDE FILM (SECOND INSULATING FILM)
 181C: TIN FILM (SECOND CONDUCTIVE FILM)
 C: CAPACITIVE ELEMENT
 C: CAPACITIVE ELEMENT (FIRST CAPACITIVE ELEMENT)

FIG. 90

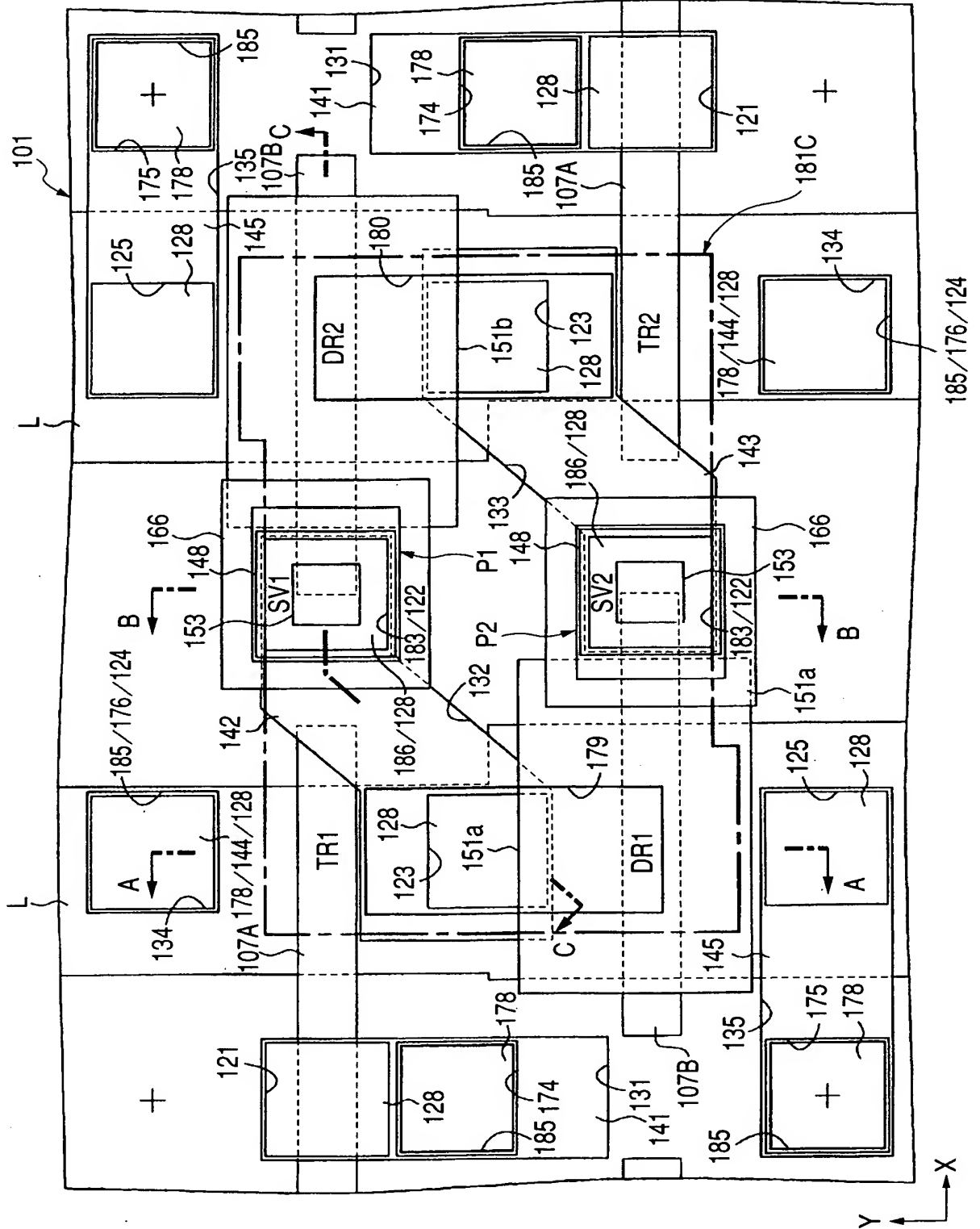


FIG. 92

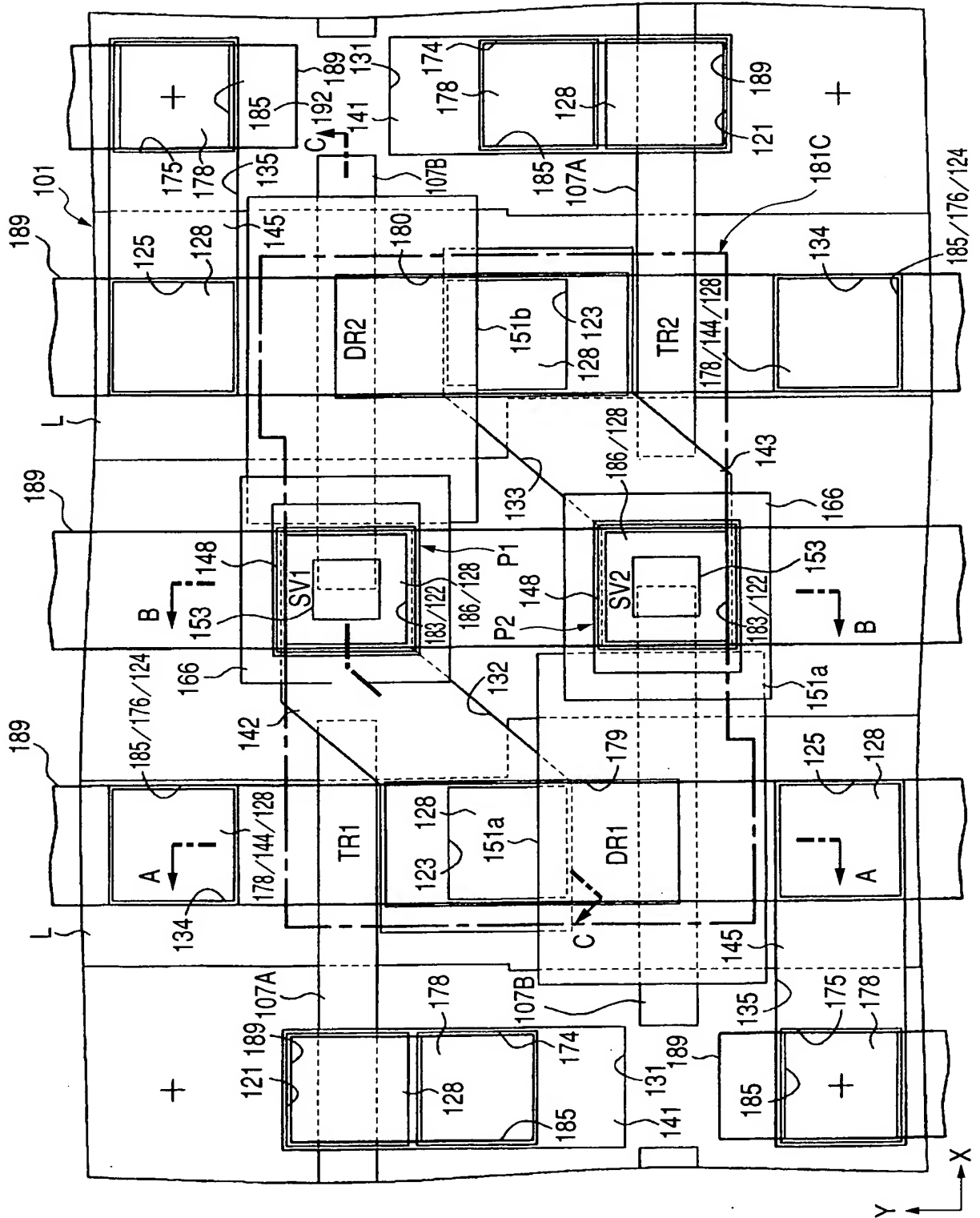


FIG. 93

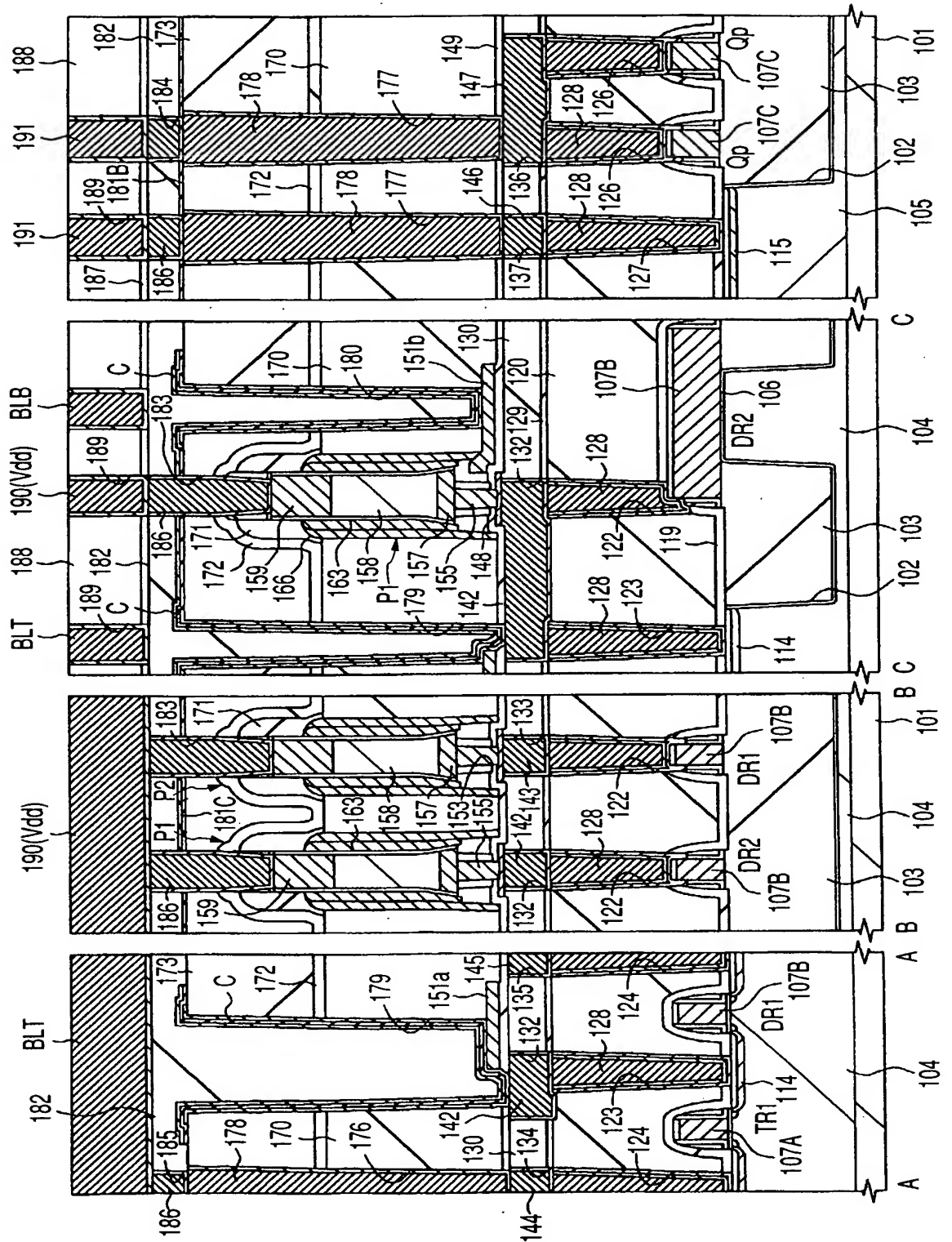
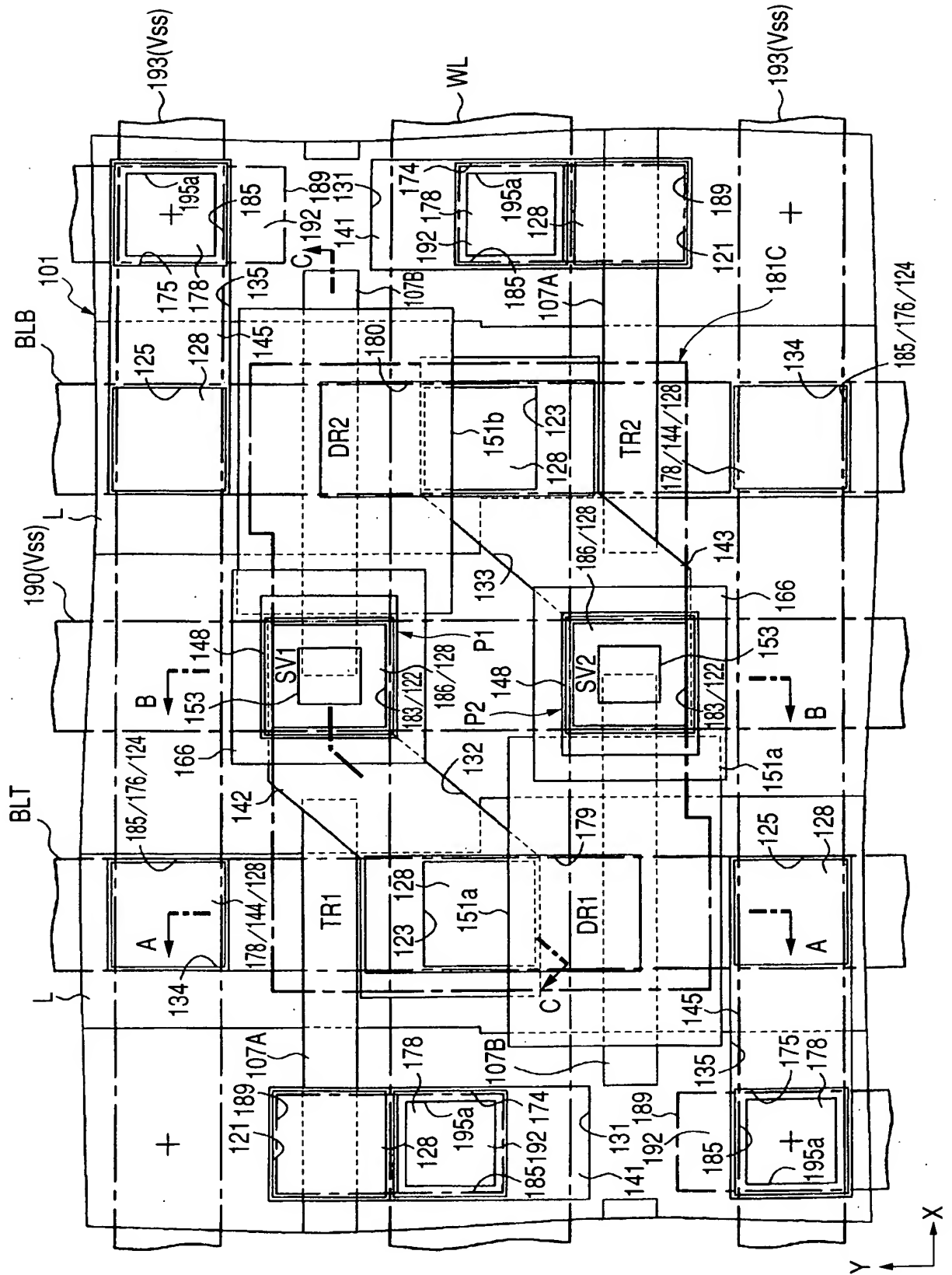


FIG. 94



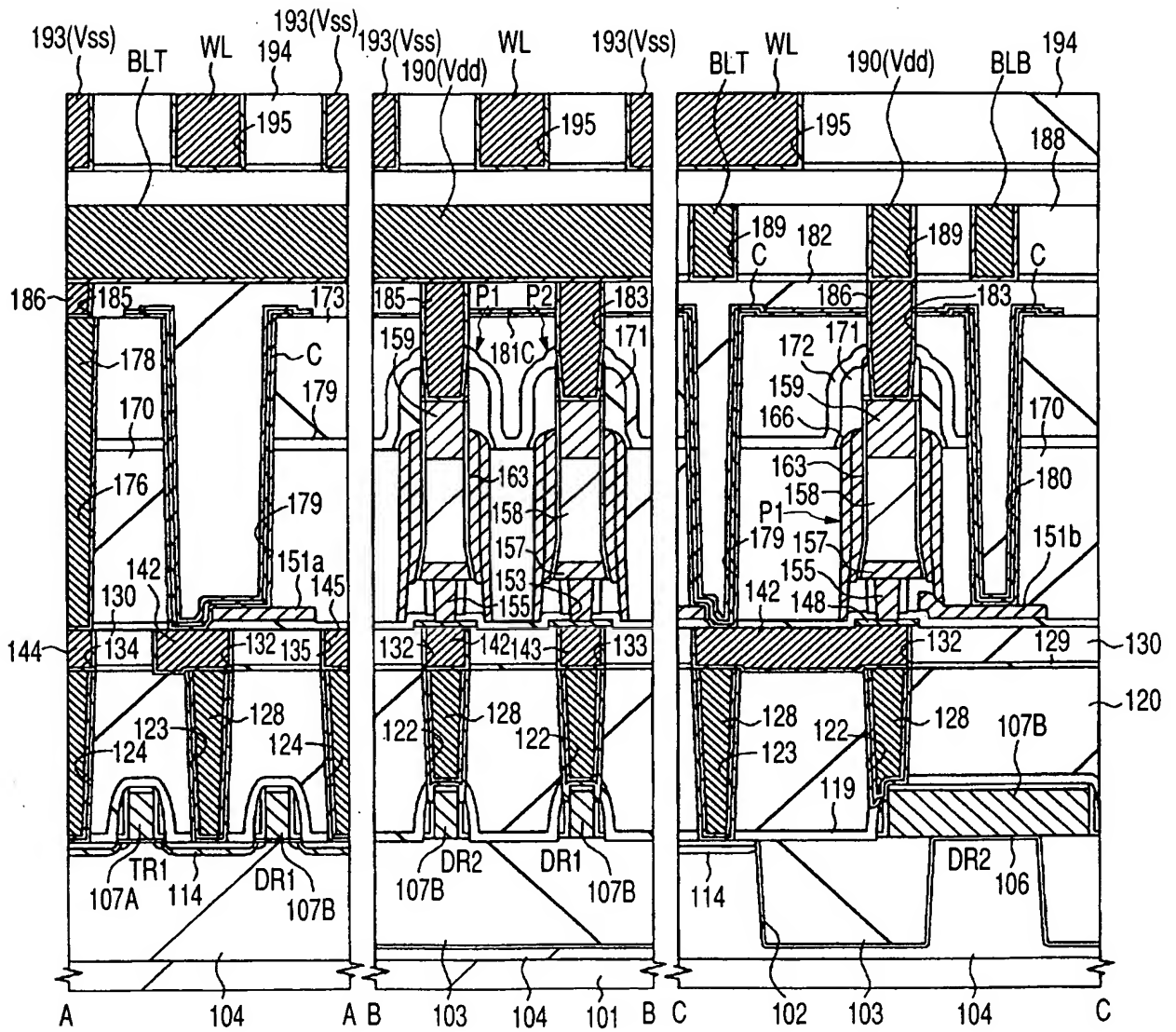


FIG. 96

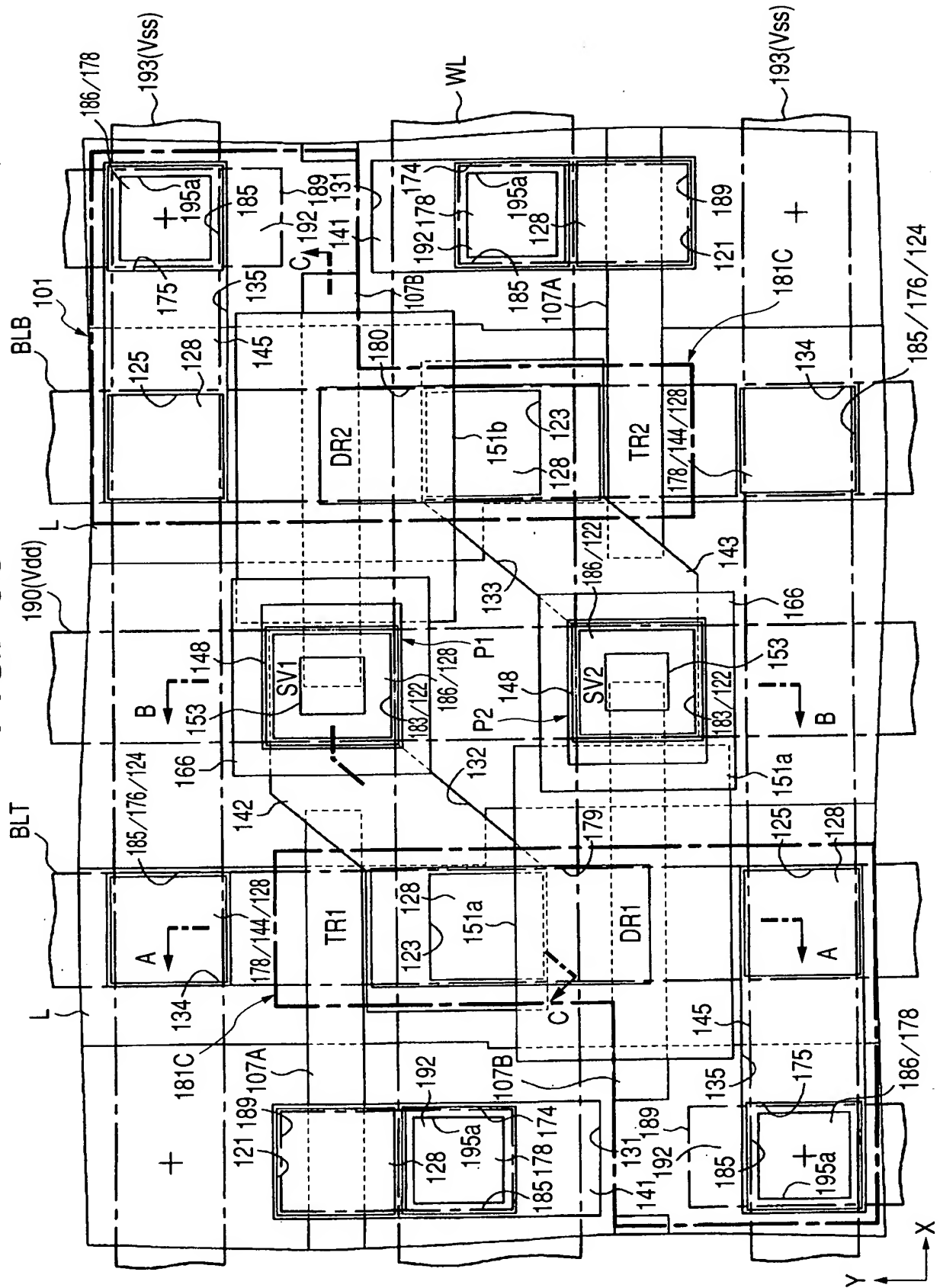


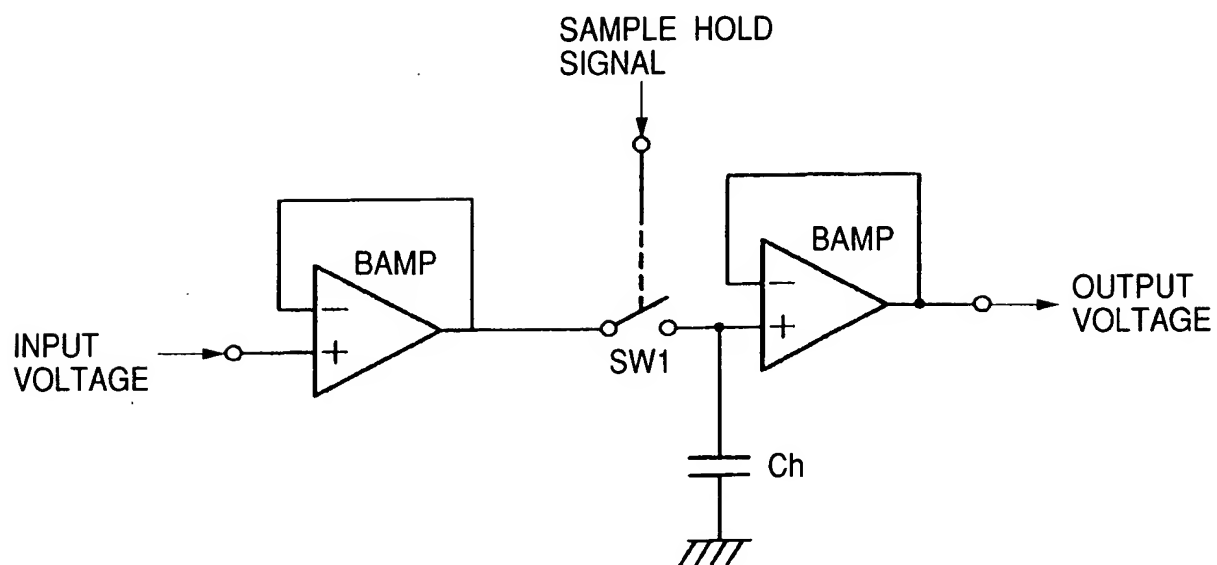
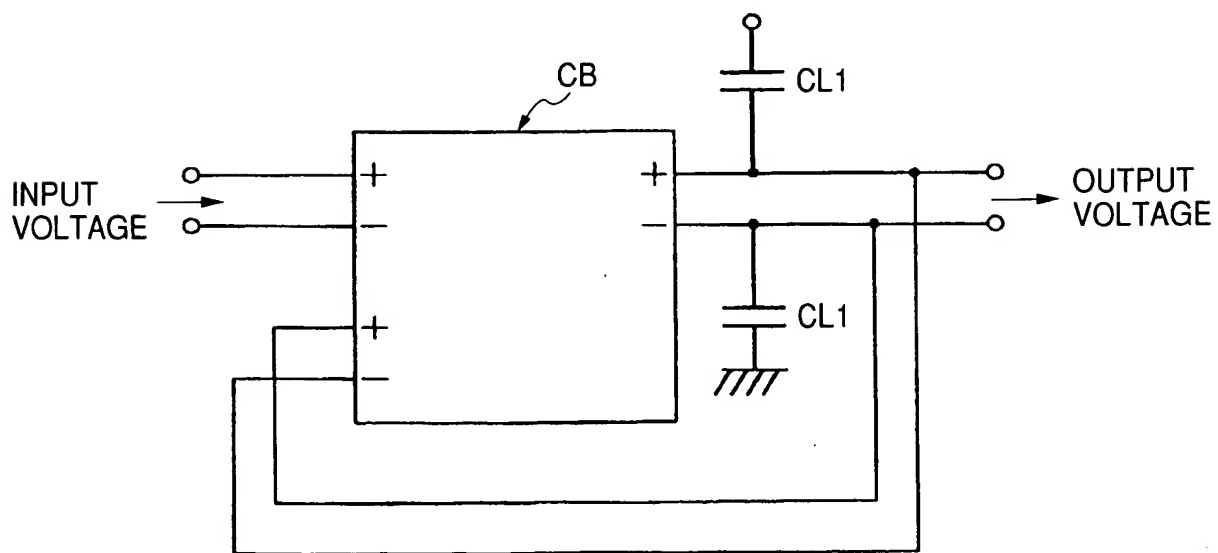
FIG. 97**FIG. 98**

FIG. 99

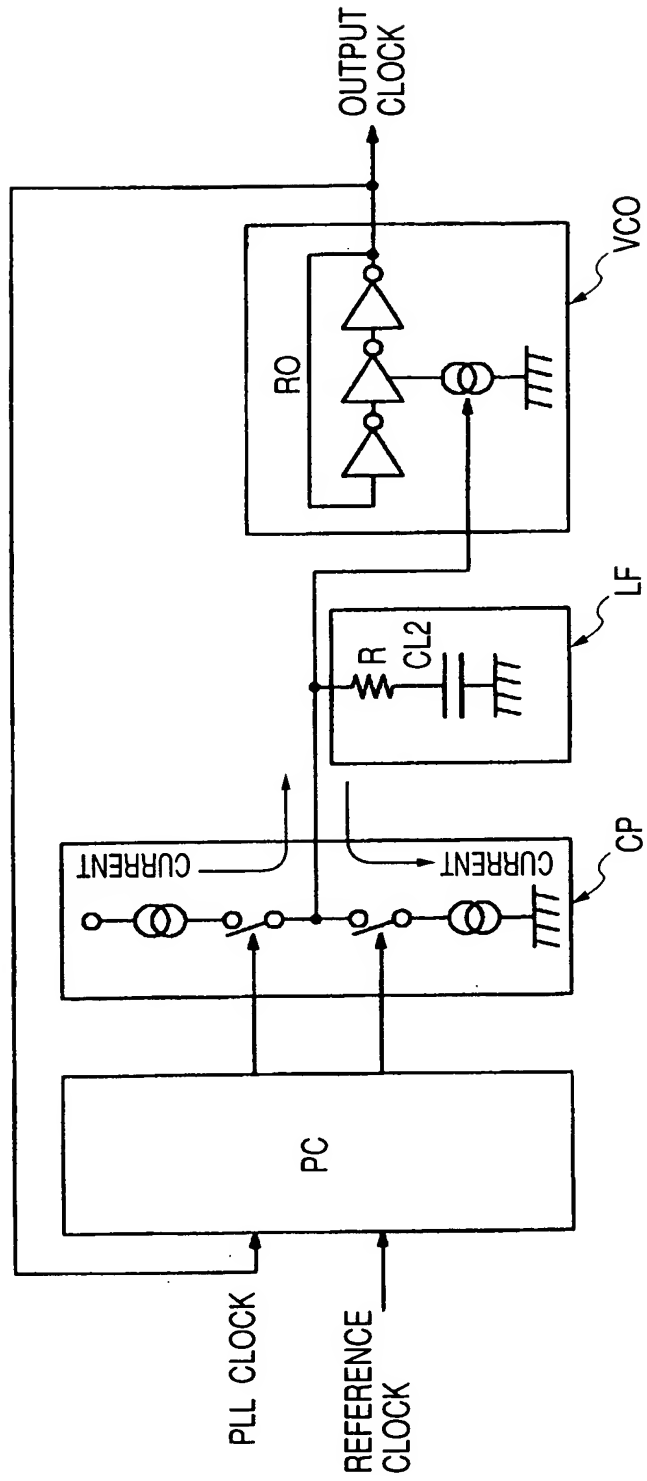


FIG. 100

